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(54) Title: ELECTROPHOTOGRAPHIC PHOTSENSITIVE MEMBER, PROCESS CARTRIDGE, AND ELECTROPHOTOGRAPHIC APPARATUS

(57) Abstract: Provided are an electrophotographic photosensitive member in which a residual potential hardly increases at the time of image formation, a pattern memory hardly occurs, and the crack of an electro-conductive layer hardly occurs, and a process cartridge and an electrophotographic apparatus each including the electrophotographic photosensitive member. To this end, the electro-conductive layer of the electrophotographic photosensitive member contains titanium oxide particles coated with tin oxide doped with phosphorus, tin oxide particles doped with phosphorus, and a binding material, and when a total volume of the electro-conductive layer is represented by V_T , a volume of the titanium oxide particles coated with tin oxide doped with phosphorus in the electro-conductive layer is represented by V_{IP} , and a volume of the tin oxide particles doped with phosphorus in the electro-conductive layer is represented by V_{2P} , the V_T , the V_{IP} , and the V_{2P} satisfy the following expressions: $2 \leq \{(V_{2P}/V_T)/(V_{IP}/V_T)\} \times 100 \leq 25$ and $15 \leq \{(V_{IP}/V_T) + (V_{2P}/V_T)\} \times 100 \leq 45$.

DESCRIPTION

Title of Invention: ELECTROPHOTOGRAPHIC PHOTOSENSITIVE MEMBER, PROCESS CARTRIDGE, AND ELECTROPHOTOGRAPHIC APPARATUS

Technical Field

- [0001] The present invention relates to an electrophotographic photosensitive member, and a process cartridge and an electrophotographic apparatus each including the electrophotographic photosensitive member.

Background Art

- [0002] An electrophotographic photosensitive member using an organic photo-conductive material (organic electrophotographic photosensitive member) has been intensively studied and developed in recent years.
- [0003] The electrophotographic photosensitive member basically includes a support and a photosensitive layer formed on the support. In actuality, however, various layers are provided in many cases between the support and the photosensitive layer for the purposes of, for example, covering defects in the surface of the support, protecting the photosensitive layer from electrical destruction, enhancing chargeability, and improving charge injection blocking property from the support to the photosensitive layer.
- [0004] Of the layers to be provided between the support and the photosensitive layer, a layer containing metal oxide particles is known as a layer to be provided for the purpose of covering defects in the surface of the support. The layer containing metal oxide particles generally has high electro-conductivity (for example, an initial volume resistivity of 1.0×10^8 to $2.0 \times 10^{13} \Omega \cdot \text{cm}$) as compared to that of a layer not containing metal oxide particles, and even when the thickness of the layer is increased, a residual potential at the

time of forming an image is difficult to increase. Therefore, the layer containing metal oxide particles covers defects in the surface of the support easily. When such layer having high electro-conductivity (hereinafter referred to as "conductive layer") is provided between the support and the photosensitive layer to cover defects in the surface of the support, an allowable range of defects in the surface of the support is enlarged. As a result, an allowable range of the support to be used is enlarged. Thus, an advantage of enhancing productivity of an electrophotographic photosensitive member is provided.

[0005] Patent Literature 1 discloses a technology involving using, in a conductive layer between a support and a photosensitive layer, a titanium oxide particle coated with tin oxide doped with phosphorus or tungsten. In addition, Patent Literature 2 discloses a technology involving using, in a conductive layer between a support and a photosensitive layer, a titanium oxide particle coated with tin oxide doped with phosphorus, tungsten, or fluorine.

[0006] In addition, Patent Literature 3 discloses a technology involving incorporating, into the undercoat layer of an electrophotographic photosensitive member obtained by sequentially laminating the undercoat layer, an intermediate layer, and a photosensitive layer on a conductive support, two kinds of metal oxide particles having different average particle diameters. In addition, Patent Literature 4 discloses the following technology. Two or more kinds of electro-conductive particles having different primary particle diameters are incorporated into the intermediate layer of an electrophotographic photosensitive member obtained by laminating the intermediate layer and a photosensitive layer on a conductive support in the stated order, a ratio "A:B" between the average particle diameters of

primary particles A having the largest average particle diameter of the electro-conductive particles and primary particles B having the smallest average particle diameter thereof is set to 12:1 to 30:1, and the average particle diameter of the primary particles B is set to 0.05 μm or less. In addition, Patent Literature 4 discloses a technology involving using a tin oxide particle doped with tantalum in the intermediate layer of the electrophotographic photosensitive member.

- [0007] In addition, Patent Literatures 5 and 6 each describe a technology involving using a tin oxide particle doped with niobium in a conductive layer or an intermediate layer between a support and a photosensitive layer.

Citation List

Patent Literature

- [0008] PTL 1: Japanese Patent Application Laid-Open No. 2012-18371
PTL 2: Japanese Patent Application Laid-Open No. 2012-18370
PTL 3: Japanese Patent Application Laid-Open No. 2007-187771
PTL 4: Japanese Patent Application Laid-Open No. 2004-151349
PTL 5: Japanese Patent Application Laid-Open No. H01-248158
PTL 6: Japanese Patent Application Laid-Open No. H01-150150

Summary of Invention

Technical Problem

- [0009] In recent years, the following opportunity has been increasing: a large amount of images identical to each other are output from one and the same electrophotographic photosensitive member in a short time period.
- [0010] In such case, the direction of movement of a recording

medium (such as a transfer material (e.g., paper) or an intermediate transfer member) in an electrophotographic photosensitive member and a vertical direction (longitudinal direction when the electrophotographic photosensitive member is cylindrical) do not deviate from each other. Accordingly, for example, when a solid black image or a half-tone image is output after a large amount of images each including vertical lines 306 (lines parallel to the direction of movement of the recording medium) like an image 301 of FIG. 4 have been continuously output, a product called a pattern memory occurs in a portion where a vertical line has been formed. More specifically, in essence, the solid black image is output like an image 302 of FIG. 4 and the half-tone image is output like an image 303 of FIG. 4. However, when the solid black image is output after a large amount of images each including the vertical lines 306 like the image 301 of FIG. 4 have been continuously output, the output image may be an image 304 with vertical lines 307 resulting from the repetition hysteresis of the vertical lines 306 of the image 301 of FIG. 4. In the case of the half-tone image as well, as in the case of the solid black image, the output image may be an image 305 with vertical lines 308 resulting from the repetition hysteresis of the vertical lines 306 of the image 301 of FIG. 4. An image portion where the repetition hysteresis has appeared like those vertical lines 307 and 308 is called a pattern memory.

[0011] In particular, the following opportunity has been recently increasing as compared with olden times in association with the lengthening of the lifetime of an electrophotographic photosensitive member: a large amount of images identical to each other are output from one and the same electrophotographic photosensitive member in a short time period.

Accordingly, even in a conventional electrophotographic photosensitive member that has heretofore been able to be sufficiently used, the case where the pattern memory occurs when a large amount of images identical to each other are output in a short time period has started to become apparent. In this respect, each of the electrophotographic photosensitive members including conventional conductive layers disclosed in Patent Literatures 1 to 6 has sometimes involved the emergence of the case where the pattern memory occurs.

[0012] On the other hand, in the case of a conductive layer containing a binding material and metal oxide particles, a crack is liable to occur in the conductive layer even when the volume resistivity of the conductive layer is reduced merely by increasing the content of the metal oxide particles in the conductive layer in order that an increase in residual potential at the time of image formation may be suppressed. Accordingly, the following necessity arises: while the occurrence of the crack of the conductive layer is suppressed, the occurrence of a pattern memory is suppressed and the increase of the residual potential is suppressed.

[0013] In view of the foregoing, the present invention is directed to providing an electrophotographic photosensitive member in which a residual potential hardly increases at the time of image formation, a pattern memory hardly occurs, and the crack of a conductive layer hardly occurs, and a process cartridge and an electrophotographic apparatus each including the electrophotographic photosensitive member.

Solution to Problem

[0014] According to one aspect of the present invention, there is provided an electrophotographic photosensitive member, including: a support; a conductive layer formed on the support; and a photosensitive layer formed on the conductive layer, in which: the conductive layer

contains a titanium oxide particle coated with tin oxide doped with phosphorus, a tin oxide particle doped with phosphorus, and a binding material; and when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with phosphorus in the conductive layer is represented by V_{1P} , and a total volume of the tin oxide particle doped with phosphorus in the conductive layer is represented by V_{2P} , the V_T , the V_{1P} , and the V_{2P} satisfy the following expressions (1) and (2).

[0015] $2 \leq \{ (V_{2P}/V_T) / (V_{1P}/V_T) \} \times 100 \leq 25 \cdots (1)$

$15 \leq \{ (V_{1P}/V_T) + (V_{2P}/V_T) \} \times 100 \leq 45 \cdots (2)$

[0016] According to another aspect of the present invention, there is provided an electrophotographic photosensitive member, including: a support; a conductive layer formed on the support; and a photosensitive layer formed on the conductive layer, in which: the conductive layer contains a titanium oxide particle coated with tin oxide doped with tungsten, a tin oxide particle doped with tungsten, and a binding material; and when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with tungsten in the conductive layer is represented by V_{1W} , and a total volume of the tin oxide particle doped with tungsten in the conductive layer is represented by V_{2W} , the V_T , the V_{1W} , and the V_{2W} satisfy the following expressions (6) and (7).

[0017] $2 \leq \{ (V_{2W}/V_T) / (V_{1W}/V_T) \} \times 100 \leq 25 \cdots (6)$

$15 \leq \{ (V_{1W}/V_T) + (V_{2W}/V_T) \} \times 100 \leq 45 \cdots (7)$

[0018] According to still another aspect of the present invention, there is provided an electrophotographic photosensitive member, including: a support; a conductive layer formed on the support; and a photosensitive layer formed on the conductive layer, in which: the conductive layer contains a titanium oxide

particle coated with tin oxide doped with fluorine, a tin oxide particle doped with fluorine, and a binding material; and when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with fluorine in the conductive layer is represented by V_{1F} , and a total volume of the tin oxide particle doped with fluorine in the conductive layer is represented by V_{2F} , the V_T , the V_{1F} , and the V_{2F} satisfy the following expressions (11) and (12).

[0019] $2 \leq \{ (V_{2F}/V_T) / (V_{1F}/V_T) \} \times 100 \leq 25 \dots (11)$

$$15 \leq \{ (V_{1F}/V_T) + (V_{2F}/V_T) \} \times 100 \leq 45 \dots (12)$$

[0020] According to still another aspect of the present invention, there is provided an electrophotographic photosensitive member, including: a support; a conductive layer formed on the support; and a photosensitive layer formed on the conductive layer, in which: the conductive layer contains a titanium oxide particle coated with tin oxide doped with niobium, a tin oxide particle doped with niobium, and a binding material; and when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with niobium in the conductive layer is represented by V_{1Nb} , and a total volume of the tin oxide particle doped with niobium in the conductive layer is represented by V_{2Nb} , the V_T , the V_{1Nb} , and the V_{2Nb} satisfy the following expressions (16) and (17).

$$2 \leq \{ (V_{2Nb}/V_T) / (V_{1Nb}/V_T) \} \times 100 \leq 25 \dots (16)$$

$$15 \leq \{ (V_{1Nb}/V_T) + (V_{2Nb}/V_T) \} \times 100 \leq 45 \dots (17)$$

[0021] According to still another aspect of the present invention, there is provided an electrophotographic photosensitive member, including: a support; a conductive layer formed on the support; and a photosensitive layer formed on the conductive layer, in which: the conductive layer contains a titanium oxide

particle coated with tin oxide doped with tantalum, a tin oxide particle doped with tantalum, and a binding material; and when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with tantalum in the conductive layer is represented by V_{1Ta} , and a total volume of the tin oxide particle doped with tantalum in the conductive layer is represented by V_{2Ta} , the V_T , the V_{1Ta} , and the V_{2Ta} satisfy the following expressions (21) and (22).

$$2 \leq \{ (V_{2Ta}/V_T) / (V_{1Ta}/V_T) \} \times 100 \leq 25 \quad \dots (21)$$

$$15 \leq \{ (V_{1Ta}/V_T) + (V_{2Ta}/V_T) \} \times 100 \leq 45 \quad \dots (22)$$

[0022] According to still another aspect of the present invention, there is provided a process cartridge detachably mountable to a main body of an electrophotographic apparatus, in which the process cartridge integrally supports: the above-described electrophotographic photosensitive member; and at least one device selected from the group consisting of a charging device, a developing device, a transferring device, and a cleaning device.

[0023] According to still another aspect of the present invention, there is provided an electrophotographic apparatus, including: the above-described electrophotographic photosensitive member; a charging device; an exposing device; a developing device; and a transferring device.

Advantageous Effects of Invention

[0024] According to the present invention, there is provided the electrophotographic photosensitive member in which a residual potential hardly increases at the time of image formation, a pattern memory hardly occurs, and the crack of a conductive layer hardly occurs, and the process cartridge and the electrophotographic apparatus each including the electrophotographic photosensitive member.

[0025] Further features of the present invention will become apparent from the following description of exemplary embodiments with reference to the attached drawings.

Brief Description of Drawings

- [0026] FIG. 1 is a view illustrating an example of the schematic construction of an electrophotographic apparatus including a process cartridge having an electrophotographic photosensitive member of the present invention.
- [0027] FIG. 2 is a view (top view) for illustrating a method of measuring the volume resistivity of a conductive layer.
- [0028] FIG. 3 is a view (cross-sectional view) for illustrating the method of measuring the volume resistivity of a conductive layer.
- [0029] FIG. 4 is a view (image example) for illustrating a pattern memory.
- [0030] FIG. 5 is a view illustrating a one-dot keima pattern image.

Description of Embodiments

- [0031] An electrophotographic photosensitive member of the present invention is an electrophotographic photosensitive member including a support, a conductive layer formed on the support, and a photosensitive layer formed on the conductive layer.
- [0032] The photosensitive layer may be a single-layer type photosensitive layer obtained by incorporating a charge-generating substance and a charge-transporting substance into a single layer, or may be a laminated type photosensitive layer obtained by laminating a charge-generating layer containing a charge-generating substance and a charge-transporting layer containing a charge-transporting substance. In addition, an undercoat layer may be provided between the conductive layer and photosensitive layer to be formed on the support as required.

[0033] A support having electro-conductivity (conductive support) is preferred as the support, and for example, a metal support formed of a metal such as aluminum, an aluminum alloy, or stainless steel can be used. When aluminum or an aluminum alloy is used, an aluminum tube produced by a production method including an extrusion process and a drawing process, or an aluminum tube produced by a production method including an extrusion process and an ironing process can be used. Such aluminum tube provides good dimensional accuracy and good surface smoothness without the cutting of its surface, and is advantageous in terms of cost. However, burr-like protruding defects are liable to occur on the uncut surface of the aluminum tube. Accordingly, it is particularly effective to provide the conductive layer.

[0034] In the electrophotographic photosensitive member of the present invention, any one of the following combinations of metal oxide particles as well as a binding material is used in the conductive layer to be formed on the support:

(p) a titanium oxide particle coated with tin oxide doped with phosphorus and a tin oxide particle doped with phosphorus;

(w) a titanium oxide particle coated with tin oxide doped with tungsten and a tin oxide particle doped with tungsten;

(f) a titanium oxide particle coated with tin oxide doped with fluorine and a tin oxide particle doped with fluorine;

(nb) a titanium oxide particle coated with tin oxide doped with niobium and a tin oxide particle doped with niobium; and

(ta) a titanium oxide particle coated with tin oxide doped with tantalum and a tin oxide particle doped with tantalum.

[0035] One of the features lies in that in each of the

combinations (p), (w), (f), (nb), and (ta) of metal oxide particles, phosphorus (P), tungsten (W), fluorine (F), niobium (Nb), or tantalum (Ta) is common to the element with which tin oxide is doped. It should be noted that the titanium oxide particles are particles of titanium oxide (TiO_2) and the tin oxide particles are particles of tin oxide (SnO_2).

[0036] Hereinafter, the titanium oxide particle coated with tin oxide doped with phosphorus is also represented as "P-doped tin oxide-coated titanium oxide particles" and the tin oxide particle doped with phosphorus is also represented as "P-doped tin oxide particles." In addition, the titanium oxide particle coated with tin oxide doped with tungsten is also represented as "W-doped tin oxide-coated titanium oxide particles" and the tin oxide particle doped with tungsten is also represented as "W-doped tin oxide particles." In addition, the titanium oxide particle coated with tin oxide doped with fluorine is also represented as "F-doped tin oxide-coated titanium oxide particles" and the tin oxide particle doped with fluorine is also represented as "F-doped tin oxide particles." In addition, the titanium oxide particle coated with tin oxide doped with niobium is also represented as "Nb-doped tin oxide-coated titanium oxide particles" and the tin oxide particle doped with niobium is also represented as "Nb-doped tin oxide particles." In addition, the titanium oxide particle coated with tin oxide doped with tantalum is also represented as "Ta-doped tin oxide-coated titanium oxide particles" and the tin oxide particle doped with tantalum is also represented as "Ta-doped tin oxide particles."

[0037] Further, in the electrophotographic photosensitive member of the present invention, in the case where the combination of metal oxide particles to be incorporated into the conductive layer is the combination (p), when

the total volume of the conductive layer is represented by V_T , the volume of the P-doped tin oxide-coated titanium oxide particles in the conductive layer is represented by V_{1P} , and the volume of the P-doped tin oxide particles in the conductive layer is represented by V_{2P} , V_T , V_{1P} , and V_{2P} satisfy the following expressions (1) and (2).

[0038] $2 \leq \{ (V_{2P}/V_T) / (V_{1P}/V_T) \} \times 100 \leq 25 \cdots (1)$

$15 \leq \{ (V_{1P}/V_T) + (V_{2P}/V_T) \} \times 100 \leq 45 \cdots (2)$

[0039] Further, in the case where the combination of metal oxide particles to be incorporated into the conductive layer is the combination (w), when the total volume of the conductive layer is represented by V_T , the volume of the W-doped tin oxide-coated titanium oxide particles in the conductive layer is represented by V_{1W} , and the volume of the W-doped tin oxide particles in the conductive layer is represented by V_{2W} , V_T , V_{1W} , and V_{2W} satisfy the following expressions (6) and (7).

[0040] $2 \leq \{ (V_{2W}/V_T) / (V_{1W}/V_T) \} \times 100 \leq 25 \cdots (6)$

$15 \leq \{ (V_{1W}/V_T) + (V_{2W}/V_T) \} \times 100 \leq 45 \cdots (7)$

Further, in the case where the combination of metal oxide particles to be incorporated into the conductive layer is the combination (f), when the total volume of the conductive layer is represented by V_T , the volume of the F-doped tin oxide-coated titanium oxide particles in the conductive layer is represented by V_{1F} , and the volume of the F-doped tin oxide particles in the conductive layer is represented by V_{2F} , V_T , V_{1F} , and V_{2F} satisfy the following expressions (11) and (12).

[0041] $2 \leq \{ (V_{2F}/V_T) / (V_{1F}/V_T) \} \times 100 \leq 25 \cdots (11)$

$15 \leq \{ (V_{1F}/V_T) + (V_{2F}/V_T) \} \times 100 \leq 45 \cdots (12)$

[0042] Further, in the case where the combination of metal oxide particles to be incorporated into the conductive layer is the combination (nb), when the total volume of the conductive layer is represented by V_T , the volume of the Nb-doped tin oxide-coated titanium oxide

particles in the conductive layer is represented by V_{1Nb} , and the volume of the Nb-doped tin oxide particles in the conductive layer is represented by V_{2Nb} , V_T , V_{1Nb} , and V_{2Nb} satisfy the following expressions (16) and (17).

[0043] $2 \leq \{ (V_{2Nb}/V_T) / (V_{1Nb}/V_T) \} \times 100 \leq 25 \dots (16)$

$15 \leq \{ (V_{1Nb}/V_T) + (V_{2Nb}/V_T) \} \times 100 \leq 45 \dots (17)$

[0044] Further, in the case where the combination of metal oxide particles to be incorporated into the conductive layer is the combination (ta), when the total volume of the conductive layer is represented by V_T , the volume of the Ta-doped tin oxide-coated titanium oxide particles in the conductive layer is represented by V_{1Ta} , and the volume of the Ta-doped tin oxide particles in the conductive layer is represented by V_{2Ta} , V_T , V_{1Ta} , and V_{2Ta} satisfy the following expressions (21) and (22).

[0045] $2 \leq \{ (V_{2Ta}/V_T) / (V_{1Ta}/V_T) \} \times 100 \leq 25 \dots (21)$

$15 \leq \{ (V_{1Ta}/V_T) + (V_{2Ta}/V_T) \} \times 100 \leq 45 \dots (22)$

[0046] Hereinafter, V_{1P} , V_{1W} , V_{1F} , V_{1Nb} , and V_{1Ta} are also collectively represented as " V_1 ," and V_{2P} , V_{2W} , V_{2F} , V_{2Nb} , and V_{2Ta} are also collectively represented as " V_2 ." In addition, the P-doped tin oxide-coated titanium oxide particles, the W-doped tin oxide-coated titanium oxide particles, the F-doped tin oxide-coated titanium oxide particles, the Nb-doped tin oxide-coated titanium oxide particles, and the Ta-doped tin oxide-coated titanium oxide particles are also collectively represented as "a first metal oxide particle," and the P-doped tin oxide particles, the W-doped tin oxide particles, the F-doped tin oxide particles, the Nb-doped tin oxide particles, and the Ta-doped tin oxide particles are also collectively represented as "a second metal oxide particle."

[0047] The inventors of the present invention have made extensive studies to suppress the occurrence of a pattern memory. As a result, the inventors have found that the pattern memory is suppressed by the formation

of a good electro-conductive path over a wide range in the conductive layer, in other words, uniform movement of charge in the conductive layer. This is probably because local retention or storage of the charge in the conductive layer hardly occurs. However, the retention or storage of the charge may not largely correlate with the volume resistivity or electric resistance of the conductive layer because the retention or storage is a local phenomenon. The formation of a good electro-conductive path in the conductive layer for suppressing the pattern memory requires the formation of an electro-conductive path that passes both the first metal oxide particle and the second metal oxide particle. To this end, the following necessity may arise for suppressing the occurrence of the pattern memory: instead of the formation of the conductive layer containing only the first metal oxide particle or the conductive layer containing only the second metal oxide particle, the first metal oxide particle and the second metal oxide particle are caused to exist in the conductive layer at a certain ratio, and then an electro-conductive path that passes both the first metal oxide particle and the second metal oxide particle is formed. That is, it may be necessary to satisfy the expression (1), (6), (11), (16), or (21). When the value for $\{(V_2/V_T)/(V_1/V_T)\} \times 100$ is less than 2, the ratio of the amount of the second metal oxide particle to the amount of the first metal oxide particle becomes insufficient. Accordingly, it is assumed that the situation becomes close to that in the case of the conductive layer containing only the first metal oxide particle and hence an electro-conductive path good for suppressing the occurrence of the pattern memory cannot be formed. On the other hand, when the value for $\{(V_2/V_T)/(V_1/V_T)\} \times 100$ is more than 25, the ratio of the amount of the second metal oxide particle

to the amount of the first metal oxide particle becomes excessive. Accordingly, it is assumed that the situation becomes close to that in the case of the conductive layer containing only the second metal oxide particle and hence an electro-conductive path good for suppressing the occurrence of the pattern memory cannot be formed. When the following expression (3), (8), (13), (18), or (23) is satisfied, a suppressing effect on the occurrence of the pattern memory becomes additionally significant because the ratio between the first metal oxide particle and the second metal oxide particle becomes the ratio at which an electro-conductive path additionally good for suppressing the occurrence of the pattern memory can be formed.

- [0048] $5 \leq \{ (V_{2P}/V_T) / (V_{1P}/V_T) \} \times 100 \leq 20 \cdots (3)$
 $5 \leq \{ (V_{2W}/V_T) / (V_{1W}/V_T) \} \times 100 \leq 20 \cdots (8)$
 $5 \leq \{ (V_{2F}/V_T) / (V_{1F}/V_T) \} \times 100 \leq 20 \cdots (13)$
 $5 \leq \{ (V_{2Nb}/V_T) / (V_{1Nb}/V_T) \} \times 100 \leq 20 \cdots (18)$
 $5 \leq \{ (V_{2Ta}/V_T) / (V_{1Ta}/V_T) \} \times 100 \leq 20 \cdots (23)$

- [0049] In addition, the formation of the electro-conductive path that passes the first metal oxide particle and the second metal oxide particle in the conductive layer may require that the sum of the contents of the first metal oxide particle and a second metal oxide particle in the conductive layer fall within a certain range. That is, it may be necessary to satisfy the expression (2), (7), (12), (17), or (22). When the value for $\{ (V_1+V_2)/V_T \} \times 100$ is less than 15, the retention or storage of the charge in the conductive layer is liable to occur and hence an increase in residual potential is liable to be large in the case of repeated use of the electrophotographic photosensitive member. The value for $\{ (V_1+V_2)/V_T \} \times 100$ is more preferably 20 or more. On the other hand, when the value for $\{ (V_1+V_2)/V_T \} \times 100$ is more than 45, the amount of the binding material becomes relatively small and hence a crack is liable to

occur in the conductive layer. The value for $\{(V_1+V_2)/V_T\} \times 100$ is more preferably 40 or less. That is, the following expression (4), (9), (14), (19), or (24) is more preferably satisfied.

[0050] $20 \leq \{(V_{1P}/V_T) + (V_{2P}/V_T)\} \times 100 \leq 40 \cdots (4)$

$20 \leq \{(V_{1W}/V_T) + (V_{2W}/V_T)\} \times 100 \leq 40 \cdots (9)$

$20 \leq \{(V_{1F}/V_T) + (V_{2F}/V_T)\} \times 100 \leq 40 \cdots (14)$

$20 \leq \{(V_{1Nb}/V_T) + (V_{2Nb}/V_T)\} \times 100 \leq 40 \cdots (19)$

$20 \leq \{(V_{1Ta}/V_T) + (V_{2Ta}/V_T)\} \times 100 \leq 40 \cdots (24)$

[0051] As described above, it is necessary to satisfy the expressions (1) and (2) simultaneously, to satisfy the expressions (6) and (7) simultaneously, to satisfy the expressions (11) and (12) simultaneously, to satisfy the expressions (16) and (17) simultaneously, or to satisfy the expressions (21) and (22) simultaneously for obtaining an electrophotographic photosensitive member in which a residual potential hardly increases at the time of image formation, a pattern memory hardly occurs, and the crack of a conductive layer hardly occurs.

[0052] With regard to the present invention, in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is, for example, a combination of a titanium oxide particle coated with tin oxide doped with antimony and a tin oxide particle doped with antimony, or a combination of titanium oxide particles coated with oxygen-deficient tin oxide and oxygen-deficient tin oxide particles, the suppressing effect on the occurrence of the pattern memory deteriorates as compared with that in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is the combination (p), (w), (f), (nb), or (ta).

[0053] In addition, even when a species (dopant) to be doped into tin oxide is phosphorus, tungsten, fluorine, niobium, or tantalum, in the case where a species to be

doped into tin oxide of the first metal oxide particle and a species to be doped into tin oxide of the second metal oxide particle differ from each other such as the case where the combination of the metal oxide particles to be incorporated into the conductive layer is a combination of a titanium oxide particle coated with tin oxide doped with phosphorus and a tin oxide particle doped with tungsten, the suppressing effect on the occurrence of the pattern memory similarly deteriorates as compared with that in the case of the combination (p), (w), (f), (nb), or (ta) in which the species to be doped are identical to each other. This is probably because of the following reason: when the species to be doped into tin oxide of the first metal oxide particle and the species to be doped into tin oxide of the second metal oxide particle are identical to each other, the electrical properties, surface properties, and work functions of the first metal oxide particle and a second metal oxide particle become physical properties closest to each other in a comprehensive manner, and hence it becomes easy for the charge to move uniformly in the conductive layer.

[0054] In addition, in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is the combination (p), when the abundance ratio of phosphorus to tin oxide in the P-doped tin oxide-coated titanium oxide particles is represented by R_{1P} [atom%] and the abundance ratio of phosphorus to tin oxide in the P-doped tin oxide particles is represented by R_{2P} [atom%], the following expression (5) is preferably satisfied.

[0055] $0.9 \leq R_{2P}/R_{1P} \leq 1.1 \cdots (5)$

[0056] In addition, in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is the combination (w), when the abundance ratio of tungsten to tin oxide in the W-doped

tin oxide-coated titanium oxide particles is represented by R_{1W} [atom%] and the abundance ratio of tungsten to tin oxide in the W-doped tin oxide particles is represented by R_{2W} [atom%], the following expression (10) is preferably satisfied.

[0057] $0.9 \leq R_{2W}/R_{1W} \leq 1.1 \cdots (10)$

[0058] In addition, in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is the combination (f), when the abundance ratio of fluorine to tin oxide in the F-doped tin oxide-coated titanium oxide particles is represented by R_{1F} [atom%] and the abundance ratio of fluorine to tin oxide in the F-doped tin oxide particles is represented by R_{2F} [atom%], the following expression (15) is preferably satisfied.

[0059] $0.9 \leq R_{2F}/R_{1F} \leq 1.1 \cdots (15)$

[0060] In addition, in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is the combination (nb), when the abundance ratio of niobium to tin oxide in the Nb-doped tin oxide-coated titanium oxide particles is represented by R_{1Nb} [atom%] and the abundance ratio of niobium to tin oxide in the Nb-doped tin oxide particles is represented by R_{2Nb} [atom%], the following expression (20) is preferably satisfied.

[0061] $0.9 \leq R_{2Nb}/R_{1Nb} \leq 1.1 \cdots (20)$

[0062] In addition, in the case where the combination of the metal oxide particles to be incorporated into the conductive layer is the combination (ta), when the abundance ratio of tantalum to tin oxide in the Ta-doped tin oxide-coated titanium oxide particles is represented by R_{1Ta} [atom%] and the abundance ratio of tantalum to tin oxide in the Ta-doped tin oxide particles is represented by R_{2Ta} [atom%], the following expression (25) is preferably satisfied.

[0063] $0.9 \leq R_{2Ta}/R_{1Ta} \leq 1.1 \cdots (25)$

- [0064] Hereinafter, R_{1P} , R_{1W} , R_{1F} , R_{1Nb} , and R_{1Ta} are also collectively represented as " R_1 ," and R_{2P} , R_{2W} , R_{2F} , R_{2Nb} , and R_{2Ta} are also collectively represented as " R_2 ."
- [0065] As represented by the expression (5), (10), (15), (20), or (25), the abundance ratios of phosphorus, tungsten, fluorine, niobium, or tantalum in tin oxide of the first metal oxide particle and tin oxide of the second metal oxide particle are preferably as close as possible to each other. In other words, the ratio R_2/R_1 is preferably as close as possible to 1.0, and specifically, the ratio is preferably 0.9 or more and 1.1 or less. When the ratio R_2/R_1 is 0.9 or more and 1.1 or less, an electro-conductive path additionally good for suppressing the occurrence of the pattern memory is formed and hence the suppressing effect on the occurrence of the pattern memory becomes additionally significant.
- [0066] The measurement of R_1 and R_2 can be performed by STEM-EDX after taking out the conductive layer of the electrophotographic photosensitive member according to an FIB method. In addition, the measurement of V_1 and V_2 can be performed by the slice and view of an FIB-SEM after taking out the conductive layer of the electrophotographic photosensitive member according to the FIB method.
- [0067] First, the measurement of R_1 and R_2 is described.
- [0068] Sampling for the STEM-EDX analysis was performed as described below.
- [0069] The sampling is performed with a supporting base made of copper (Cu) by an FIB- μ sampling method. An apparatus used by the inventors of the present invention is an FB-2000A μ -Sampling System (trade name) manufactured by Hitachi High-Technologies Corporation. The sampling was performed so that the horizontal and longitudinal sizes of a sample became such sizes that a measurement range could be secured, and the thickness

of the sample became 150 nm.

[0070] The STEM-EDX analysis was performed as described below.

[0071] The inventors of the present invention have performed the analysis with a field emission electron microscope (HRTEM) (trade name: JEM2100F) manufactured by JEOL Ltd. and a JED-2300T (trade name) (having a resolution of 133 eV or less) (energy dispersive X-ray spectroscopy) manufactured by JEOL Ltd. as an EDX portion.

[0072] Analysis conditions were set as described below.

System: Analysis Station

Image acquisition: Digital Micrograph

Measurement conditions: Acceleration voltage: 200 kV, beam diameter (diameter): 1.0 nm, measurement time: 50 seconds (in point analysis) and 40 minutes (in area analysis)

[0073] The measurement range measured 3.6 μm long by 3.4 μm wide by 150 nm thick.

[0074] The abundance ratio of phosphorus to tin oxide in the P-doped tin oxide particles, the abundance ratio of phosphorus to tin oxide in the P-doped tin oxide-coated titanium oxide particles, the abundance ratio of tungsten to tin oxide in the W-doped tin oxide particles, the abundance ratio of tungsten to tin oxide in the W-doped tin oxide-coated titanium oxide particles, the abundance ratio of fluorine to tin oxide in the F-doped tin oxide particles, the abundance ratio of fluorine to tin oxide in the F-doped tin oxide-coated titanium oxide particles, the abundance ratio of niobium to tin oxide in the Nb-doped tin oxide particles, the abundance ratio of niobium to tin oxide in the Nb-doped tin oxide-coated titanium oxide particles, the abundance ratio of tantalum to tin oxide in the Ta-doped tin oxide particles, or the abundance ratio of tantalum to tin oxide in the Ta-doped tin oxide-coated titanium oxide particles can be determined from an atomic ratio because the identification of an

element can be performed by the STEM-EDX.

- [0075] The sampling was similarly performed ten times to provide ten samples, followed by the measurement. The average of a total of ten R_1 's and the average of a total of ten R_2 's were each defined as a value for R_1 or R_2 in the conductive layer of the electrophotographic photosensitive member as a measuring object.
- [0076] Next, the measurement of the ratios (V_1/V_T) and (V_2/V_T) is described.
- [0077] The volume of the P-doped tin oxide-coated titanium oxide particles and the volume of the P-doped tin oxide particles, and their ratios in the conductive layer can be determined by identifying tin oxide doped with phosphorus and titanium oxide based on their difference in contrast of the slice and view of the FIB-SEM. When the species to be doped into tin oxide is an element except phosphorus such as tungsten, fluorine, niobium, or tantalum, the volumes and the ratios in the conductive layer can be similarly determined.
- [0078] Conditions for the slice and view in the present invention were set as described below.

Sampling for analysis: FIB method

Processing and observation apparatus: NVision 40
manufactured by SII-Zeiss

Slice interval: 10 nm

Observation conditions:

Acceleration voltage: 1.0 kV

Sample tilt: 54°

WD: 5 mm

Detector: BSE detector

Aperture: 60 μm , high current

ABC: ON

Image resolution: 1.25 nm/pixel

- [0079] The analysis is performed in a region measuring 2 μm wide by 2 μm long, information on each cross-section is

integrated, and the volumes V_1 and V_2 per space measuring $2\text{ }\mu\text{m}$ wide by $2\text{ }\mu\text{m}$ long by $2\text{ }\mu\text{m}$ thick ($V_T=8\text{ }\mu\text{m}^3$) are determined. In addition, the measurement is performed under an environment having a temperature of 23°C and a pressure of $1\times 10^{-4}\text{ Pa}$. It should be noted that a Strata 400S (sample tilt: 52°) manufactured by FEI Company can also be used as a processing and observation apparatus.

[0080] The sampling was similarly performed ten times to provide ten samples, followed by the measurement. A value obtained by dividing the average of a total of ten volumes V_1 per $8\text{ }\mu\text{m}^3$ by V_T ($8\text{ }\mu\text{m}^3$) was defined as the ratio (V_1/V_T) in the conductive layer of the electrophotographic photosensitive member as a measuring object. In addition, a value obtained by dividing the average of a total of ten volumes V_2 per $8\text{ }\mu\text{m}^3$ by V_T ($8\text{ }\mu\text{m}^3$) was defined as a value for the ratio (V_2/V_T) in the conductive layer of the electrophotographic photosensitive member as a measuring object.

[0081] It should be noted that the areas of identified tin oxide doped with phosphorus and titanium oxide were obtained from the information on each cross-section through image analysis. The image analysis was performed with the following image processing software.

[0082] Image processing software: Image-Pro Plus manufactured by Media Cybernetics

Of the metal oxide particles to be used in the present invention, the first metal oxide particle has a coating layer constituted of tin oxide doped with phosphorus, tungsten, fluorine, niobium, or tantalum, and a core particle constituted of titanium oxide. In addition, the first metal oxide particle is such a structure that the core particle is coated with the coating layer.

[0083] The ratio (coating ratio) of tin oxide (SnO_2) in the first metal oxide particle to be used in the present

invention is preferably 10 to 60% by mass. A tin raw material needed for producing tin oxide (SnO_2) needs to be blended at the time of the production of the first metal oxide particle for controlling the coating ratio of tin oxide (SnO_2). For example, when tin chloride (SnCl_4) as a tin raw material is used, the blending needs to be performed in consideration of the amount of tin oxide (SnO_2) to be produced from tin chloride (SnCl_4). Although tin oxide (SnO_2) constituting the coating layer of each of the first metal oxide particle to be used in the present invention is doped with phosphorus (P), tungsten (W), fluorine (F), niobium (Nb), or tantalum (Ta), the coating ratio is a value calculated from the mass of tin oxide (SnO_2) with respect to the total mass of tin oxide (SnO_2) and titanium oxide (TiO_2) without any consideration of the mass of phosphorus (P), tungsten (W), fluorine (F), niobium (Nb), or tantalum (Ta) with which tin oxide (SnO_2) is doped.

[0084] In addition, it is preferred that tin oxide (SnO_2) in the first metal oxide particle or a second metal oxide particle be doped with phosphorus (P), tungsten (W), fluorine (F), niobium (Nb), or tantalum (Ta) in an amount (doping ratio) of 0.1 to 10 mass% with respect to tin oxide (SnO_2) (in terms of mass of the tin oxide containing no phosphorus (P), tungsten (W), fluorine (F), niobium (Nb), and tantalum (Ta)).

[0085] It should be noted that a method of producing the first metal oxide particle (P-doped tin oxide-coated titanium oxide particles, W-doped tin oxide-coated titanium oxide particles, F-doped tin oxide-coated titanium oxide particles, Nb-doped tin oxide-coated titanium oxide particles, or Ta-doped tin oxide-coated titanium oxide particles) is also disclosed in Japanese Patent Application Laid-Open No. H06-207118 and Japanese Patent Application Laid-Open No. 2004-349167.

- [0086] In addition, a method of producing the second metal oxide particle (P-doped tin oxide particles, W-doped tin oxide particles, F-doped tin oxide particles, Nb-doped tin oxide particles, or Ta-doped tin oxide particles) is also disclosed in Japanese Patent No. 3365821, Japanese Patent Application Laid-Open No. H02-197014, Japanese Patent Application Laid-Open No. H09-278445, and Japanese Patent Application Laid-Open No. H10-53417.
- [0087] A particulate shape, a spherical shape, a needle shape, a fibrous shape, a columnar shape, a rod shape, a spindle shape, a plate shape, and other analogous shapes can each be used as the shape of a titanium oxide (TiO_2) particle as the core particle in each of the first metal oxide particle to be used in the present invention. Of those, a spherical shape is preferred from such a viewpoint that an image defect such as a black spot hardly occurs.
- [0088] In addition, any one of the crystal forms such as rutile, anatase, brookite, and amorphous forms can be used as the crystal form of the titanium oxide (TiO_2) particle as the core particle in each of the first metal oxide particle to be used in the present invention. In addition, any one of the production methods such as a sulfuric acid method and a hydrochloric acid method can be adopted as the production method.
- [0089] In the present invention, a first reason why the first metal oxide particle having the core particles (titanium oxide (TiO_2) particles) are used is as described below. Tin oxide (SnO_2) constituting the coating layer of each of the first metal oxide particle has higher electro-conductivity than that of titanium oxide (TiO_2) constituting each core particle and charge received by the second metal oxide particle containing tin oxide (SnO_2) propagates mainly through the coating

layer containing tin oxide (SnO_2) in each of the first metal oxide particle, i.e., the transfer of the charge between tin oxide (SnO_2) is mainly performed, and hence the transfer of the charge between the first metal oxide particle and the second metal oxide particle becomes smooth, and the charge uniformly moves in the conductive layer.

[0090] A second reason why the first metal oxide particle having the core particles (titanium oxide (TiO_2) particles) are used is that an improvement in dispersibility of the second metal oxide particle in a conductive-layer coating solution is achieved. When the second metal oxide particle is used without the use of the first metal oxide particle, the aggregation of the second metal oxide particle is liable to occur in the conductive-layer coating solution to enlarge their average particle diameter, and hence protrusive seeding defects occur in the surface of the conductive layer to be formed or the stability of the conductive-layer coating solution reduces in some cases. In addition, the suppressing effect on the pattern memory is not sufficiently obtained.

[0091] A third reason why the first metal oxide particle having the core particles (titanium oxide (TiO_2) particles) are used is that the titanium oxide (TiO_2) particles as the core particles of the first metal oxide particle each have low transparency as a particle and hence easily cover defects in the surface of the support. In contrast, for example, when barium sulfate particles are used as the core particles, the particles each have high transparency as a particle and hence a material for covering the defects in the surface of the support may be separately needed.

[0092] The particle diameter of each of the titanium oxide (TiO_2) particles as the core particles of the first metal oxide particle to be used in the present

invention is preferably 0.05 μm or more and 0.40 μm or less from the viewpoint of adjusting the average particle diameter of the first metal oxide particle to a preferred range to be described later.

- [0093] The powder resistivity of the first metal oxide particle to be used in the present invention is preferably $1.0 \times 10^1 \Omega \cdot \text{cm}$ or more and $1.0 \times 10^6 \Omega \cdot \text{cm}$ or less, more preferably $1.0 \times 10^2 \Omega \cdot \text{cm}$ or more and $1.0 \times 10^5 \Omega \cdot \text{cm}$ or less.
- [0094] The powder resistivity of the second metal oxide particle to be used in the present invention is preferably $1.0 \times 10^0 \Omega \cdot \text{cm}$ or more and $1.0 \times 10^5 \Omega \cdot \text{cm}$ or less, more preferably $1.0 \times 10^1 \Omega \cdot \text{cm}$ or more and $1.0 \times 10^4 \Omega \cdot \text{cm}$ or less.
- [0095] The powder resistivity of the first metal oxide particle to be used in the present invention is preferably lower than the powder resistivity of the titanium oxide (TiO_2) particles as the core particles of the first metal oxide particle.
- [0096] A method of measuring the powder resistivity of metal oxide particles such as the first metal oxide particle or a second metal oxide particle to be used in the present invention is as described below.
- [0097] The powder resistivity of metal oxide particles such as the first metal oxide particle or a second metal oxide particle to be used in the present invention, or of the core particles of composite particles like the first metal oxide particle to be used in the present invention is measured under a normal-temperature and normal-humidity (23°C/50%RH) environment. In the present invention, a resistivity meter manufactured by Mitsubishi Chemical Corporation (trade name: Loresta GP (Hiresta UP when the powder resistivity exceeded $1.0 \times 10^7 \Omega \cdot \text{cm}$)) was used as a measuring apparatus. The metal oxide particles as measuring objects are compressed into a pellet-shaped sample for measurement

at a pressure of 500 kg/cm². A voltage of 100 V is applied. The core particles are subjected to the measurement before the formation of the coating layer.

[0098] The conductive layer can be formed by applying the conductive-layer coating solution containing a solvent, the binding material, and the first metal oxide particle and the second metal oxide particle onto the support, and drying and/or curing the resultant coating film.

[0099] The conductive-layer coating solution can be prepared by dispersing the first metal oxide particle and the second metal oxide particle together with the binding material into the solvent. As a dispersion method, there are given, for example, methods using a paint shaker, a sand mill, a ball mill, and a liquid collision type high-speed disperser.

[0100] Examples of the binding material to be used in the conductive layer include resins such as a phenol resin, polyurethane, polyamide, polyimide, polyamide-imide, polyvinyl acetal, an epoxy resin, an acrylic resin, a melamine resin, and polyester. The resins may be used alone or in combination of two or more kinds thereof. Further, of those resins, from the viewpoints of, for example, suppression of migration (dissolution) into another layer, adhesiveness with the support, dispersibility and dispersion stability of the particles of the present invention, and solvent resistance after layer formation, a curable resin is preferred, and a thermosetting resin is more preferred. Further, of the thermosetting resins, a thermosetting phenol resin and thermosetting polyurethane are preferred. In the case of using the curable resin as the binding material in the conductive layer, the binding material to be contained in the conductive-layer coating solution is a monomer and/or an oligomer of the curable resin.

- [0101] Examples of the solvent to be used in the conductive-layer coating solution include alcohols such as methanol, ethanol, and isopropanol, ketones such as acetone, methyl ethyl ketone, and cyclohexanone, ethers such as tetrahydrofuran, dioxane, ethylene glycol monomethyl ether, and propylene glycol monomethyl ether, esters such as methyl acetate and ethyl acetate, and aromatic hydrocarbons such as toluene and xylene.
- [0102] In addition, a surface roughness providing material for roughening the surface of the conductive layer may be incorporated into the conductive-layer coating solution in order to suppress the occurrence of interference fringes on an output image due to the interference of light reflected at the surface of the conductive layer. Resin particles having an average particle diameter of 1 μm or more and 5 μm or less are preferred as the surface roughness providing material. Examples of the resin particles include particles of curable resins such as a curable rubber, a polyurethane, an epoxy resin, an alkyd resin, a phenol resin, a polyester, a silicone resin, and an acryl-melamine resin. Of those, particles of a silicone resin that hardly aggregate are preferred. The density (0.5 to 2 g/cm^3) of the resin particles is small as compared with the densities (4 to 8 g/cm^3) of the first metal oxide particle and a second metal oxide particle to be used in the present invention, and hence the surface of the conductive layer can be efficiently roughened at the time of the formation of the conductive layer. In this regard, however, when the content of the surface roughness providing material in the conductive layer increases, the volume resistivity of the conductive layer tends to increase in some cases. Accordingly, the content of the surface roughness providing material in the conductive-layer coating solution is preferably 1 to 80% by mass with respect to the binding material in the

conductive-layer coating solution for adjusting the volume resistivity of the conductive layer to $2.0 \times 10^{13} \Omega \cdot \text{cm}$ or less. In the present invention, the densities [g/cm^3] of the first metal oxide particle, the second metal oxide particle, the binding material (provided that when the binding material was liquid, a cured product thereof was subjected to the measurement), the silicone particles, and the like were determined with a dry auto-densimeter as described below. A helium gas purge was performed ten times as a pretreatment for particles as measuring objects at a temperature of 23°C and a maximum pressure of 19.5 psig with a dry auto-densimeter manufactured by Shimadzu Corporation (trade name: Accupyc 1330) and a container having a capacity of 10 cm^3 . After that, a fluctuation in pressure in a sample chamber of 0.0050 psig/min was used as a pressure equilibrium judgment value as to whether a pressure in the container reached equilibrium. When the fluctuation was equal to or less than the value, the pressure was defined as being in an equilibrium state and then the measurement was initiated to measure any such density [g/cm^3] automatically.

[0103] In addition, a leveling agent for improving the surface property of the conductive layer may be incorporated into the conductive-layer coating solution. In addition, pigment particles may be incorporated into the conductive-layer coating solution for additionally improving the coverage of the conductive layer.

[0104] In addition, the average particle diameter of the first metal oxide particle (P-doped tin oxide-coated titanium oxide particles, W-doped tin oxide-coated titanium oxide particles, F-doped tin oxide-coated titanium oxide particles, Nb-doped tin oxide-coated titanium oxide particles, or Ta-doped tin oxide-coated titanium oxide particles) in the conductive-layer coating solution is preferably $0.10 \mu\text{m}$ or more and $0.45 \mu\text{m}$ or

less, more preferably 0.15 μm or more and 0.40 μm or less. When the average particle diameter is less than 0.10 μm , the reaggregation of the first metal oxide particle is liable to occur after the preparation of the conductive-layer coating solution and hence the stability of the conductive-layer coating solution may reduce. When the average particle diameter is more than 0.45 μm , the surface of the conductive layer roughens to promote the occurrence of local injection of charge into the photosensitive layer, and hence a black spot on the white background of an output image may become conspicuous.

- [0105] In addition, the average particle diameter of the second metal oxide particle (P-doped tin oxide particles, W-doped tin oxide particles, F-doped tin oxide particles, Nb-doped tin oxide particles, or Ta-doped tin oxide particles) in the conductive-layer coating solution is preferably 0.01 μm or more and 0.45 μm or less, more preferably 0.01 μm or more and 0.10 μm or less.
- [0106] The average particle diameters of metal oxide particles such as the first metal oxide particle and a second metal oxide particle in the conductive-layer coating solution can be determined by the following liquid phase sedimentation method or cross-sectional observation with an SEM.
- [0107] First, the conductive-layer coating solution is diluted with the solvent used for its preparation so that its transmittance may fall within the range of 0.8 to 1.0. Next, a histogram of the average particle diameter (volume average particle diameter) and particle size distribution of the metal oxide particles is created with an ultracentrifugal automatic particle size distribution analyzer. In the present invention, the measurement was performed with an ultracentrifugal automatic particle size distribution analyzer (trade

name: CAPA 700) manufactured by HORIBA, Ltd. as the ultracentrifugal automatic particle size distribution analyzer under the condition of a number of rotation of 3,000 rpm.

[0108] From the viewpoint of covering defects in the surface of the support, the thickness of the conductive layer is preferably 10 μm or more and 40 μm or less, more preferably 15 μm or more and 35 μm or less.

[0109] It should be noted that, in the present invention, as an apparatus for measuring the thickness of each layer of the electrophotographic photosensitive member including the conductive layer, FISHERSCOPE mms manufactured by Fisher Instruments K.K. was used.

[0110] The volume resistivity of the conductive layer is preferably $1.0 \times 10^8 \Omega \cdot \text{cm}$ or more and $2.0 \times 10^{13} \Omega \cdot \text{cm}$ or less. When a layer having a volume resistivity of $2.0 \times 10^{13} \Omega \cdot \text{cm}$ or less is provided on the support as a layer for covering the defects in the surface of the support, the flow of charge is hardly disrupted at the time of image formation and hence a residual potential hardly increases. Meanwhile, when the volume resistivity of the conductive layer is $1.0 \times 10^8 \Omega \cdot \text{cm}$ or more, the quantity of the charge flowing in the conductive layer at the time of the charging of the electrophotographic photosensitive member does not become excessively large and hence fogging due to an increase in dark attenuation of the electrophotographic photosensitive member hardly occurs.

[0111] A method of measuring the volume resistivity of the conductive layer of the electrophotographic photosensitive member is described with reference to FIGS. 2 and 3. FIG. 2 is a top view for illustrating the method of measuring the volume resistivity of the conductive layer and FIG. 3 is a cross-sectional view for illustrating the method of measuring the volume resistivity of the conductive layer.

[0112] The volume resistivity of the conductive layer is measured under a normal-temperature and normal-humidity (23°C/50%RH) environment. A copper tape 203 (manufactured by Sumitomo 3M Limited, Type No. 1181) is attached to the surface of a conductive layer 202 and is used as an electrode on the front surface side of the conductive layer 202. In addition, a support 201 is used as an electrode on the back side of the conductive layer 202. A power source 206 for applying a voltage between the copper tape 203 and the support 201, and a current measurement appliance 207 for measuring a current flowing between the copper tape 203 and the support 201 are placed. In addition, a copper wire 204 is mounted on the copper tape 203 for applying a voltage to the copper tape 203 and then the copper wire 204 is fixed to the copper tape 203 by attaching a copper tape 205 similar to the copper tape 203 from above the copper wire 204 so that the copper wire 204 may not protrude from the copper tape 203. A voltage is applied to the copper tape 203 with the copper wire 204.

[0113] When a background current value in the case where no voltage is applied between the copper tape 203 and the support 201 is represented by I_0 [A], a current value in the case where a voltage of -1 V formed only of a DC voltage (DC component) is applied is represented by I [A], the thickness of the conductive layer 202 is represented by d [cm], and the area of the electrode (copper tape 203) on the front surface side of the conductive layer 202 is represented by S [cm²], a value represented by the following expression (26) is defined as a volume resistivity ρ [$\Omega \cdot \text{cm}$] of the conductive layer 202.

[0114] $\rho = 1 / (I - I_0) \times S / d$ [$\Omega \cdot \text{cm}$] ... (26)

[0115] This measurement is preferably performed with an appliance capable of measuring a minute current as the

current measurement appliance 207 because a minute current quantity whose absolute value is 1×10^{-6} A or less is measured in the measurement. Examples of such appliance include a pA meter (trade name: 4140B) manufactured by Yokogawa Hewlett-Packard and a high resistance meter (trade name: 4339B) manufactured by Agilent Technologies.

- [0116] It should be noted that the volume resistivity of the conductive layer measured in a state where only the conductive layer is formed on the support and that measured in a state where only the conductive layer is left on the support by peeling each layer (such as the photosensitive layer) on the conductive layer from the electrophotographic photosensitive member show the same value.
- [0117] In order to prevent the injection of a charge from the conductive layer to the photosensitive layer, an undercoat layer (barrier layer) having electric barrier property may be provided between the conductive layer and the photosensitive layer.
- [0118] The undercoat layer can be formed by coating the conductive layer with an undercoat-layer coating solution containing a resin (binder material) and drying the resultant coating film.
- [0119] Examples of the resin (binder material) to be used in the undercoat layer include a polyvinyl alcohol, a polyvinyl methyl ether, a polyacrylic acids, a methylcellulose, an ethylcellulose, a polyglutamic acid, casein, starch, and other water-soluble resins, a polyamide, a polyimide, a polyamide-imide, a polyamic acid, a melamine resin, an epoxy resin, a polyurethane, and a polyglutamate. Of those, thermoplastic resins are preferred to effectively express the electric barrier property of the undercoat layer. Of the thermoplastic resins, a thermoplastic polyamide is preferred. The polyamide is preferably a copolymerized

nylon.

- [0120] The thickness of the undercoat layer is preferably 0.1 μm or more and 2.0 μm or less.
- [0121] In addition, an electron-transporting substance (electron-accepting substance such as an acceptor) may be contained in the undercoat layer to prevent the flow of charge from being disrupted in the undercoat layer.
- [0122] Examples of the electron-transporting substance include electron-withdrawing substances such as 2,4,7-trinitrofluorenone, 2,4,5,7-tetranitrofluorenone, chloranil, and tetracyanoquinodimethane, and polymers of those electron-withdrawing substances.
- [0123] The photosensitive layer is provided on the conductive layer (undercoat layer).
- [0124] Examples of the charge-generating substance to be used in the photosensitive layer include: azo pigments such as monoazo, disazo, and trisazo; phthalocyanine pigments such as metal phthalocyanine and non-metal phthalocyanine; indigo pigments such as indigo and thioindigo; perylene pigments such as perylene acid anhydride and perylene acid imide; polycyclic quinone pigments such as anthraquinone and pyrenequinone; squarylium dyes; pyrylium salts and thiapyrylium salts; triphenylmethane dyes; quinacridone pigments; azulanium salt pigments; cyanine dyes; xanthene dyes; quinonimine dyes; and styryl dyes. Of those, metal phthalocyanines such as oxytitanium phthalocyanine, hydroxygallium phthalocyanine, and chlorogallium phthalocyanine are preferred.
- [0125] When the photosensitive layer is a laminated type photosensitive layer, the charge-generating layer can be formed by applying a charge-generating-layer coating solution, which is prepared by dispersing a charge-generating substance into a solvent together with a binder material, and then drying the resultant coating film. As a dispersion method, there are given, for

example, methods using a homogenizer, an ultrasonic wave, a ball mill, a sand mill, an attritor, and a roll mill.

- [0126] Examples of the binder material to be used in the charge-generating layer include a polycarbonate, a polyester, a polyarylate, a butyral resin, a polystyrene, a polyvinyl acetal, a diallyl phthalate resin, an acrylic resin, a methacrylic resin, a vinyl acetate resin, a phenol resin, a silicone resin, a polysulfone, a styrene-butadiene copolymer, an alkyd resin, an epoxy resin, a urea resin, and a vinyl chloride-vinyl acetate copolymer. Those binder materials may be used alone or as a mixture or a copolymer of two or more kinds thereof.
- [0127] The ratio of the charge-generating substance to the binder material (charge-generating substance:binder material) falls within the range of preferably 10:1 to 1:10 (mass ratio), more preferably 5:1 to 1:1 (mass ratio).
- [0128] Examples of the solvent to be used in the charge-generating-layer coating solution include an alcohol, a sulfoxide, a ketone, an ether, an ester, an aliphatic halogenated hydrocarbon, and an aromatic compound.
- [0129] The thickness of the charge-generating layer is preferably 5 μm or less, more preferably 0.1 μm or more and 2 μm or less.
- [0130] Further, any of various sensitizers, antioxidants, UV absorbers, plasticizers, and the like may be added to the charge-generating layer as required. Further, an electron-transporting substance (electron-accepting substance such as an acceptor) may be contained in the charge-generating layer to prevent the flow of charge from being disrupted in the charge-generating layer.
- [0131] Examples of the electron-transporting substance include electron-withdrawing substances such as 2,4,7-trinitrofluorenone, 2,4,5,7-tetranitrofluorenone,

chloranil, and tetracyanoquinodimethane, and polymers of those electron-withdrawing substances.

[0132] Examples of the charge-transporting substance to be used in the photosensitive layer include a triarylamine compound, a hydrazone compound, a styryl compound, a stilbene compound, a pyrazoline compound, an oxazole compound, a thiazole compound, and a triarylmethane compound.

[0133] When the photosensitive layer is a laminated type photosensitive layer, the charge-transporting layer can be formed by applying a charge-transporting-layer coating solution, which is prepared by dissolving a charge-transporting substance and a binder material in a solvent, and then drying the resultant coating film.

[0134] Examples of the binder material to be used in the charge-transporting layer include an acrylic resin, a styrene resin, a polyester, a polycarbonate, a polyarylate, a polysulfone, a polyphenylene oxide, an epoxy resin, a polyurethane, an alkyd resin, and an unsaturated resin. Those binder materials may be used alone or as a mixture or a copolymer of two or more kinds thereof.

[0135] The ratio of the charge-transporting substance to the binder material (charge-transporting substance:binder material) preferably falls within the range of 2:1 to 1:2 (mass ratio).

[0136] Examples of the solvent to be used in the charge-transporting-layer coating solution include: ketones such as acetone and methyl ethyl ketone; esters such as methyl acetate and ethyl acetate; ethers such as dimethoxymethane and dimethoxyethane; aromatic hydrocarbons such as toluene and xylene; and hydrocarbons each substituted by a halogen atom, such as chlorobenzene, chloroform, and carbon tetrachloride.

[0137] The thickness of the charge-transporting layer is preferably 3 μm or more and 40 μm or less, more

preferably 4 μm or more and 30 μm or less from the viewpoints of charging uniformity and image reproducibility.

- [0138] Further, an antioxidant, a UV absorber, or a plasticizer may be added to the charge-transporting layer as required.
- [0139] When the photosensitive layer is a single-layer type photosensitive layer, the single-layer type photosensitive layer can be formed by applying a single-layer-type-photosensitive-layer coating solution containing a charge-generating substance, a charge-transporting substance, a binder material, and a solvent, and then drying the resultant coating film. As the charge-generating substance, the charge-transporting substance, the binder material, and the solvent, for example, those of various kinds described above can be used.
- [0140] Further, a protective layer may be formed on the photosensitive layer to protect the photosensitive layer. The protective layer can be formed by applying a protective-layer coating solution containing a resin (binder material), and then drying and/or curing the resultant coating film.
- [0141] The thickness of the protective layer is preferably 0.5 μm or more and 10 μm or less, more preferably 1 μm or more and 8 μm to less.
- [0142] In the application of each of the coating solutions corresponding to the respective layers, coating methods such as dip coating, spray coating, spinner coating, roller coating, Meyer bar coating, and blade coating may be employed.
- [0143] FIG. 1 illustrates an example of the schematic construction of an electrophotographic apparatus including a process cartridge having an electrophotographic photosensitive member.
- [0144] In FIG. 1, an electrophotographic photosensitive member

1 having a drum shape (cylindrical shape) is driven to rotate around an axis 2 in a direction indicated by the arrow at a predetermined peripheral speed.

[0145] The circumferential surface of the electrophotographic photosensitive member 1 to be driven to rotate is uniformly charged at a positive or negative predetermined potential by a charging device (such as a primary charging device or a charging roller) 3, and then receives exposure light (image exposure light) 4 emitted from an exposing device (not shown) such as a slit exposure or a laser-beam scanning exposure. Thus, electrostatic latent images corresponding to images of interest are sequentially formed on the circumferential surface of the electrophotographic photosensitive member 1. A voltage to be applied to the charging device 3 may be only a DC voltage, or may be a DC voltage superimposed with an AC voltage.

[0146] The electrostatic latent images formed on the circumferential surface of the electrophotographic photosensitive member 1 are converted into toner images by development with toner of a developing device 5. Subsequently, the toner images formed on the circumferential surface of the electrophotographic photosensitive member 1 are transferred to a transfer material (such as paper) P by a transfer bias from a transferring device (such as a transfer roller) 6. The transfer material P is fed with a transfer material feeding device (not shown) to a portion (abutment portion) between the electrophotographic photosensitive member 1 and the transferring device 6 in synchronization with the rotation of the electrophotographic photosensitive member 1.

[0147] The transfer material P which has received the transfer of the toner images is separated from the circumferential surface of the electrophotographic photosensitive member 1, introduced to a fixing device

8, subjected to image fixation, and then printed as an image-formed product (print or copy) out of the apparatus.

[0148] The circumferential surface of the electrophotographic photosensitive member 1 after the transfer of the toner images undergoes removal of the remaining toner after the transfer by a cleaning device (such as a cleaning blade) 7. Further, the circumferential surface of the electrophotographic photosensitive member 1 is subjected to a neutralization process with pre-exposure light 11 from a pre-exposing device (not shown) and then repeatedly used in image formation. It should be noted that, when the charging device is a contact-charging device such as a charging roller, the pre-exposure is not always required. It should also be noted that, when the electrophotographic apparatus adopts a cleaner-less system, the cleaning device is not always required.

[0149] The electrophotographic photosensitive member 1 and at least one structural component selected from the charging device 3, the developing device 5, the transferring device 6, the cleaning device 7, and the like may be housed in a container and then integrally supported as a process cartridge. In addition, the process cartridge may be detachably mountable to the main body of an electrophotographic apparatus. In FIG. 1, the electrophotographic photosensitive member 1, and the charging device 3, the developing device 5, and the cleaning device 7 are integrally supported as a cartridge, thereby forming a process cartridge 9, which is detachably mountable to the main body of an electrophotographic apparatus, through use of a guiding device 10 such as a rail of the main body of the electrophotographic apparatus. Further, the electrophotographic apparatus may have a construction including the electrophotographic photosensitive member

1, and the charging device 3, the exposing device, the developing device 5, and the transferring device 6.

Example

[0150] Hereinafter, the present invention is described in more detail by way of specific examples, provided that the present invention is not limited thereto. It should be noted that the term "part(s)" in each of Examples and Comparative Examples means "part(s) by mass," the term "average particle diameter" means "average primary particle diameter," the unit "%" of a coating ratio in each table means "% by mass," and the unit "%" of a doping ratio (doping amount) means "% by mass." In addition, densities in Examples and the tables are each a value determined by the foregoing method and are each represented in the unit of "g/cm³."

[0151] <Preparation examples of conductive-layer coating solutions>

(Preparation example of conductive-layer coating solution CP-1)

112.00 Parts of P-doped tin oxide-coated titanium oxide particles (average primary particle diameter: 230 nm, powder resistivity: 5,000 $\Omega \cdot \text{cm}$, amount (doping ratio) of phosphorus doped into tin oxide: 4.50% by mass, coating ratio: 45% by mass, density: 5.1 g/cm³) as a first metal oxide particle, 3.00 parts of P-doped tin oxide particles (average primary particle diameter: 20 nm, powder resistivity: 300 $\Omega \cdot \text{cm}$, amount (doping ratio) of phosphorus doped into tin oxide: 3.60% by mass, density: 6.8 g/cm³) as a second metal oxide particle, 266.67 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 120 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using 465 parts of glass beads each having a diameter of 0.8 mm, and were then subjected to a dispersion treatment under the following dispersion

treatment conditions to provide a dispersion solution: a disc rotation number of 2,000 rpm, a dispersion treatment time of 4.5 hours, and a setting temperature of cooling water of 18°C.

- [0152] The glass beads were removed from the dispersion solution with a mesh. After that, 5.00 parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material and 0.30 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent were added to the dispersion solution, and then the mixture was stirred for 30 minutes to prepare a conductive-layer coating solution CP-1.
- [0153] (Preparation examples of conductive-layer coating solutions CP-2 to CP-93, CP-141 to CP-233, CP-281 to CP-373, CP-421 to CP-513, and CP-561 to CP-653)
- [0154] Conductive-layer coating solutions CP-2 to CP-93, CP-141 to CP-233, CP-281 to CP-373, CP-421 to CP-513, and CP-561 to CP-653 were prepared by the same operations as those of the preparation example of the conductive-layer coating solution CP-1 except that the kind (including a coating ratio, a doping ratio, and a density, the same holds true for the following) and amount of the first metal oxide particle, the kind (including a doping ratio and a density, the same holds true for the following) and amount of the second metal oxide particle, and the amount of the binding material were changed as shown in Tables 1 to 3, 8 to 10, 15 to 17, 44 to 46, and 49 to 51.
- [0155] It should be noted that P-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-2 to CP-93 had a powder resistivity of 5,000 $\Omega\cdot\text{cm}$.

- [0156] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-7, CP-13, CP-19, CP-24, CP-29, CP-35, CP-40, CP-45, CP-50, CP-55, CP-61, CP-66, CP-71, CP-77, CP-83, and CP-89 had a powder resistivity of 300 $\Omega \cdot \text{cm}$.
- [0157] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-2, CP-8, CP-14, CP-20, CP-25, CP-30, CP-36, CP-41, CP-46, CP-51, CP-56, CP-62, CP-67, CP-72, CP-78, CP-84, and CP-90 had a powder resistivity of 250 $\Omega \cdot \text{cm}$. In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-3, CP-6, CP-9, CP-12, CP-15, CP-18, CP-21, CP-26, CP-31, CP-34, CP-37, CP-42, CP-47, CP-52, CP-57, CP-60, CP-63, CP-68, CP-73, CP-76, CP-79, CP-82, CP-85, CP-88, and CP-91 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.
- [0158] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-4, CP-10, CP-16, CP-22, CP-27, CP-32, CP-38, CP-43, CP-48, CP-53, CP-58, CP-64, CP-69, CP-74, CP-80, CP-86, and CP-92 had a powder resistivity of 150 $\Omega \cdot \text{cm}$.
- [0159] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-5, CP-11, CP-17, CP-23, CP-28, CP-33, CP-39, CP-44, CP-49, CP-54, CP-59, CP-65, CP-70, CP-75, CP-81, CP-87, and CP-93 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.
- [0160] In addition, W-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-141 to CP-233 had a powder resistivity of 3,000 $\Omega \cdot \text{cm}$.
- [0161] In addition, W-doped tin oxide particles used as the

second metal oxide particle in the preparation of the conductive-layer coating solutions CP-141, CP-147, CP-153, CP-159, CP-164, CP-169, CP-175, CP-180, CP-185, CP-190, CP-195, CP-201, CP-206, CP-211, CP-217, CP-223, and CP-229 had a powder resistivity of 180 $\Omega \cdot \text{cm}$.

[0162] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-142, CP-148, CP-154, CP-160, CP-165, CP-170, CP-176, CP-181, CP-186, CP-191, CP-196, CP-202, CP-207, CP-212, CP-218, CP-224, and CP-230 had a powder resistivity of 140 $\Omega \cdot \text{cm}$.

[0163] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-143, CP-146, CP-149, CP-152, CP-155, CP-158, CP-161, CP-166, CP-171, CP-174, CP-177, CP-182, CP-187, CP-192, CP-197, CP-200, CP-203, CP-208, CP-213, CP-216, CP-219, CP-222, CP-225, CP-228, and CP-231 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.

[0164] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-144, CP-150, CP-156, CP-162, CP-167, CP-172, CP-178, CP-183, CP-188, CP-193, CP-198, CP-204, CP-209, CP-214, CP-220, CP-226, and CP-232 had a powder resistivity of 70 $\Omega \cdot \text{cm}$.

[0165] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-145, CP-151, CP-157, CP-163, CP-168, CP-173, CP-179, CP-184, CP-189, CP-194, CP-199, CP-205, CP-210, CP-215, CP-221, CP-227, and CP-233 had a powder resistivity of 30 $\Omega \cdot \text{cm}$.

[0166] In addition, F-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-281 to CP-373 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.

[0167] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the

conductive-layer coating solutions CP-281, CP-287, CP-293, CP-299, CP-304, CP-309, CP-315, CP-320, CP-325, CP-330, CP-335, CP-341, CP-346, CP-351, CP-357, CP-363, and CP-369 had a powder resistivity of 300 $\Omega \cdot \text{cm}$.

[0168] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-282, CP-288, CP-294, CP-300, CP-305, CP-310, CP-316, CP-321, CP-326, CP-331, CP-336, CP-342, CP-347, CP-352, CP-358, CP-364 and CP-370 had a powder resistivity of 270 $\Omega \cdot \text{cm}$.

[0169] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-283, CP-286, CP-289, CP-292, CP-295, CP-298, CP-301, CP-306, CP-311, CP-314, CP-317, CP-322, CP-327, CP-332, CP-337, CP-340, CP-343, CP-348, CP-353, CP-356, CP-359, CP-362, CP-365, CP-368, and CP-371 had a powder resistivity of 220 $\Omega \cdot \text{cm}$.

[0170] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-284, CP-290, CP-296, CP-302, CP-307, CP-312, CP-318, CP-323, CP-328, CP-333, CP-338, CP-344, CP-349, CP-354, CP-360, CP-366, and CP-372 had a powder resistivity of 170 $\Omega \cdot \text{cm}$.

[0171] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-285, CP-291, CP-297, CP-303, CP-308, CP-313, CP-319, CP-324, CP-329, CP-334, CP-339, CP-345, CP-350, CP-355, CP-361, CP-367, and CP-373 had a powder resistivity of 130 $\Omega \cdot \text{cm}$.

[0172] In addition, Nb-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-421 to CP-513 had a powder resistivity of 6,500 $\Omega \cdot \text{cm}$.

[0173] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-421, CP-427, CP-

433, CP-439, CP-444, CP-449, CP-455, CP-460, CP-465, CP-470, CP-475, CP-481, CP-486, CP-491, CP-497, CP-503, and CP-509 had a powder resistivity of 400 $\Omega \cdot \text{cm}$.

[0174] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-422, CP-428, CP-434, CP-440, CP-445, CP-450, CP-456, CP-461, CP-466, CP-471, CP-476, CP-482, CP-487, CP-492, CP-498, CP-504, and CP-510 had a powder resistivity of 360 $\Omega \cdot \text{cm}$.

[0175] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-423, CP-426, CP-429, CP-432, CP-435, CP-438, CP-441, CP-446, CP-451, CP-454, CP-457, CP-462, CP-467, CP-472, CP-477, CP-480, CP-483, CP-488, CP-493, CP-496, CP-499, CP-502, CP-505, CP-508, and CP-511 had a powder resistivity of 330 $\Omega \cdot \text{cm}$.

[0176] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-424, CP-430, CP-436, CP-442, CP-447, CP-452, CP-458, CP-463, CP-468, CP-473, CP-478, CP-484, CP-489, CP-494, CP-500, CP-506, and CP-512 had a powder resistivity of 300 $\Omega \cdot \text{cm}$.

[0177] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-425, CP-431, CP-437, CP-443, CP-448, CP-453, CP-459, CP-464, CP-469, CP-474, CP-479, CP-485, CP-490, CP-495, CP-501, CP-507, and CP-513 had a powder resistivity of 270 $\Omega \cdot \text{cm}$.

[0178] In addition, Ta-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-561 to CP-653 had a powder resistivity of 4,500 $\Omega \cdot \text{cm}$.

[0179] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-561, CP-567, CP-573, CP-579, CP-584, CP-589, CP-595, CP-600, CP-605,

CP-610, CP-615, CP-621, CP-626, CP-631, CP-637, CP-643, and CP-649 had a powder resistivity of 270 $\Omega \cdot \text{cm}$.

[0180] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-562, CP-568, CP-574, CP-580, CP-585, CP-590, CP-596, CP-601, CP-606, CP-611, CP-616, CP-622, CP-627, CP-632, CP-638, CP-644, and CP-650 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.

[0181] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-563, CP-566, CP-569, CP-572, CP-575, CP-578, CP-581, CP-586, CP-591, CP-594, CP-597, CP-602, CP-607, CP-612, CP-617, CP-620, CP-623, CP-628, CP-633, CP-636, CP-639, CP-642, CP-645, CP-648, and CP-651 had a powder resistivity of 160 $\Omega \cdot \text{cm}$.

[0182] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-564, CP-570, CP-576, CP-582, CP-587, CP-592, CP-598, CP-603, CP-608, CP-613, CP-618, CP-624, CP-629, CP-634, CP-640, CP-646, and CP-652 had a powder resistivity of 110 $\Omega \cdot \text{cm}$.

[0183] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-565, CP-571, CP-577, CP-583, CP-588, CP-593, CP-599, CP-604, CP-609, CP-614, CP-619, CP-625, CP-630, CP-635, CP-641, CP-647, and CP-653 had a powder resistivity of 65 $\Omega \cdot \text{cm}$.

[0184] (Preparation examples of conductive-layer coating solutions CP-94 to CP-140, CP-234 to CP-280, CP-374 to CP-420, CP-514 to CP-560, and CP-654 to CP-700)
Conductive-layer coating solutions CP-94 to CP-140, CP-234 to CP-280, CP-374 to CP-420, CP-514 to CP-560, and CP-654 to CP-700 were prepared by the same operations as those of the preparation example of the conductive-layer coating solution CP-1 except that: the kind and amount of the first metal oxide particle, the kind and

amount of the second metal oxide particle, the amount of the binding material, and the amount of the silicone resin particles were changed as shown in Tables 3, 4, 11, 12, 18, 19, 46, 47, 52, and 53; and the operation for the dispersion treatment was carried out by adding 30.00 parts of uncoated titanium oxide particles (powder resistivity: $5.0 \times 10^7 \Omega \cdot \text{cm}$, average particle diameter: 210 nm, density: 4.2 g/cm^3) at the time of the operation for the dispersion treatment. It should be noted that when the conductive-layer coating solutions CP-139, CP-279, CP-419, CP-559, and CP-699 were prepared, the disc rotation number and dispersion treatment time in the dispersion treatment conditions were changed to 2,500 rpm and 10 hours, respectively. In addition, when the conductive-layer coating solutions CP-140, CP-280, CP-420, CP-560, and CP-700 were prepared, the disc rotation number and dispersion treatment time in the dispersion treatment conditions were changed to 2,500 rpm and 30 hours, respectively.

[0185] It should be noted that P-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-94 to CP-140 had a powder resistivity of $5,000 \Omega \cdot \text{cm}$.

[0186] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-94, CP-99, CP-104, CP-109, CP-114, CP-119, CP-124, CP-129, and CP-134 had a powder resistivity of $300 \Omega \cdot \text{cm}$.

[0187] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-95, CP-100, CP-105, CP-110, CP-115, CP-120, CP-125, CP-130, and CP-135 had a powder resistivity of $250 \Omega \cdot \text{cm}$.

[0188] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the

conductive-layer coating solutions CP-96, CP-101, CP-106, CP-111, CP-116, CP-121, CP-126, CP-131, CP-136, CP-139, and CP-140 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.

[0189] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-97, CP-102, CP-107, CP-112, CP-117, CP-122, CP-127, CP-132, and CP-137 had a powder resistivity of 150 $\Omega \cdot \text{cm}$.

[0190] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-98, CP-103, CP-108, CP-113, CP-118, CP-123, CP-128, CP-133, and CP-138 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.

[0191] In addition, W-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-234 to CP-280 had a powder resistivity of 3,000 $\Omega \cdot \text{cm}$.

[0192] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-234, CP-239, CP-244, CP-249, CP-254, CP-259, CP-264, CP-269, and CP-274 had a powder resistivity of 180 $\Omega \cdot \text{cm}$.

[0193] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-235, CP-240, CP-245, CP-250, CP-255, CP-260, CP-265, CP-270, and CP-275 had a powder resistivity of 140 $\Omega \cdot \text{cm}$.

[0194] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-236, CP-241, CP-246, CP-251, CP-256, CP-261, CP-266, CP-271, CP-276, CP-279, and CP-280 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.

[0195] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-237, CP-242, CP-247, CP-252, CP-257, CP-262, CP-267, CP-272, and CP-277

had a powder resistivity of 70 $\Omega \cdot \text{cm}$.

[0196] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-238, CP-243, CP-248, CP-253, CP-258, CP-263, CP-268, CP-273, and CP-278 had a powder resistivity of 30 $\Omega \cdot \text{cm}$.

[0197] In addition, F-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-374 to CP-420 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.

[0198] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-374, CP-379, CP-384, CP-389, CP-394, CP-399, CP-404, CP-409, and CP-414 had a powder resistivity of 300 $\Omega \cdot \text{cm}$.

[0199] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-375, CP-380, CP-385, CP-390, CP-395, CP-400, CP-405, CP-410, and CP-415 had a powder resistivity of 270 $\Omega \cdot \text{cm}$.

[0200] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-376, CP-381, CP-386, CP-391, CP-396, CP-401, CP-406, CP-411, CP-416, CP-419, and CP-420 had a powder resistivity of 220 $\Omega \cdot \text{cm}$.

[0201] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-377, CP-382, CP-387, CP-392, CP-397, CP-402, CP-407, CP-412, and CP-417 had a powder resistivity of 170 $\Omega \cdot \text{cm}$.

[0202] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-378, CP-383, CP-388, CP-393, CP-398, CP-403, CP-408, CP-413, and CP-418 had a powder resistivity of 130 $\Omega \cdot \text{cm}$.

[0203] In addition, Nb-doped tin oxide-coated titanium oxide

particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-514 to CP-560 had a powder resistivity of 6,500 $\Omega \cdot \text{cm}$.

- [0204] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-514, CP-519, CP-524, CP-529, CP-534, CP-539, CP-544, CP-549, and CP-554 had a powder resistivity of 400 $\Omega \cdot \text{cm}$. In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-515, CP-520, CP-525, CP-530, CP-535, CP-540, CP-545, CP-550, and CP-555 had a powder resistivity of 360 $\Omega \cdot \text{cm}$.
- [0205] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-516, CP-521, CP-526, CP-531, CP-536, CP-541, CP-546, CP-551, CP-556, CP-559, and CP-560 had a powder resistivity of 330 $\Omega \cdot \text{cm}$.
- [0206] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-517, CP-522, CP-527, CP-532, CP-537, CP-542, CP-547, CP-552, and CP-557 had a powder resistivity of 300 $\Omega \cdot \text{cm}$.
- [0207] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-518, CP-523, CP-528, CP-533, CP-538, CP-543, CP-548, CP-553, and CP-558 had a powder resistivity of 270 $\Omega \cdot \text{cm}$.
- [0208] In addition, Ta-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-654 to CP-700 had a powder resistivity of 4,500 $\Omega \cdot \text{cm}$.
- [0209] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-654, CP-659, CP-664, CP-669, CP-674, CP-679, CP-684, CP-689, and CP-694

had a powder resistivity of 270 $\Omega \cdot \text{cm}$.

[0210] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-655, CP-660, CP-665, CP-670, CP-675, CP-680, CP-685, CP-690, and CP-695 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.

[0211] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-656, CP-661, CP-666, CP-671, CP-676, CP-681, CP-686, CP-691, CP-696, CP-699, and CP-700 had a powder resistivity of 160 $\Omega \cdot \text{cm}$.

[0212] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-657, CP-662, CP-667, CP-672, CP-677, CP-682, CP-687, CP-692, and CP-697 had a powder resistivity of 110 $\Omega \cdot \text{cm}$.

[0213] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-658, CP-663, CP-668, CP-673, CP-678, CP-683, CP-688, CP-693, and CP-698 had a powder resistivity of 65 $\Omega \cdot \text{cm}$.

[0214] (Preparation examples of conductive-layer coating solutions CP-C1 to CP-C22, CP-C42 to CP-C63, CP-C76 to CP-C97, CP-C107 to CP-C128, and CP-C129 to CP-C150)
Conductive-layer coating solutions CP-C1 to CP-C22, CP-C42 to CP-C63, CP-C76 to CP-C97, CP-C107 to CP-C128, and CP-C129 to CP-C150 were prepared by the same operations as those of the preparation example of the conductive-layer coating solution CP-1 except that the kind and amount of the first metal oxide particle, the kind and amount of the second metal oxide particle, and the amount of the binding material were changed (including a change as to whether or not the first metal oxide particle or the second metal oxide particle were used, the same holds true for the following) as shown in Tables 5, 13, 20, 48, and 54.

- [0215] It should be noted that P-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-C1 to CP-C9 and CP-C13 to CP-C22 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0216] In addition, P-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-C4 to CP-C22 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.
- [0217] In addition, W-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-C42 to CP-C50 and CP-C54 to CP-C63 had a powder resistivity of 3,000 $\Omega \cdot \text{cm}$.
- [0218] In addition, W-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-C45 to CP-C63 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.
- [0219] In addition, F-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-C76 to CP-C84 and CP-C88 to CP-C97 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0220] In addition, F-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-C79 to CP-C97 had a powder resistivity of 220 $\Omega \cdot \text{cm}$.
- [0221] In addition, Nb-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-C107 to CP-C115 and CP-C119 to CP-C128 had a powder resistivity of 6,500 $\Omega \cdot \text{cm}$.
- [0222] In addition, Nb-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-C110 to CP-C128 had a powder resistivity of 330 $\Omega \cdot \text{cm}$.

[0223] In addition, Ta-doped tin oxide-coated titanium oxide particles used as the first metal oxide particle in the preparation of the conductive-layer coating solutions CP-C129 to CP-C137 and CP-C141 to CP-C150 had a powder resistivity of 4,500 $\Omega \cdot \text{cm}$.

[0224] In addition, Ta-doped tin oxide particles used as the second metal oxide particle in the preparation of the conductive-layer coating solutions CP-C132 to CP-C150 had a powder resistivity of 160 $\Omega \cdot \text{cm}$.

[0225] (Preparation examples of conductive-layer coating solutions CP-C23 to CP-C35, CP-C64 to CP-C71, CP-C98 to CP-C105, CP-C151 to CP-C178, and CP-C179)

Conductive-layer coating solutions CP-C23 to CP-C35, CP-C64 to CP-C71, CP-C98 to CP-C105, and CP-C151 to CP-C179 were prepared by the same operations as those of the preparation example of the conductive-layer coating solution CP-1 except that the kind and amount of the first metal oxide particle, the kind and amount of the second metal oxide particle, and the amount of the binding material were changed as shown in Tables 6, 7, 14, 21, and 55 to 58. It should be noted that in the tables, for example, titanium oxide particles coated with oxygen-deficient tin oxide (oxygen-deficient tin oxide-coated titanium oxide particles) do not correspond to the first metal oxide particle according to the present invention and oxygen-deficient tin oxide particles do not correspond to the second metal oxide particle according to the present invention, but the particles were shown in the respective columns for convenience as examples to be compared with the present invention. The same holds true for the following.

[0226] It should be noted that P-doped tin oxide-coated titanium oxide particles used in the preparation of the conductive-layer coating solutions CP-C26 to CP-C28, CP-C31 to CP-C32, CP-C153, and CP-C154 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.

- [0227] In addition, P-doped tin oxide-coated barium sulfate particles used in the preparation of the conductive-layer coating solution CP-C35 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0228] In addition, P-doped tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C23 to CP-C25, CP-C29, CP-C30, CP-C35, CP-151, and CP-152 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.
- [0229] In addition, W-doped tin oxide-coated titanium oxide particles used in the preparation of the conductive-layer coating solutions CP-C67 to CP-C69, CP-C104, CP-C157, and CP-C158 had a powder resistivity of 3,000 $\Omega \cdot \text{cm}$.
- [0230] In addition, W-doped tin oxide-coated barium sulfate particles used in the preparation of the conductive-layer coating solution CP-C71 had a powder resistivity of 3,000 $\Omega \cdot \text{cm}$.
- [0231] In addition, W-doped tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C31, CP-C64 to CP-C66, CP-C70, CP-C71, CP-C155, and CP-C156 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.
- [0232] In addition, F-doped tin oxide-coated titanium oxide particles used in the preparation of the conductive-layer coating solutions CP-C30, CP-C70, CP-C101 to CP-C103, CP-C161, and CP-C162 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0233] In addition, F-doped tin oxide-coated barium sulfate particles used in the preparation of the conductive-layer coating solution CP-C105 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0234] In addition, F-doped tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C32, CP-C159, and CP-C160 had a powder resistivity of 220 $\Omega \cdot \text{cm}$.
- [0235] In addition, Nb-doped tin oxide-coated titanium oxide particles used in the preparation of the conductive-

layer coating solutions CP-C151, CP-C155, CP-C159, CP-C166 to CP-C168, and CP-C170 had a powder resistivity of 6,500 $\Omega \cdot \text{cm}$.

- [0236] In addition, Nb-doped tin oxide-coated barium sulfate particles used in the preparation of the conductive-layer coating solution CP-C171 had a powder resistivity of 6,500 $\Omega \cdot \text{cm}$.
- [0237] In addition, Nb-doped tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C153, CP-C157, CP-C161, CP-C163 to CP-C165, CP-C169, and CP-C171 had a powder resistivity of 330 $\Omega \cdot \text{cm}$.
- [0238] In addition, Ta-doped tin oxide-coated titanium oxide particles used in the preparation of the conductive-layer coating solutions CP-C152, CP-C156, CP-C160, CP-C169, and CP-C175 to CP-C177 had a powder resistivity of 4,500 $\Omega \cdot \text{cm}$.
- [0239] In addition, Ta-doped tin oxide-coated barium sulfate particles used in the preparation of the conductive-layer coating solution CP-C178 had a powder resistivity of 4,500 $\Omega \cdot \text{cm}$.
- [0240] In addition, Ta-doped tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C154, CP-C158, CP-C162, CP-C170, CP-C172 to CP-C174, and CP-C178 had a powder resistivity of 160 $\Omega \cdot \text{cm}$.
- [0241] In addition, oxygen-deficient tin oxide-coated titanium oxide particles used in the preparation of the conductive-layer coating solutions CP-C23, CP-C64, CP-C98, CP-C163, and CP-C172 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0242] In addition, oxygen-deficient tin oxide-coated barium sulfate particles used in the preparation of the conductive-layer coating solutions CP-C24, CP-C33, CP-C65, CP-C99, CP-C164, CP-C173, and CP-C179 had a powder resistivity of 5,000 $\Omega \cdot \text{cm}$.
- [0243] In addition, Sb-doped tin oxide-coated titanium oxide particles used in the preparation of the conductive-

layer coating solutions CP-C25, CP-C34, CP-C66, CP-C100, CP-C165, and CP-C174 had a powder resistivity of 3,000 $\Omega \cdot \text{cm}$.

[0244] In addition, oxygen-deficient tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C26, CP-C33, CP-C67, CP-C101, CP-C166, CP-C175, and CP-C179 had a powder resistivity of 200 $\Omega \cdot \text{cm}$.

[0245] In addition, indium tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C27, CP-C68, CP-C102, CP-C167, and CP-C176 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.

[0246] In addition, Sb-doped tin oxide particles used in the preparation of the conductive-layer coating solutions CP-C28, CP-C34, CP-C69, CP-C103, CP-C168, and CP-C177 had a powder resistivity of 100 $\Omega \cdot \text{cm}$.

[0247] (Preparation example of conductive-layer coating solution CP-C36)

The intermediate-layer coating liquid of Example 1 described in Patent Literature 4 was prepared by the following operations and defined as a conductive-layer coating solution CP-C36.

[0248] That is, 20 parts of barium sulfate particles coated with oxygen-deficient tin oxide (coating ratio: 50% by mass, average primary particle diameter: 600 nm, specific gravity: 5.1 (density=5.1 g/cm³)), 100 parts of a tin oxide particle doped with antimony (trade name: T-1, manufactured by Mitsubishi Materials Corporation, average primary particle diameter: 20 nm, powder resistivity: 5 $\Omega \cdot \text{cm}$, specific gravity: 6.6 (density=6.6 g/cm³)), 70 parts of a resol-type phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60%) as a binding material, and 100 parts of 2-methoxy-1-propanol were loaded into a ball mill, and were then subjected to a dispersion treatment for 20 hours to prepare a conductive-layer coating solution CP-C36.

[0249] (Preparation example of conductive-layer coating solution CP-C37)

A conductive-layer coating solution CP-C37 was prepared by the same operations as those of the preparation example of the conductive-layer coating solution CP-C36 except that the tin oxide particle doped with antimony were changed to a tin oxide particle doped with tantalum (average primary particle diameter: 20 nm, specific gravity: 6.1 (density=6.1 g/cm³)).

[0250] (Preparation example of conductive-layer coating solution CP-C38)

The conductive layer coating fluid L-7 described in Patent Literature 2 was prepared by the following operations and defined as a conductive-layer coating solution CP-C38.

[0251] That is, 46 parts of P-doped tin oxide-coated titanium oxide particles (average primary particle diameter: 220 nm, powder resistivity: 100 Ω·cm, amount (doping ratio) of phosphorus doped into tin oxide: 7% by mass, coating ratio: 15%), 36.5 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 50 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using glass beads each having a diameter of 0.5 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a disc rotation number of 2,500 rpm and a dispersion treatment time of 3.5 hours.

[0252] 3.9 Parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material and 0.001 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent were added to the dispersion solution, and then the

mixture was stirred to prepare a conductive-layer coating solution CP-C38.

[0253] (Preparation example of conductive-layer coating solution CP-C39)

The conductive layer coating fluid L-21 described in Patent Literature 2 was prepared by the following operations and defined as a conductive-layer coating solution CP-C39.

[0254] That is, 44 parts of P-doped tin oxide-coated titanium oxide particles (average primary particle diameter: 40 nm, powder resistivity: 500 $\Omega \cdot \text{cm}$, amount (doping ratio) of phosphorus doped into tin oxide: 8% by mass, coating ratio: 20%), 36.5 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 50 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using glass beads each having a diameter of 0.5 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a disc rotation number of 2,500 rpm and a dispersion treatment time of 3.5 hours.

[0255] 3.9 Parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material and 0.001 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C39.

[0256] (Preparation example of conductive-layer coating solution CP-C40)

The conductive layer coating fluid 1 described in Patent Literature 1 was prepared by the following operations and defined as a conductive-layer coating

solution CP-C40.

[0257] That is, 204 parts of P-doped tin oxide-coated titanium oxide particles (powder resistivity: 40 $\Omega\cdot\text{cm}$, coating ratio: 35% by mass, amount (doping ratio) of phosphorus doped into tin oxide: 3% by mass), 148 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 98 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using 450 parts of glass beads each having a diameter of 0.8 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a number of rotation of 2,000 rpm, a dispersion treatment time of 4 hours, and a setting temperature of cooling water of 18°C.

[0258] The glass beads were removed from the dispersion solution with a mesh. After that, 13.8 parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material, 0.014 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent, 6 parts of methanol, and 6 parts of 1-methoxy-2-propanol were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C40.

[0259] (Preparation example of conductive-layer coating solution CP-C41)

The conductive layer coating fluid 4 described in Patent Literature 1 was prepared by the following operations and defined as a conductive-layer coating solution CP-C41.

[0260] That is, 204 parts of P-doped tin oxide-coated titanium oxide particles (powder resistivity: 500 $\Omega\cdot\text{cm}$, coating

ratio: 35% by mass, amount (doping ratio) of phosphorus (P) doped into tin oxide (SnO_2): 0.05% by mass), 148 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 98 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using 450 parts of glass beads each having a diameter of 0.8 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a number of rotation of 2,000 rpm, a dispersion treatment time of 4 hours, and a setting temperature of cooling water of 18°C.

[0261] The glass beads were removed from the dispersion solution with a mesh. After that, 13.8 parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material, 0.014 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent, 6 parts of methanol, and 6 parts of 1-methoxy-2-propanol were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C41.

[0262] (Preparation example of conductive-layer coating solution CP-C72)

The conductive layer coating fluid L-10 described in Patent Literature 2 was prepared by the following operations and defined as a conductive-layer coating solution CP-C72.

[0263] That is, 53 parts of W-doped tin oxide-coated titanium oxide particles (average primary particle diameter: 220 nm, powder resistivity: 150 $\Omega\cdot\text{cm}$, amount (doping ratio) of tungsten doped into tin oxide: 7% by mass, coating ratio: 15%), 36.5 parts of a phenol resin (trade name:

PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 50 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using glass beads each having a diameter of 0.5 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a disc rotation number of 2,500 rpm and a dispersion treatment time of 3.5 hours.

[0264] The glass beads were removed from the dispersion solution with a mesh. After that, 3.9 parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μ m) as a surface roughness providing material and 0.001 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C72.

[0265] (Preparation example of conductive-layer coating solution CP-C73)
The conductive layer coating fluid L-22 described in Patent Literature 2 was prepared by the following operations and defined as a conductive-layer coating solution CP-C73.

[0266] That is, 46 parts of W-doped tin oxide-coated titanium oxide particles (average primary particle diameter: 40 nm, powder resistivity: 550 Ω ·cm, amount (doping ratio) of tungsten doped into tin oxide: 8% by mass, coating ratio: 20%), 36.5 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 50 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using glass beads each having a diameter of 0.5 mm, and were then subjected to a

dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a disc rotation number of 2,500 rpm and a dispersion treatment time of 3.5 hours.

[0267] 3.9 Parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material and 0.001 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent were added to the dispersion solution, and then the mixture was stirred to prepare the conductive layer coating fluid L-22 described in Patent Literature 2. The coating solution was defined as the conductive-layer coating solution CP-C73.

[0268] (Preparation example of conductive-layer coating solution CP-C74)

The conductive layer coating fluid 10 described in Patent Literature 1 was prepared by the following operations and defined as a conductive-layer coating solution CP-C74.

[0269] That is, 204 parts of W-doped tin oxide-coated titanium oxide particles (powder resistivity: 25 $\Omega\cdot\text{cm}$, coating ratio: 33% by mass, amount (doping ratio) of tungsten doped into tin oxide: 3% by mass), 148 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 98 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using 450 parts of glass beads each having a diameter of 0.8 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a number of rotation of 2,000 rpm, a dispersion treatment time of 4 hours, and a setting temperature of cooling water of 18°C.

[0270] The glass beads were removed from the dispersion solution with a mesh. After that, 13.8 parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material, 0.014 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent, 6 parts of methanol, and 6 parts of 1-methoxy-2-propanol were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C74.

[0271] (Preparation example of conductive-layer coating solution CP-C75)

The conductive layer coating fluid 13 described in Patent Literature 1 was prepared by the following operations and defined as a conductive-layer coating solution CP-C75.

[0272] That is, 204 parts of W-doped tin oxide-coated titanium oxide particles (powder resistivity: 69 $\Omega\cdot\text{cm}$, coating ratio: 33% by mass, amount (doping ratio) of tungsten doped into tin oxide: 0.1% by mass), 148 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 98 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using 450 parts of glass beads each having a diameter of 0.8 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a number of rotation of 2,000 rpm, a dispersion treatment time of 4 hours, and a setting temperature of cooling water of 18°C.

[0273] The glass beads were removed from the dispersion solution with a mesh. After that, 13.8 parts of silicone resin particles (trade name: TOSPEARL 120,

manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material, 0.014 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray Silicone Co., Ltd.) as a leveling agent, 6 parts of methanol, and 6 parts of 1-methoxy-2-propanol were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C75.

[0274] (Preparation example of conductive-layer coating solution CP-C106)

The conductive layer coating fluid L-30 described in Patent Literature 2 was prepared by the following operations and defined as a conductive-layer coating solution CP-C106.

[0275] That is, 60 parts of F-doped tin oxide-coated titanium oxide particles (average primary particle diameter: 75 nm, powder resistivity: 300 $\Omega\cdot\text{cm}$, amount (doping ratio) of fluorine doped into tin oxide: 7% by mass, coating ratio: 15%), 36.5 parts of a phenol resin (trade name: PLYOPHEN J-325, manufactured by DIC Corporation, resin solid content: 60% by mass) as a binding material, and 50 parts of 1-methoxy-2-propanol as a solvent were loaded into a sand mill using glass beads each having a diameter of 0.5 mm, and were then subjected to a dispersion treatment under the following dispersion treatment conditions to provide a dispersion solution: a disc rotation number of 2,500 rpm and a dispersion treatment time of 3.5 hours.

[0276] The glass beads were removed from the dispersion solution with a mesh. After that, 3.9 parts of silicone resin particles (trade name: TOSPEARL 120, manufactured by Momentive Performance Materials Inc., average particle diameter: 2 μm) as a surface roughness providing material and 0.001 part of a silicone oil (trade name: SH28PA, manufactured by Dow Corning Toray

Silicone Co., Ltd.) as a leveling agent were added to the dispersion solution, and then the mixture was stirred to prepare a conductive-layer coating solution CP-C106.

[0277] [Table 1]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Amount [part (s)]
CP-1		45	4.50	5.1	112.00		3.60	6.8	3.00	1.3	1.3	5.00		
CP-2		45	4.50	5.1	112.00		4.05	6.7	2.95	1.3	1.3	5.00		
CP-3		45	4.50	5.1	112.00		4.50	6.7	2.95	1.3	1.3	5.00		
CP-4		45	4.50	5.1	112.00		4.95	6.7	2.95	1.3	1.3	5.00		
CP-5		45	4.50	5.1	112.00		5.40	6.7	2.95	1.3	1.3	5.00		
CP-6		45	4.50	5.1	108.50		4.50	6.7	7.15	1.3	1.3	5.00		
CP-7		45	4.50	5.1	99.80		3.60	6.8	17.30	1.3	1.3	5.00		
CP-8		45	4.50	5.1	99.90		4.05	6.7	17.06	1.3	1.3	5.00		
CP-9		45	4.50	5.1	99.90		4.50	6.7	17.06	1.3	1.3	5.00		
CP-10	P-doped tin	45	4.50	5.1	99.90		4.95	6.7	17.06	1.3	1.3	5.00		
CP-11	oxide-	45	4.50	5.1	99.90		5.40	6.7	17.06	1.3	1.3	5.00		
CP-12	coated	45	4.50	5.1	93.50	P-doped tin oxide	4.50	6.7	24.60	1.3	1.3	5.00		
CP-13	titanium	45	4.50	5.1	89.30	particles	3.60	6.8	29.80	1.3	1.3	5.00		
CP-14	oxide	45	4.50	5.1	89.40	(average particle	4.05	6.7	29.40	1.3	1.3	5.00		None
CP-15	particles	45	4.50	5.1	89.40	diameter: 20 nm)	4.50	6.7	29.40	1.3	1.3	5.00		
CP-16	(average particle	45	4.50	5.1	89.40		4.95	6.7	29.40	1.3	1.3	5.00		
CP-17	diameter: 230 nm)	45	4.50	5.1	89.40		5.40	6.7	29.40	1.3	1.3	5.00		
CP-18		45	4.50	5.1	135.50		4.50	6.7	3.60	1.3	1.3	5.00		
CP-19		45	4.50	5.1	131.00		3.60	6.8	8.75	1.3	1.3	5.00		
CP-20		45	4.50	5.1	131.10		4.05	6.7	8.65	1.3	1.3	5.00		
CP-21		45	4.50	5.1	131.10		4.50	6.7	8.65	1.3	1.3	5.00		
CP-22		45	4.50	5.1	131.10		4.95	6.7	8.65	1.3	1.3	5.00		
CP-23		45	4.50	5.1	131.10		5.40	6.7	8.65	1.3	1.3	5.00		
CP-24		45	4.50	5.1	120.50		3.60	6.8	20.90	1.3	1.3	5.00		
CP-25		45	4.50	5.1	120.60		4.05	6.7	20.60	1.3	1.3	5.00		
CP-26		45	4.50	5.1	120.60		4.50	6.7	20.60	1.3	1.3	5.00		

CP-27	45	4.50	5.1	120.60	4.95	6.7	20.60	1.3	223.00	1.3	5.00
CP-28	45	4.50	5.1	120.60	5.40	6.7	20.60	1.3	223.00	1.3	5.00
CP-29	45	4.50	5.1	112.50	3.60	6.8	30.00	1.3	220.83	1.3	5.00
CP-30	45	4.50	5.1	112.60	4.05	6.7	29.60	1.3	221.33	1.3	5.00
CP-31	45	4.50	5.1	112.60	4.50	6.7	29.60	1.3	221.33	1.3	5.00
CP-32	45	4.50	5.1	112.60	4.95	6.7	29.60	1.3	221.33	1.3	5.00
CP-33	45	4.50	5.1	112.60	5.40	6.7	29.60	1.3	221.33	1.3	5.00
CP-34	45	4.50	5.1	107.60	4.50	6.7	35.35	1.3	220.08	1.3	5.00
CP-35	45	4.50	5.1	171.50	3.60	6.8	4.60	1.3	164.83	1.3	5.00
CP-36	45	4.50	5.1	171.50	4.05	6.7	4.50	1.3	165.00	1.3	5.00
CP-37	45	4.50	5.1	171.50	4.50	6.7	4.50	1.3	165.00	1.3	5.00
CP-38	45	4.50	5.1	171.50	4.95	6.7	4.50	1.3	165.00	1.3	5.00
CP-39	45	4.50	5.1	171.50	5.40	6.7	4.50	1.3	165.00	1.3	5.00
CP-40	45	4.50	5.1	165.60	3.60	6.8	11.05	1.3	163.92	1.3	5.00

[0278] [Table 2]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Density (resin solid content thereof is 60% by mass of the following)	Density [part (s)]	Amount [part (s)]	Kind	Amount [part (s)]
CP-41	P-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	165.70	P-doped tin oxide particles (average particle diameter: 20 nm)	4.05	6.7	10.90	1.3	1.3	5.00	None	
CP-42		45	4.50	5.1	165.70		4.50	6.7	10.90	1.3	1.3	5.00		
CP-43		45	4.50	5.1	165.70		4.95	6.7	10.90	1.3	1.3	5.00		
CP-44		45	4.50	5.1	165.70		5.40	6.7	10.90	1.3	1.3	5.00		
CP-45		45	4.50	5.1	151.80		3.60	6.8	26.35	1.3	1.3	5.00		
CP-46		45	4.50	5.1	151.95		4.05	6.7	25.95	1.3	1.3	5.00		
CP-47		45	4.50	5.1	151.95		4.50	6.7	25.95	1.3	1.3	5.00		
CP-48		45	4.50	5.1	151.95		4.95	6.7	25.95	1.3	1.3	5.00		
CP-49		45	4.50	5.1	151.95		5.40	6.7	25.95	1.3	1.3	5.00		
CP-50		45	4.50	5.1	141.40		3.60	6.8	37.70	1.3	1.3	5.00		
CP-51		45	4.50	5.1	141.70		4.05	6.7	37.25	1.3	1.3	5.00		
CP-52		45	4.50	5.1	141.70		4.50	6.7	37.25	1.3	1.3	5.00		
CP-53		45	4.50	5.1	141.70		4.95	6.7	37.25	1.3	1.3	5.00		
CP-54		45	4.50	5.1	141.70		5.40	6.7	37.25	1.3	1.3	5.00		
CP-55		45	4.50	5.1	134.80		3.60	6.8	45.00	1.3	1.3	5.00		
CP-56		45	4.50	5.1	135.15		4.05	6.7	44.40	1.3	1.3	5.00		
CP-57		45	4.50	5.1	135.15		4.50	6.7	44.40	1.3	1.3	5.00		
CP-58		45	4.50	5.1	135.15		4.95	6.7	44.40	1.3	1.3	5.00		
CP-59		45	4.50	5.1	135.15		5.40	6.7	44.40	1.3	1.3	5.00		
CP-60		45	4.50	5.1	197.70		4.50	6.7	5.20	1.3	1.3	5.00		
CP-61		45	4.50	5.1	190.70		3.60	6.8	12.75	1.3	1.3	5.00		
CP-62		45	4.50	5.1	190.85		4.05	6.7	12.55	1.3	1.3	5.00		
CP-63		45	4.50	5.1	190.85		4.50	6.7	12.55	1.3	1.3	5.00		
CP-64		45	4.50	5.1	190.85		4.95	6.7	12.55	1.3	1.3	5.00		
CP-65		45	4.50	5.1	190.85		5.40	6.7	12.55	1.3	1.3	5.00		
CP-66		45	4.50	5.1	174.40		3.60	6.8	30.30	1.3	1.3	5.00		

CP-67	45	4.50	5.1	174.70	4.05	6.7	29.90	1.3	117.33	1.3	5.00
CP-68	45	4.50	5.1	174.70	4.50	6.7	29.90	1.3	117.33	1.3	5.00
CP-69	45	4.50	5.1	174.70	4.95	6.7	29.90	1.3	117.33	1.3	5.00
CP-70	45	4.50	5.1	174.70	5.40	6.7	29.90	1.3	117.33	1.3	5.00
CP-71	45	4.50	5.1	162.30	3.60	6.8	43.30	1.3	115.67	1.3	5.00
CP-72	45	4.50	5.1	162.70	4.05	6.7	42.75	1.3	115.92	1.3	5.00
CP-73	45	4.50	5.1	162.70	4.50	6.7	42.75	1.3	115.92	1.3	5.00
CP-74	45	4.50	5.1	162.70	4.95	6.7	42.75	1.3	115.92	1.3	5.00
CP-75	45	4.50	5.1	162.70	5.40	6.7	42.75	1.3	115.92	1.3	5.00
CP-76	45	4.50	5.1	155.05	4.50	6.7	50.95	1.3	115.00	1.3	5.00
CP-77	45	4.50	5.1	208.30	3.60	6.8	5.60	1.3	101.83	1.3	5.00
CP-78	45	4.50	5.1	208.25	4.05	6.7	5.56	1.3	101.98	1.3	5.00
CP-79	45	4.50	5.1	208.25	4.50	6.7	5.56	1.3	101.98	1.3	5.00
CP-80	45	4.50	5.1	208.25	4.95	6.7	5.56	1.3	101.98	1.3	5.00

[0279] [Table 3]

	(1) A first metal oxide particle					(2) A second metal oxide particle					(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)				
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [resin solid content thereof is 60% by mass of the following]	Density	Amount [part(s)]	Kind	Density	Amount [part (s)]			
Conductive -layer coating solution	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	CP-81	45	4.50	5.1	208.25	P-doped tin oxide particles (average particle diameter: 20 nm)	5.40	6.7	5.56	1.3	101.98	1.3	5.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00		
		CP-82	45	4.50	5.1	201.10		4.50	6.7	13.20	1.3	101.17	1.3	5.00				4.2	30.00
		CP-83	45	4.50	5.1	183.55		3.60	6.8	31.90	1.3	99.25	1.3	5.00				4.2	30.00
		CP-84	45	4.50	5.1	183.90		4.05	6.7	31.40	1.3	99.50	1.3	5.00				4.2	30.00
		CP-85	45	4.50	5.1	183.90		4.50	6.7	31.40	1.3	99.50	1.3	5.00				4.2	30.00
		CP-86	45	4.50	5.1	183.90		4.95	6.7	31.40	1.3	99.50	1.3	5.00				4.2	30.00
		CP-87	45	4.50	5.1	183.90		5.40	6.7	31.40	1.3	99.50	1.3	5.00				4.2	30.00
		CP-88	45	4.50	5.1	171.10		4.50	6.7	45.00	1.3	98.17	1.3	5.00				4.2	30.00
		CP-89	45	4.50	5.1	162.50		3.60	6.8	54.20	1.3	97.17	1.3	5.00				4.2	30.00
		CP-90	45	4.50	5.1	163.00		4.05	6.7	53.55	1.3	97.42	1.3	5.00				4.2	30.00
		CP-91	45	4.50	5.1	163.00		4.50	6.7	53.55	1.3	97.42	1.3	5.00				4.2	30.00
		CP-92	45	4.50	5.1	163.00		4.95	6.7	53.55	1.3	97.42	1.3	5.00				4.2	30.00
		CP-93	45	4.50	5.1	163.00		5.40	6.7	53.55	1.3	97.42	1.3	5.00				4.2	30.00
		CP-94	45	4.50	5.1	135.40		3.60	6.8	9.05	1.3	159.25	1.3	40.00				4.2	30.00
		CP-95	45	4.50	5.1	135.40		4.05	6.7	8.90	1.3	159.50	1.3	40.00				4.2	30.00
		CP-96	45	4.50	5.1	135.40		4.50	6.7	8.90	1.3	159.50	1.3	40.00				4.2	30.00
CP-97	45	4.50	5.1	135.40	4.95	6.7	8.90	1.3	159.50	1.3	40.00	4.2	30.00						
CP-98	45	4.50	5.1	135.40	5.40	6.7	8.90	1.3	159.50	1.3	40.00	4.2	30.00						
CP-99	45	4.50	5.1	124.50	3.60	6.8	21.60	1.3	156.50	1.3	40.00	4.2	30.00						
CP-100	45	4.50	5.1	124.50	4.05	6.7	21.30	1.3	157.00	1.3	40.00	4.2	30.00						
CP-101	45	4.50	5.1	124.50	4.50	6.7	21.30	1.3	157.00	1.3	40.00	4.2	30.00						
CP-102	45	4.50	5.1	124.50	4.95	6.7	21.30	1.3	157.00	1.3	40.00	4.2	30.00						
CP-103	45	4.50	5.1	124.50	5.40	6.7	21.30	1.3	157.00	1.3	40.00	4.2	30.00						
CP-104	45	4.50	5.1	116.20	3.60	6.8	31.00	1.3	154.67	1.3	40.00	4.2	30.00						

CP-105	45	4.50	5.1	116.40	4.05	6.7	30.60	1.3	155.00	1.3	40.00	4.2	30.00
CP-106	45	4.50	5.1	116.40	4.50	6.7	30.60	1.3	155.00	1.3	40.00	4.2	30.00
CP-107	45	4.50	5.1	116.40	4.95	6.7	30.60	1.3	155.00	1.3	40.00	4.2	30.00
CP-108	45	4.50	5.1	116.40	5.40	6.7	30.60	1.3	155.00	1.3	40.00	4.2	30.00
CP-109	45	4.50	5.1	171.10	3.60	6.8	11.40	1.3	95.83	1.3	40.00	4.2	30.00
CP-110	45	4.50	5.1	171.20	4.05	6.7	11.25	1.3	95.92	1.3	40.00	4.2	30.00
CP-111	45	4.50	5.1	171.20	4.50	6.7	11.25	1.3	95.92	1.3	40.00	4.2	30.00
CP-112	45	4.50	5.1	171.20	4.95	6.7	11.25	1.3	95.92	1.3	40.00	4.2	30.00
CP-113	45	4.50	5.1	171.20	5.40	6.7	11.25	1.3	95.92	1.3	40.00	4.2	30.00
CP-114	45	4.50	5.1	156.80	3.60	6.8	27.20	1.3	93.33	1.3	40.00	4.2	30.00
CP-115	45	4.50	5.1	157.00	4.05	6.7	26.85	1.3	93.58	1.3	40.00	4.2	30.00
CP-116	45	4.50	5.1	157.00	4.50	6.7	26.85	1.3	93.58	1.3	40.00	4.2	30.00
CP-117	45	4.50	5.1	157.00	4.95	6.7	26.85	1.3	93.58	1.3	40.00	4.2	30.00
CP-118	45	4.50	5.1	157.00	5.40	6.7	26.85	1.3	93.58	1.3	40.00	4.2	30.00
CP-119	45	4.50	5.1	146.10	3.60	6.8	39.00	1.3	91.50	1.3	40.00	4.2	30.00
CP-120	45	4.50	5.1	146.40	4.05	6.7	38.50	1.3	91.83	1.3	40.00	4.2	30.00

[0280] [Table 4]

	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles	(5) Particles except (1) to (4)			
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]	
Conductive -layer coating solution	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	146.40	p-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.7	38.50	1.3	91.83	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00	
		45	4.50	5.1	146.40		4.95	6.7	38.50	1.3	91.83		4.2	30.00	
		45	4.50	5.1	146.40		5.40	6.7	38.50	1.3	91.83		4.2	30.00	
		45	4.50	5.1	197.05		3.60	6.8	13.15	1.3	49.67		4.2	30.00	
		45	4.50	5.1	197.20		4.05	6.7	13.00	1.3	49.67		4.2	30.00	
		45	4.50	5.1	197.20		4.50	6.7	13.00	1.3	49.67		4.2	30.00	
		45	4.50	5.1	197.20		4.95	6.7	13.00	1.3	49.67		4.2	30.00	
		45	4.50	5.1	197.20		5.40	6.7	13.00	1.3	49.67		4.2	30.00	
		45	4.50	5.1	180.20		3.60	6.8	31.30	1.3	47.50		4.2	30.00	
		45	4.50	5.1	180.50		4.05	6.7	30.85	1.3	47.75		4.2	30.00	
	CP-131	45	4.50	5.1	180.50	4.50	6.7	30.85	1.3	47.75	1.3	40.00		4.2	30.00
		45	4.50	5.1	180.50	4.95	6.7	30.85	1.3	47.75	1.3	40.00		4.2	30.00
		45	4.50	5.1	180.50	5.40	6.7	30.85	1.3	47.75	1.3	40.00		4.2	30.00
		45	4.50	5.1	167.65	3.60	6.8	44.75	1.3	46.00	1.3	40.00		4.2	30.00
		45	4.50	5.1	168.05	4.05	6.7	44.16	1.3	46.32	1.3	40.00		4.2	30.00
		45	4.50	5.1	168.05	4.50	6.7	44.16	1.3	46.32	1.3	40.00		4.2	30.00
		45	4.50	5.1	168.05	4.95	6.7	44.16	1.3	46.32	1.3	40.00		4.2	30.00
		45	4.50	5.1	168.05	5.40	6.7	44.16	1.3	46.32	1.3	40.00		4.2	30.00
		45	4.50	5.1	157.00	4.50	6.7	26.85	1.3	93.58	1.3	40.00		4.2	30.00
		45	4.50	5.1	161.00	4.50	6.7	22.85	1.3	93.58	1.3	40.00		4.2	30.00

[0281] [Table 5]

	(1) A first metal oxide particle					(2) A second metal oxide particle					(3) Binding material (phenol resin)	(4) Silicone resin particles			(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density thereof is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]		
Conductive -layer coating solution	CP-C1	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	114.60	None	None	1.3	267.33	1.3	5.00	None				
	CP-C2		45	4.50	5.1	175.60			1.3	165.67	1.3	5.00					
	CP-C3		45	4.50	5.1	213.50			1.3	102.50	1.3	5.00					
	CP-C4		45	4.50	5.1	113.25			1.3	267.10	1.3	5.00					
	CP-C5		45	4.50	5.1	173.50			1.3	165.38	1.3	5.00					
	CP-C6		45	4.50	5.1	210.90			1.3	102.17	1.3	5.00					
	CP-C7		45	4.50	5.1	85.60			1.3	259.42	1.3	5.00					
	CP-C8		45	4.50	5.1	129.20			1.3	158.08	1.3	5.00					
	CP-C9		45	4.50	5.1	155.65			1.3	96.67	1.3	5.00					
	CP-C10	P-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.7	61.35	1.3		236.00	1.3	5.00							
	CP-C11		4.50	6.7	133.40	1.3		137.00	1.3	5.00							
	CP-C12		4.50	6.7	192.80	1.3		81.00	1.3	5.00							
	CP-C13		4.50	6.7	226.40	1.3		316.00	1.3	5.00							
	CP-C14		4.50	6.7	2.20	1.3		315.17	1.3	5.00							
CP-C15	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	4.50	6.7	5.30	1.3	312.92	1.3	5.00									
CP-C16		4.50	6.7	12.75	1.3	311.50	1.3	5.00									
CP-C17		4.50	6.7	18.35	1.3	310.63	1.3	5.00									
CP-C18		4.50	6.7	21.92	1.3	85.92	1.3	5.00									
CP-C19		4.50	6.7	5.75	1.3	85.25	1.3	5.00									
CP-C20		4.50	6.7	13.80	1.3	83.75	1.3	5.00									
CP-C21		4.50	6.7	32.80	1.3	82.58	1.3	5.00									
CP-C22		4.50	6.7	46.95	1.3	81.95	1.3	5.00									

[0282] [Table 6]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density [part(s)]	Amount [part(s)]	Density [part(s)]	Kind Density	Amount [part(s)]
CP-C23	Oxygen- deficient tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	-	5.1	152.00			4.50	6.7	26.00	1.3	161.67	1.3	5.00
CP-C24	Oxygen- deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	152.00	P-doped tin oxide particles (average particle diameter: 20 nm)		4.50	6.7	26.00	1.3	161.67	1.3	5.00
CP-C25	Sb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.00			4.50	6.7	26.00	1.3	161.67	1.3	5.00

None

CP-C26	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.20	Oxygen- deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.60	1.3	162.00	1.3	5.00
CP-C27	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	151.10	Indium tin oxide particles (average particle diameter: 20 nm)	4.50	7.1	27.35	1.3	160.92	1.3	5.00
CP-C28	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.20	Sb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	162.00	1.3	5.00
CP-C29	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.30	P-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.7	25.70	1.3	160.00	1.3	5.00

[0283] [Table 7]

	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Amount [part(s)]
Conductive -layer coating solution														
CP-C30	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	150.60	P-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.7	26.25	1.3	163.58	1.3	5.00	
CP-C31	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	150.20	W-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.5	28.80	1.3	160.00	1.3	5.00	
CP-C32		45	4.50	5.1	152.20	F-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	162.00	1.3	5.00	None
CP-C33	Oxygen-deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	152.20	Oxygen-deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.60	1.3	162.00	1.3	5.00	

CP-C34	Sb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.20	Sb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	162.00	1.3	5.00
CP-C35	P-doped tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	4.50	5.1	151.90	P-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.7	26.00	1.3	161.83	1.3	5.00

[0284] [Table 8]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part(s)]	Amount [part(s)]	Kind	Doping ratio [%]	Density [part(s)]	Amount [part(s)]	Density [part(s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density [part(s)]	Amount [part(s)]	Kind Density [part(s)]
CP-141	W-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	113.20	W-doped tin oxide particles (average particle diameter: 20 nm)	3.60	7.4	3.22	1.3	264.30	1.3	5.00	None
CP-142		45	4.50	5.2	113.20		4.05	7.5	3.26	1.3	264.23	1.3	5.00	
CP-143		45	4.50	5.2	113.20		4.50	7.5	3.26	1.3	264.23	1.3	5.00	
CP-144		45	4.50	5.2	113.20		4.95	7.6	3.31	1.3	264.15	1.3	5.00	
CP-145		45	4.50	5.2	113.20		5.40	7.6	3.31	1.3	264.15	1.3	5.00	
CP-146		45	4.50	5.2	109.40		4.50	7.5	7.90	1.3	262.83	1.3	5.00	
CP-147		45	4.50	5.2	100.50		3.60	7.4	18.60	1.3	259.83	1.3	5.00	
CP-148		45	4.50	5.2	100.50		4.05	7.5	18.85	1.3	259.42	1.3	5.00	
CP-149		45	4.50	5.2	100.50		4.50	7.5	18.85	1.3	259.42	1.3	5.00	
CP-150		45	4.50	5.2	100.40		4.95	7.6	19.10	1.3	259.17	1.3	5.00	
CP-151		45	4.50	5.2	100.40		5.40	7.6	19.10	1.3	259.17	1.3	5.00	
CP-152		45	4.50	5.2	93.70		4.50	7.5	27.05	1.3	257.08	1.3	5.00	
CP-153		45	4.50	5.2	89.55		3.60	7.4	31.86	1.3	255.98	1.3	5.00	
CP-154		45	4.50	5.2	89.48		4.05	7.5	32.26	1.3	255.43	1.3	5.00	
CP-155		45	4.50	5.2	89.48		4.50	7.5	32.26	1.3	255.43	1.3	5.00	
CP-156		45	4.50	5.2	89.30		4.95	7.6	32.65	1.3	255.08	1.3	5.00	
CP-157		45	4.50	5.2	89.30		5.40	7.6	32.65	1.3	255.08	1.3	5.00	
CP-158		45	4.50	5.2	136.65		4.50	7.5	3.97	1.3	223.97	1.3	5.00	
CP-159		45	4.50	5.2	132.00		3.60	7.4	9.40	1.3	222.67	1.3	5.00	
CP-160		45	4.50	5.2	132.00		4.05	7.5	9.55	1.3	222.42	1.3	5.00	
CP-161		45	4.50	5.2	132.00		4.50	7.5	9.55	1.3	222.42	1.3	5.00	
CP-162		45	4.50	5.2	131.90		4.95	7.6	9.65	1.3	222.42	1.3	5.00	
CP-163		45	4.50	5.2	131.90		5.40	7.6	9.65	1.3	222.42	1.3	5.00	
CP-164		45	4.50	5.2	121.00		3.60	7.4	22.40	1.3	219.33	1.3	5.00	

CP-165	45	4.50	5.2	120.85	4.05	7.5	22.67	1.3	219.13	1.3	5.00
CP-166	45	4.50	5.2	120.85	4.50	7.5	22.67	1.3	219.13	1.3	5.00
CP-167	45	4.50	5.2	120.70	4.95	7.6	22.95	1.3	218.92	1.3	5.00
CP-168	45	4.50	5.2	120.70	5.40	7.6	22.95	1.3	218.92	1.3	5.00
CP-169	45	4.50	5.2	112.75	3.60	7.4	32.10	1.3	216.92	1.3	5.00
CP-170	45	4.50	5.2	112.55	4.05	7.5	32.50	1.3	216.58	1.3	5.00
CP-171	45	4.50	5.2	112.55	4.50	7.5	32.50	1.3	216.58	1.3	5.00
CP-172	45	4.50	5.2	112.40	4.95	7.6	32.85	1.3	216.25	1.3	5.00
CP-173	45	4.50	5.2	112.40	5.40	7.6	32.85	1.3	216.25	1.3	5.00
CP-174	45	4.50	5.2	107.30	4.50	7.5	38.70	1.3	215.00	1.3	5.00
CP-175	45	4.50	5.2	172.50	3.60	7.4	4.90	1.3	162.67	1.3	5.00
CP-176	45	4.50	5.2	172.40	4.05	7.5	5.00	1.3	162.67	1.3	5.00
CP-177	45	4.50	5.2	172.40	4.50	7.5	5.00	1.3	162.67	1.3	5.00
CP-178	45	4.50	5.2	172.40	4.95	7.6	5.05	1.3	162.58	1.3	5.00
CP-179	45	4.50	5.2	172.40	5.40	7.6	5.05	1.3	162.58	1.3	5.00
CP-180	45	4.50	5.2	166.30	3.60	7.4	11.85	1.3	161.42	1.3	5.00

[0285] [Table 9]

	(1) A first metal oxide particle					(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]	
Conductive -layer coating solution	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	166.20	W-doped tin oxide particles (average particle diameter: 20 nm)	4.05	7.5	12.00	1.3	161.33	1.3	5.00	None		
		45	4.50	5.2	166.20		4.50	7.5	12.00	1.3	161.33	1.3	5.00			
		45	4.50	5.2	166.10		4.95	7.6	12.15	1.3	161.25	1.3	5.00			
		45	4.50	5.2	166.10		5.40	7.6	12.15	1.3	161.25	1.3	5.00			
		45	4.50	5.2	151.80		3.60	7.4	28.15	1.3	158.42	1.3	5.00			
		45	4.50	5.2	151.60		4.05	7.5	28.45	1.3	158.25	1.3	5.00			
		45	4.50	5.2	151.60		4.50	7.5	28.45	1.3	158.25	1.3	5.00			
		45	4.50	5.2	151.45		4.95	7.6	28.80	1.3	157.92	1.3	5.00			
		45	4.50	5.2	151.45		5.40	7.6	28.80	1.3	157.92	1.3	5.00			
		45	4.50	5.2	141.10		3.60	7.4	40.20	1.3	156.17	1.3	5.00			
		45	4.50	5.2	140.85		4.05	7.5	40.65	1.3	155.83	1.3	5.00			
		45	4.50	5.2	140.85		4.50	7.5	40.65	1.3	155.83	1.3	5.00			
	45	4.50	5.2	140.55	4.95	7.6	41.10	1.3	155.58	1.3	5.00					
	45	4.50	5.2	140.55	5.40	7.6	41.10	1.3	155.58	1.3	5.00					
	45	4.50	5.2	134.30	3.60	7.4	47.80	1.3	154.83	1.3	5.00					
	45	4.50	5.2	134.05	4.05	7.5	48.35	1.3	154.33	1.3	5.00					
	45	4.50	5.2	134.05	4.50	7.5	48.35	1.3	154.33	1.3	5.00					
	45	4.50	5.2	133.70	4.95	7.6	48.90	1.3	154.00	1.3	5.00					
	45	4.50	5.2	133.70	5.40	7.6	48.90	1.3	154.00	1.3	5.00					
	45	4.50	5.2	198.40	4.50	7.5	5.75	1.3	118.08	1.3	5.00					
	45	4.50	5.2	191.15	3.60	7.4	13.60	1.3	117.08	1.3	5.00					
	45	4.50	5.2	191.00	4.05	7.5	13.80	1.3	117.00	1.3	5.00					
	45	4.50	5.2	191.00	4.50	7.5	13.80	1.3	117.00	1.3	5.00					
	45	4.50	5.2	190.90	4.95	7.6	13.95	1.3	116.92	1.3	5.00					

CP-205	45	4.50	5.2	190.90	5.40	7.6	13.95	1.3	116.92	1.3	5.00
CP-206	45	4.50	5.2	174.10	3.60	7.4	32.20	1.3	114.50	1.3	5.00
CP-207	45	4.50	5.2	173.76	4.05	7.5	32.60	1.3	114.40	1.3	5.00
CP-208	45	4.50	5.2	173.76	4.50	7.5	32.60	1.3	114.40	1.3	5.00
CP-209	45	4.50	5.2	173.50	4.95	7.6	33.00	1.3	114.17	1.3	5.00
CP-210	45	4.50	5.2	173.50	5.40	7.6	33.00	1.3	114.17	1.3	5.00
CP-211	45	4.50	5.2	161.45	3.60	7.4	45.95	1.3	112.67	1.3	5.00
CP-212	45	4.50	5.2	161.05	4.05	7.5	46.50	1.3	112.42	1.3	5.00
CP-213	45	4.50	5.2	161.05	4.50	7.5	46.50	1.3	112.42	1.3	5.00
CP-214	45	4.50	5.2	160.70	4.95	7.6	47.00	1.3	112.17	1.3	5.00
CP-215	45	4.50	5.2	160.70	5.40	7.6	47.00	1.3	112.17	1.3	5.00
CP-216	45	4.50	5.2	153.10	4.50	7.5	55.20	1.3	111.17	1.3	5.00
CP-217	45	4.50	5.2	208.90	3.60	7.4	6.00	1.3	100.17	1.3	5.00
CP-218	45	4.50	5.2	208.85	4.05	7.5	6.07	1.3	100.13	1.3	5.00
CP-219	45	4.50	5.2	208.85	4.50	7.5	6.07	1.3	100.13	1.3	5.00
CP-220	45	4.50	5.2	208.85	4.95	7.6	6.10	1.3	100.08	1.3	5.00

[0286] [Table 10]

Conductive -layer coating solution	(1) A first metal oxide particle					(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density content thereof is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]	
CP-221	W-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	208.85	W-doped tin oxide particles (average particle diameter: 20 nm)	5.40	7.6	6.10	1.3	100.08	1.3	5.00	None		
CP-222		45	4.50	5.2	201.00		4.50	7.5	14.50	1.3	99.17	1.3	5.00			
CP-223		45	4.50	5.2	183.00		3.60	7.4	33.85	1.3	96.92	1.3	5.00			
CP-224		45	4.50	5.2	182.65		4.05	7.5	34.30	1.3	96.75	1.3	5.00			
CP-225		45	4.50	5.2	182.65		4.50	7.5	34.30	1.3	96.75	1.3	5.00			
CP-226		45	4.50	5.2	182.35		4.95	7.6	34.70	1.3	96.58	1.3	5.00			
CP-227		45	4.50	5.2	182.35		5.40	7.6	34.70	1.3	96.58	1.3	5.00			
CP-228		45	4.50	5.2	169.20		4.50	7.5	48.80	1.3	95.00	1.3	5.00			
CP-229		45	4.50	5.2	161.10		3.60	7.4	57.35	1.3	94.25	1.3	5.00			
CP-230		45	4.50	5.2	160.67		4.05	7.5	57.95	1.3	93.97	1.3	5.00			
CP-231		45	4.50	5.2	160.67		4.50	7.5	57.95	1.3	93.97	1.3	5.00			
CP-232		45	4.50	5.2	160.25		4.95	7.6	58.55	1.3	93.67	1.3	5.00			
CP-233		45	4.50	5.2	160.25		5.40	7.6	58.55	1.3	93.67	1.3	5.00			

[0287] [Table 11]

	(1) A first metal oxide particle					(2) A second metal oxide particle			(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]	
Conductive -layer coating solution	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	136.40	W-doped tin oxide particles (average particle diameter: 20 nm)	3.60	7.4	9.72	1.3	156.47	1.3	40.00	4.2	30.00
		45	4.50	5.2	136.40		4.05	7.5	9.85	1.3	156.25	1.3	40.00	4.2	30.00
		45	4.50	5.2	136.40		4.50	7.5	9.85	1.3	156.25	1.3	40.00	4.2	30.00
		45	4.50	5.2	136.30		4.95	7.6	9.98	1.3	156.20	1.3	40.00	4.2	30.00
		45	4.50	5.2	136.30		5.40	7.6	9.98	1.3	156.20	1.3	40.00	4.2	30.00
		45	4.50	5.2	125.00		3.60	7.4	23.15	1.3	153.08	1.3	40.00	4.2	30.00
		45	4.50	5.2	124.90		4.05	7.5	23.44	1.3	152.77	1.3	40.00	4.2	30.00
		45	4.50	5.2	124.90		4.50	7.5	23.44	1.3	152.77	1.3	40.00	4.2	30.00
		45	4.50	5.2	124.70		4.95	7.6	23.70	1.3	152.67	1.3	40.00	4.2	30.00
		45	4.50	5.2	124.70		5.40	7.6	23.70	1.3	152.67	1.3	40.00	4.2	30.00
		45	4.50	5.2	116.50		3.60	7.4	33.15	1.3	150.58	1.3	40.00	4.2	30.00
		45	4.50	5.2	116.30		4.05	7.5	33.55	1.3	150.25	1.3	40.00	4.2	30.00
		45	4.50	5.2	116.30		4.50	7.5	33.55	1.3	150.25	1.3	40.00	4.2	30.00
		45	4.50	5.2	116.10		4.95	7.6	33.95	1.3	149.92	1.3	40.00	4.2	30.00
		45	4.50	5.2	116.10		5.40	7.6	33.95	1.3	149.92	1.3	40.00	4.2	30.00
		45	4.50	5.2	171.80		3.60	7.4	12.25	1.3	93.25	1.3	40.00	4.2	30.00
		45	4.50	5.2	171.70		4.05	7.5	12.40	1.3	93.17	1.3	40.00	4.2	30.00
		45	4.50	5.2	171.70		4.50	7.5	12.40	1.3	93.17	1.3	40.00	4.2	30.00
		45	4.50	5.2	171.65		4.95	7.6	12.55	1.3	93.00	1.3	40.00	4.2	30.00
		45	4.50	5.2	171.65		5.40	7.6	12.55	1.3	93.00	1.3	40.00	4.2	30.00
		45	4.50	5.2	156.85		3.60	7.4	29.05	1.3	90.17	1.3	40.00	4.2	30.00
		45	4.50	5.2	156.65		4.05	7.5	29.40	1.3	89.92	1.3	40.00	4.2	30.00
		45	4.50	5.2	156.65		4.50	7.5	29.40	1.3	89.92	1.3	40.00	4.2	30.00
		45	4.50	5.2	156.45		4.95	7.6	29.75	1.3	89.67	1.3	40.00	4.2	30.00

CP-258	45	4.50	5.2	156.45	5.40	7.6	29.75	1.3	89.67	1.3	40.00	4.2	30.00
CP-259	45	4.50	5.2	145.80	3.60	7.4	41.50	1.3	87.83	1.3	40.00	4.2	30.00
CP-260	45	4.50	5.2	145.50	4.05	7.5	42.00	1.3	87.50	1.3	40.00	4.2	30.00
CP-261	45	4.50	5.2	145.50	4.50	7.5	42.00	1.3	87.50	1.3	40.00	4.2	30.00
CP-262	45	4.50	5.2	145.20	4.95	7.6	42.45	1.3	87.25	1.3	40.00	4.2	30.00
CP-263	45	4.50	5.2	145.20	5.40	7.6	42.45	1.3	87.25	1.3	40.00	4.2	30.00
CP-264	45	4.50	5.2	197.50	3.60	7.4	14.10	1.3	47.33	1.3	40.00	4.2	30.00
CP-265	45	4.50	5.2	197.35	4.05	7.5	14.25	1.3	47.33	1.3	40.00	4.2	30.00
CP-266	45	4.50	5.2	197.35	4.50	7.5	14.25	1.3	47.33	1.3	40.00	4.2	30.00
CP-267	45	4.50	5.2	197.20	4.95	7.6	14.45	1.3	47.25	1.3	40.00	4.2	30.00
CP-268	45	4.50	5.2	197.20	5.40	7.6	14.45	1.3	47.25	1.3	40.00	4.2	30.00
CP-269	45	4.50	5.2	179.80	3.60	7.4	33.30	1.3	44.83	1.3	40.00	4.2	30.00
CP-270	45	4.50	5.2	179.55	4.05	7.5	33.70	1.3	44.58	1.3	40.00	4.2	30.00

[0288] [Table 12]

	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)				
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]	
Conductive -layer coating solution	CP-271	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	179.55	W-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.5	33.70	1.3	44.58	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00
	CP-272		45	4.50	5.2	179.30		4.95	7.6	34.10	1.3	44.33	1.3	40.00		4.2	30.00
	CP-273		45	4.50	5.2	179.30		5.40	7.6	34.10	1.3	44.33	1.3	40.00		4.2	30.00
	CP-274		45	4.50	5.2	166.75		3.60	7.4	47.50	1.3	42.92	1.3	40.00		4.2	30.00
	CP-275		45	4.50	5.2	166.40		4.05	7.5	48.00	1.3	42.67	1.3	40.00		4.2	30.00
	CP-276		45	4.50	5.2	166.40		4.50	7.5	48.00	1.3	42.67	1.3	40.00		4.2	30.00
	CP-277		45	4.50	5.2	166.05		4.95	7.6	48.55	1.3	42.33	1.3	40.00		4.2	30.00
	CP-278		45	4.50	5.2	166.05		5.40	7.6	48.55	1.3	42.33	1.3	40.00		4.2	30.00
	CP-279		45	4.50	5.2	156.65		4.50	7.5	29.40	1.3	89.92	1.3	40.00		4.2	30.00
	CP-280		45	4.50	5.2	160.55		4.50	7.5	25.50	1.3	89.92	1.3	40.00		4.2	30.00

[0289] [Table 13]

	(1) A first metal oxide particle				(2) A second metal oxide particle			(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)			
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]	
Conductive -layer coating solution	CP-C42	W-doped tin oxide-coated titanium particles (average particle diameter: 230 nm)	45	4.50	5.2	115.85	None	None	1.3	265.25	1.3	5.00	None		
	CP-C43		45	4.50	5.2	176.85			1.3	163.58	1.3	5.00			
	CP-C44		45	4.50	5.2	214.46			1.3	100.90	1.3	5.00			
	CP-C45		45	4.50	5.2	114.50			1.3	264.75	1.3	5.00			
	CP-C46		45	4.50	5.2	174.62			1.3	163.12	1.3	5.00			
	CP-C47		45	4.50	5.2	211.63			1.3	100.53	1.3	5.00			
	CP-C48		45	4.50	5.2	85.50			1.3	254.17	1.3	5.00			
	CP-C49		45	4.50	5.2	127.80			1.3	153.17	1.3	5.00			
	CP-C50		45	4.50	5.2	153.01			1.3	92.97	1.3	5.00			
	CP-C51		W-doped tin oxide particles (average particle diameter: 20 nm)	None					4.50	7.5	141.25	222.92			
	CP-C52	4.50		7.5	199.36	1.3	126.07	1.3	5.00						
	CP-C53	4.50		7.5	231.05	1.3	73.25	1.3	5.00						
	CP-C54	45		4.50	5.2	84.25	1.3	313.87	1.3	5.00					
	CP-C55	45		4.50	5.2	81.50	1.3	312.70	1.3	5.00					
	CP-C56	45		4.50	5.2	75.05	1.3	309.80	1.3	5.00					
	CP-C57	45		4.50	5.2	70.20	1.3	307.58	1.3	5.00					
	CP-C58	45		4.50	5.2	67.10	1.3	306.18	1.3	5.00					
	CP-C59	45		4.50	5.2	218.08	1.3	84.37	1.3	5.00					
	CP-C60	45	4.50	5.2	209.80	1.3	83.47	1.3	5.00						
CP-C61	45	4.50	5.2	190.47	1.3	81.35	1.3	5.00							
CP-C62	45	4.50	5.2	176.27	1.3	79.80	1.3	5.00							
CP-C63	45	4.50	5.2	167.35	1.3	78.83	1.3	5.00							

[0290] [Table 14]

	(1) A first metal oxide particle				(2) A second metal oxide particle			(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Amount [part(s)]
Conductive -layer coating solution													
CP-C64	Oxygen-deficient tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	-	5.1	150.26		4.50	7.5	28.73	1.3	160.02	1.3	5.00
CP-C65	Oxygen-deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	150.26	W-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.5	28.73	1.3	160.02	1.3	5.00
CP-C66	Sb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	151.61		4.50	7.5	28.43	1.3	158.27	1.3	5.00

None

CP-C67	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.50	Oxygen- deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.32	1.3	160.30	1.3	5.00
CP-C68	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	152.45	Indium tin oxide particles (average particle diameter: 20 nm)	4.50	7.1	27.05	1.3	159.17	1.3	5.00
CP-C69	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.50	Sb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.32	1.3	160.30	1.3	5.00
CP-C70	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	148.90	W-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.5	29.03	1.3	161.78	1.3	5.00
CP-C71	W-doped tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	4.50	5.2	151.61		4.50	7.5	28.43	1.3	158.27	1.3	5.00

[0291] [Table 15]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle			(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density [part(s)]	Amount [part(s)]	Kind	Density [part(s)]	Amount [part(s)]
CP-281	F-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	F-doped tin oxide particles (average particle diameter: 20 nm)	3.60	6.7	2.97	1.3	268.88	1.3	5.00	None
CP-282		45	4.50	5.0		4.05	6.7	2.97	1.3	268.88	1.3	5.00	
CP-283		45	4.50	5.0		4.50	6.6	2.93	1.3	268.95	1.3	5.00	
CP-284		45	4.50	5.0		4.95	6.6	2.93	1.3	268.95	1.3	5.00	
CP-285		45	4.50	5.0		5.40	6.6	2.93	1.3	268.95	1.3	5.00	
CP-286		45	4.50	5.0		4.50	6.6	7.08	1.3	267.95	1.3	5.00	
CP-287		45	4.50	5.0		3.60	6.7	17.20	1.3	265.17	1.3	5.00	
CP-288		45	4.50	5.0		4.05	6.7	17.20	1.3	265.17	1.3	5.00	
CP-289		45	4.50	5.0		4.50	6.6	16.95	1.3	265.58	1.3	5.00	
CP-290		45	4.50	5.0		4.95	6.6	16.95	1.3	265.58	1.3	5.00	
CP-291		45	4.50	5.0		5.40	6.6	16.95	1.3	265.58	1.3	5.00	
CP-292		45	4.50	5.0		4.50	6.6	24.40	1.3	263.67	1.3	5.00	
CP-293		45	4.50	5.0		3.60	6.7	29.55	1.3	262.08	1.3	5.00	
CP-294		45	4.50	5.0		4.05	6.7	29.55	1.3	262.08	1.3	5.00	
CP-295		45	4.50	5.0		4.50	6.6	29.15	1.3	262.58	1.3	5.00	
CP-296		45	4.50	5.0		4.95	6.6	29.15	1.3	262.58	1.3	5.00	
CP-297		45	4.50	5.0		5.40	6.6	29.15	1.3	262.58	1.3	5.00	
CP-298		45	4.50	5.0		4.50	6.6	3.55	1.3	228.75	1.3	5.00	
CP-299		45	4.50	5.0		3.60	6.7	8.70	1.3	227.67	1.3	5.00	
CP-300		45	4.50	5.0		4.05	6.7	8.70	1.3	227.67	1.3	5.00	
CP-301		45	4.50	5.0		4.50	6.6	8.57	1.3	227.83	1.3	5.00	
CP-302		45	4.50	5.0		4.95	6.6	8.57	1.3	227.83	1.3	5.00	
CP-303		45	4.50	5.0		5.40	6.6	8.57	1.3	227.83	1.3	5.00	
CP-304		45	4.50	5.0		3.60	6.7	20.80	1.3	225.00	1.3	5.00	
CP-305		45	4.50	5.0		4.05	6.7	20.80	1.3	225.00	1.3	5.00	

CP-306	45	4.50	5.0	119.30	4.50	6.6	20.50	1.3	225.33	1.3	5.00
CP-307	45	4.50	5.0	119.30	4.95	6.6	20.50	1.3	225.33	1.3	5.00
CP-308	45	4.50	5.0	119.30	5.40	6.6	20.50	1.3	225.33	1.3	5.00
CP-309	45	4.50	5.0	111.40	3.60	6.7	29.85	1.3	222.92	1.3	5.00
CP-310	45	4.50	5.0	111.40	4.05	6.7	29.85	1.3	222.92	1.3	5.00
CP-311	45	4.50	5.0	111.45	4.50	6.6	29.45	1.3	223.50	1.3	5.00
CP-312	45	4.50	5.0	111.45	4.95	6.6	29.45	1.3	223.50	1.3	5.00
CP-313	45	4.50	5.0	111.45	5.40	6.6	29.45	1.3	223.50	1.3	5.00
CP-314	45	4.50	5.0	106.50	4.50	6.6	35.15	1.3	222.25	1.3	5.00
CP-315	45	4.50	5.0	170.20	3.60	6.7	4.57	1.3	167.05	1.3	5.00
CP-316	45	4.50	5.0	170.20	4.05	6.7	4.57	1.3	167.05	1.3	5.00
CP-317	45	4.50	5.0	170.20	4.50	6.6	4.50	1.3	167.17	1.3	5.00
CP-318	45	4.50	5.0	170.20	4.95	6.6	4.50	1.3	167.17	1.3	5.00
CP-319	45	4.50	5.0	170.20	5.40	6.6	4.50	1.3	167.17	1.3	5.00
CP-320	45	4.50	5.0	164.30	3.60	6.7	11.05	1.3	166.08	1.3	5.00

[0292] [Table 16]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part (s)]
CP-321	F-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	164.30	F-doped tin oxide particles (average particle diameter: 20 nm)	4.05	6.7	11.05	1.3	166.08	1.3	5.00	None
CP-322		45	4.50	5.0	164.45		4.50	6.6	10.86	1.3	166.15	1.3	5.00	
CP-323		45	4.50	5.0	164.45		4.95	6.6	10.86	1.3	166.15	1.3	5.00	
CP-324		45	4.50	5.0	164.45		5.40	6.6	10.86	1.3	166.15	1.3	5.00	
CP-325		45	4.50	5.0	150.60		3.60	6.7	26.25	1.3	163.58	1.3	5.00	
CP-326		45	4.50	5.0	150.60		4.05	6.7	26.25	1.3	163.58	1.3	5.00	
CP-327		45	4.50	5.0	150.80		4.50	6.6	25.90	1.3	163.83	1.3	5.00	
CP-328		45	4.50	5.0	150.80		4.95	6.6	25.90	1.3	163.83	1.3	5.00	
CP-329		45	4.50	5.0	150.80		5.40	6.6	25.90	1.3	163.83	1.3	5.00	
CP-330		45	4.50	5.0	140.30		3.60	6.7	37.60	1.3	161.83	1.3	5.00	
CP-331		45	4.50	5.0	140.30		4.05	6.7	37.60	1.3	161.83	1.3	5.00	
CP-332		45	4.50	5.0	140.55		4.50	6.6	37.15	1.3	162.17	1.3	5.00	
CP-333		45	4.50	5.0	140.55		4.95	6.6	37.15	1.3	162.17	1.3	5.00	
CP-334		45	4.50	5.0	140.55		5.40	6.6	37.15	1.3	162.17	1.3	5.00	
CP-335		45	4.50	5.0	133.80		3.60	6.7	44.82	1.3	160.63	1.3	5.00	
CP-336		45	4.50	5.0	133.80		4.05	6.7	44.82	1.3	160.63	1.3	5.00	
CP-337		45	4.50	5.0	134.10		4.50	6.6	44.25	1.3	161.08	1.3	5.00	
CP-338		45	4.50	5.0	134.10		4.95	6.6	44.25	1.3	161.08	1.3	5.00	
CP-339		45	4.50	5.0	134.10		5.40	6.6	44.25	1.3	161.08	1.3	5.00	
CP-340		45	4.50	5.0	196.60		4.50	6.6	5.19	1.3	122.02	1.3	5.00	
CP-341		45	4.50	5.0	189.70		3.60	6.7	12.74	1.3	120.93	1.3	5.00	
CP-342		45	4.50	5.0	189.70		4.05	6.7	12.74	1.3	120.93	1.3	5.00	
CP-343		45	4.50	5.0	189.75		4.50	6.6	12.55	1.3	121.17	1.3	5.00	
CP-344		45	4.50	5.0	189.75		4.95	6.6	12.55	1.3	121.17	1.3	5.00	
CP-345		45	4.50	5.0	189.75		5.40	6.6	12.55	1.3	121.17	1.3	5.00	
CP-346		45	4.50	5.0	173.40		3.60	6.7	30.20	1.3	119.00	1.3	5.00	
CP-347		45	4.50	5.0	173.40		4.05	6.7	30.20	1.3	119.00	1.3	5.00	
CP-348		45	4.50	5.0	173.70		4.50	6.6	29.80	1.3	119.17	1.3	5.00	
CP-349		45	4.50	5.0	173.70		4.95	6.6	29.80	1.3	119.17	1.3	5.00	

CP-350	45	4.50	5.0	173.70	5.40	6.6	29.80	1.3	119.17	1.3	5.00
CP-351	45	4.50	5.0	161.30	3.60	6.7	43.25	1.3	117.42	1.3	5.00
CP-352	45	4.50	5.0	161.30	4.05	6.7	43.25	1.3	117.42	1.3	5.00
CP-353	45	4.50	5.0	161.70	4.50	6.6	42.70	1.3	117.67	1.3	5.00
CP-354	45	4.50	5.0	161.70	4.95	6.6	42.70	1.3	117.67	1.3	5.00
CP-355	45	4.50	5.0	161.70	5.40	6.6	42.70	1.3	117.67	1.3	5.00
CP-356	45	4.50	5.0	154.10	4.50	6.6	50.85	1.3	116.75	1.3	5.00
CP-357	45	4.50	5.0	207.30	3.60	6.7	5.56	1.3	103.57	1.3	5.00
CP-358	45	4.50	5.0	207.30	4.05	6.7	5.56	1.3	103.57	1.3	5.00
CP-359	45	4.50	5.0	207.35	4.50	6.6	5.48	1.3	103.62	1.3	5.00
CP-360	45	4.50	5.0	207.35	4.95	6.6	5.48	1.3	103.62	1.3	5.00

[0293] [Table 17]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part (s)]	Kind	Doping ratio [%]	Density	Amount [part (s)]	(resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part (s)]
CP-361	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	207.35	F-doped tin oxide particles (average particle diameter: 20 nm)	5.40	6.6	5.48	1.3	1.3	5.00	None		
CP-362		45	4.50	5.0	200.07		4.50	6.6	13.21	1.3	1.3	5.00			
CP-363		45	4.50	5.0	182.62		3.60	6.7	31.82	1.3	1.3	5.00			
CP-364		45	4.50	5.0	182.62		4.05	6.7	31.82	1.3	1.3	5.00			
CP-365		45	4.50	5.0	182.95		4.50	6.6	31.40	1.3	1.3	5.00			
CP-366		45	4.50	5.0	182.95		4.95	6.6	31.40	1.3	1.3	5.00			
CP-367		45	4.50	5.0	182.95		5.40	6.6	31.40	1.3	1.3	5.00			
CP-368		45	4.50	5.0	170.15		4.50	6.6	44.95	1.3	1.3	5.00			
CP-369		45	4.50	5.0	161.65		3.60	6.7	54.18	1.3	1.3	5.00			
CP-370		45	4.50	5.0	161.65		4.05	6.7	54.18	1.3	1.3	5.00			
CP-371		45	4.50	5.0	162.10		4.50	6.6	53.50	1.3	1.3	5.00			
CP-372		45	4.50	5.0	162.10		4.95	6.6	53.50	1.3	1.3	5.00			
CP-373		45	4.50	5.0	162.10		5.40	6.6	53.50	1.3	1.3	5.00			

[0294] [Table 18]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)			(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [g/cm ³]	Amount [g]	Kind	Doping ratio [%]	Density [g/cm ³]	Amount [g]	Density [g/cm ³]	Amount [g]	Density [g/cm ³]	Amount [g]	Kind	Density [g/cm ³]
CP-374		45	4.50	5.0	134.00		3.60	6.7	9.00	1.3	161.67	1.3	40.00		4.2
CP-375		45	4.50	5.0	134.00		4.05	6.7	9.00	1.3	161.67	1.3	40.00		4.2
CP-376		45	4.50	5.0	134.10		4.50	6.6	8.85	1.3	161.75	1.3	40.00		4.2
CP-377		45	4.50	5.0	134.10		4.95	6.6	8.85	1.3	161.75	1.3	40.00		4.2
CP-378		45	4.50	5.0	134.10		5.40	6.6	8.85	1.3	161.75	1.3	40.00		4.2
CP-379		45	4.50	5.0	123.15		3.60	6.7	21.45	1.3	159.00	1.3	40.00		4.2
CP-380		45	4.50	5.0	123.15		4.05	6.7	21.45	1.3	159.00	1.3	40.00		4.2
CP-381		45	4.50	5.0	123.25		4.50	6.6	21.15	1.3	159.33	1.3	40.00		4.2
CP-382		45	4.50	5.0	123.25		4.95	6.6	21.15	1.3	159.33	1.3	40.00		4.2
CP-383		45	4.50	5.0	123.25		5.40	6.6	21.15	1.3	159.33	1.3	40.00		4.2
CP-384	F-doped tin oxide-coated titanium oxide	45	4.50	5.0	115.00		3.60	6.7	30.85	1.3	156.92	1.3	40.00		4.2
CP-385		45	4.50	5.0	115.00		4.05	6.7	30.85	1.3	156.92	1.3	40.00		4.2
CP-386		45	4.50	5.0	115.20	F-doped tin oxide	4.50	6.6	30.45	1.3	157.25	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2
CP-387		45	4.50	5.0	115.20		4.95	6.6	30.45	1.3	157.25	1.3	40.00		4.2
CP-388		45	4.50	5.0	115.20		5.40	6.6	30.45	1.3	157.25	1.3	40.00		4.2
CP-389		45	4.50	5.0	169.80		3.60	6.7	11.40	1.3	98.00	1.3	40.00		4.2
CP-390	particles (average particle diameter: 230 nm)	45	4.50	5.0	169.80	particles (average particle diameter: 20 nm)	4.05	6.7	11.40	1.3	98.00	1.3	40.00		4.2
CP-391		45	4.50	5.0	169.85		4.50	6.6	11.25	1.3	98.17	1.3	40.00		4.2
CP-392		45	4.50	5.0	169.85		4.95	6.6	11.25	1.3	98.17	1.3	40.00		4.2
CP-393		45	4.50	5.0	169.85		5.40	6.6	11.25	1.3	98.17	1.3	40.00		4.2
CP-394		45	4.50	5.0	155.60		3.60	6.7	27.10	1.3	95.50	1.3	40.00		4.2
CP-395		45	4.50	5.0	155.60		4.05	6.7	27.10	1.3	95.50	1.3	40.00		4.2
CP-396		45	4.50	5.0	155.75		4.50	6.6	26.75	1.3	95.83	1.3	40.00		4.2
CP-397		45	4.50	5.0	155.75		4.95	6.6	26.75	1.3	95.83	1.3	40.00		4.2
CP-398		45	4.50	5.0	155.75		5.40	6.6	26.75	1.3	95.83	1.3	40.00		4.2
CP-399		45	4.50	5.0	144.95		3.60	6.7	38.85	1.3	93.67	1.3	40.00		4.2
CP-400		45	4.50	5.0	144.95		4.05	6.7	38.85	1.3	93.67	1.3	40.00		4.2
CP-401		45	4.50	5.0	145.20		4.50	6.6	38.35	1.3	94.08	1.3	40.00		4.2
CP-402		45	4.50	5.0	145.20		4.95	6.6	38.35	1.3	94.08	1.3	40.00		4.2
CP-403		45	4.50	5.0	145.20		5.40	6.6	38.35	1.3	94.08	1.3	40.00		4.2
CP-404		45	4.50	5.0	195.90		3.60	6.7	13.15	1.3	51.58	1.3	40.00		4.2

[0295] [Table 19]

Conductive -layer coating solution	(1) A first metal oxide particle					(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density thereof is 60% by mass of the following)	Density [part(s)]	Amount [part(s)]	Kind	Density	Amount [part(s)]	
CP-405	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	195.90	F-doped tin oxide particles (average particle diameter: 20 nm)	4.05	6.7	13.15	1.3	51.58	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00
CP-406		45	4.50	5.0	196.10		4.50	6.6	12.95	1.3	51.58	1.3	40.00		4.2	30.00
CP-407		45	4.50	5.0	196.10		4.95	6.6	12.95	1.3	51.58	1.3	40.00		4.2	30.00
CP-408		45	4.50	5.0	196.10		5.40	6.6	12.95	1.3	51.58	1.3	40.00		4.2	30.00
CP-409		45	4.50	5.0	179.15		3.60	6.7	31.20	1.3	49.42	1.3	40.00		4.2	30.00
CP-410		45	4.50	5.0	179.15		4.05	6.7	31.20	1.3	49.42	1.3	40.00		4.2	30.00
CP-411		45	4.50	5.0	179.45		4.50	6.6	30.80	1.3	49.58	1.3	40.00		4.2	30.00
CP-412		45	4.50	5.0	179.45		4.95	6.6	30.80	1.3	49.58	1.3	40.00		4.2	30.00
CP-413		45	4.50	5.0	179.45		5.40	6.6	30.80	1.3	49.58	1.3	40.00		4.2	30.00
CP-414		45	4.50	5.0	166.60		3.60	6.7	44.70	1.3	47.83	1.3	40.00		4.2	30.00
CP-415	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	166.60	4.05	6.7	44.70	1.3	47.83	1.3	40.00	4.2	30.00		
CP-416		45	4.50	5.0	167.05	4.50	6.6	44.10	1.3	48.08	1.3	40.00	4.2	30.00		
CP-417		45	4.50	5.0	167.05	4.95	6.6	44.10	1.3	48.08	1.3	40.00	4.2	30.00		
CP-418		45	4.50	5.0	167.05	5.40	6.6	44.10	1.3	48.08	1.3	40.00	4.2	30.00		
CP-419		45	4.50	5.0	155.75	4.50	6.6	26.75	1.3	95.83	1.3	40.00	4.2	30.00		
CP-420		45	4.50	5.0	159.00	4.50	6.6	23.20	1.3	96.33	1.3	40.00	4.2	30.00		

[0296] [Table 20]

	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density thereof is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]
Conductive -layer coating solution															
CP-C76	F-doped tin	45	4.50	5.0	113.20					1.3	269.67	1.3	5.00		
CP-C77	oxide-coated	45	4.50	5.0	174.30					1.3	167.83	1.3	5.00		
CP-C78	titanium	45	4.50	5.0	212.50					1.3	104.17	1.3	5.00		
CP-C79	oxide	45	4.50	5.0	112.00					1.3	269.20	1.3	5.00		
CP-C80	particles	45	4.50	5.0	172.20					1.3	167.52	1.3	5.00		
CP-C81	(average	45	4.50	5.0	209.90					1.3	103.87	1.3	5.00		
CP-C82	particle	45	4.50	5.0	84.60					1.3	261.50	1.3	5.00		
CP-C83	diameter: 230 nm)	45	4.50	5.0	128.20					1.3	160.07	1.3	5.00		
CP-C84		45	4.50	5.0	154.80					1.3	98.17	1.3	5.00		
CP-C85										1.3	237.83	1.3	5.00		
CP-C86										1.3	138.58	1.3	5.00		
CP-C87										1.3	82.22	1.3	5.00		
CP-C88		45	4.50	5.0	82.10					1.3	317.88	1.3	5.00		
CP-C89	F-doped tin	45	4.50	5.0	79.50					1.3	317.08	1.3	5.00		
CP-C90	oxide-coated	45	4.50	5.0	73.50					1.3	314.82	1.3	5.00		
CP-C91	titanium	45	4.50	5.0	68.80					1.3	313.37	1.3	5.00		
CP-C92	oxide	45	4.50	5.0	65.90					1.3	312.25	1.3	5.00		
CP-C93	particles	45	4.50	5.0	216.76					1.3	87.48	1.3	5.00		
CP-C94	(average	45	4.50	5.0	209.10					1.3	86.82	1.3	5.00		
CP-C95	particle	45	4.50	5.0	191.10					1.3	85.17	1.3	5.00		
CP-C96	diameter: 230 nm)	45	4.50	5.0	177.65					1.3	84.00	1.3	5.00		
CP-C97		45	4.50	5.0	169.20					1.3	83.25	1.3	5.00		

None

F-doped tin oxide particles (average particle diameter: 20 nm)

[0297] [Table 21]

	(1) A first metal oxide particle				(2) A second metal oxide particle			(3) Binding material (phenol resin)			(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]
Conductive -layer coating solution														
CP-C98	Oxygen-deficient tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	-	5.1	152.20			4.50	6.6	25.60	1.3	162.00	1.3	5.00
CP-C99	Oxygen-deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	152.20	F-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	162.00	1.3	5.00	None
CP-C100	Sb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.50			4.50	6.6	25.35	1.3	160.25	1.3	5.00

CP-C101	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	150.75	Oxygen- deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.90	1.3	163.92	1.3	5.00
CP-C102		45	4.50	5.0	149.72	Indium tin oxide particles (average particle diameter: 20 nm)	4.50	7.1	27.63	1.3	162.50	1.3	5.00
CP-C103		45	4.50	5.0	150.76	Sb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.87	1.3	163.95	1.3	5.00
CP-C104	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.50	F-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.32	1.3	160.30	1.3	5.00
CP-C105	F-doped tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	4.50	5.0	150.75		4.50	6.6	25.90	1.3	163.92	1.3	5.00

[0298] [Table 44]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle			(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part(s)]	Amount [part(s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density [part (s)]	Amount [part (s)]	Kind	Density [part (s)]
CP-421	Nb-doped tin oxide- titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	111.95	Nb-doped tin oxide particles (average particle diameter: 20 nm)	3.60	7.0	3.07	1.3	266.63	1.3	5.00
CP-422		45	4.50	5.1	111.95		4.05	7.0	3.07	1.3	266.63	1.3	5.00
CP-423		45	4.50	5.1	111.95		4.50	7.0	3.07	1.3	266.63	1.3	5.00
CP-424		45	4.50	5.1	111.95		4.95	7.0	3.07	1.3	266.63	1.3	5.00
CP-425		45	4.50	5.1	111.95		5.40	7.0	3.07	1.3	266.63	1.3	5.00
CP-426		45	4.50	5.1	108.30		4.50	7.0	7.43	1.3	265.45	1.3	5.00
CP-427		45	4.50	5.1	99.60		3.60	7.0	17.77	1.3	262.72	1.3	5.00
CP-428		45	4.50	5.1	99.60		4.05	7.0	17.77	1.3	262.72	1.3	5.00
CP-429		45	4.50	5.1	99.60		4.50	7.0	17.77	1.3	262.72	1.3	5.00
CP-430		45	4.50	5.1	99.60		4.95	7.0	17.77	1.3	262.72	1.3	5.00
CP-431		45	4.50	5.1	99.60		5.40	7.0	17.77	1.3	262.72	1.3	5.00
CP-432		45	4.50	5.1	93.10		4.50	7.0	25.56	1.3	260.57	1.3	5.00
CP-433		45	4.50	5.1	88.92		3.60	7.0	30.51	1.3	259.28	1.3	5.00
CP-434		45	4.50	5.1	88.92		4.05	7.0	30.51	1.3	259.28	1.3	5.00
CP-435		45	4.50	5.1	88.92		4.50	7.0	30.51	1.3	259.28	1.3	5.00
CP-436		45	4.50	5.1	88.92		4.95	7.0	30.51	1.3	259.28	1.3	5.00
CP-437		45	4.50	5.1	88.92		5.40	7.0	30.51	1.3	259.28	1.3	5.00
CP-438	Nb-doped tin oxide- titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	135.45		4.50	7.0	3.72	1.3	259.28	1.3	5.00
CP-439		45	4.50	5.1	130.90		3.60	7.0	8.98	1.3	225.20	1.3	5.00
CP-440		45	4.50	5.1	130.90		4.05	7.0	8.98	1.3	225.20	1.3	5.00
CP-441		45	4.50	5.1	130.90		4.50	7.0	8.98	1.3	225.20	1.3	5.00
CP-442		45	4.50	5.1	130.90		4.95	7.0	8.98	1.3	225.20	1.3	5.00
CP-443		45	4.50	5.1	130.90		5.40	7.0	8.98	1.3	225.20	1.3	5.00
CP-444		45	4.50	5.1	120.15		3.60	7.0	21.44	1.3	222.35	1.3	5.00
CP-445		45	4.50	5.1	120.15		4.05	7.0	21.44	1.3	222.35	1.3	5.00
CP-446		45	4.50	5.1	120.15		4.50	7.0	21.44	1.3	222.35	1.3	5.00
CP-447		45	4.50	5.1	120.15		4.95	7.0	21.44	1.3	222.35	1.3	5.00

None

CP-447	45	4.50	5.1	120.15	4.95	7.0	21.44	1.3	222.35	1.3	5.00
CP-448	45	4.50	5.1	120.15	5.40	7.0	21.44	1.3	222.35	1.3	5.00
CP-449	45	4.50	5.1	112.08	3.60	7.0	30.77	1.3	220.25	1.3	5.00
CP-450	45	4.50	5.1	112.08	4.05	7.0	30.77	1.3	220.25	1.3	5.00
CP-451	45	4.50	5.1	112.08	4.50	7.0	30.77	1.3	220.25	1.3	5.00
CP-452	45	4.50	5.1	112.08	4.95	7.0	30.77	1.3	220.25	1.3	5.00
CP-453	45	4.50	5.1	112.08	5.40	7.0	30.77	1.3	220.25	1.3	5.00
CP-454	45	4.50	5.1	106.95	4.50	7.0	36.70	1.3	218.92	1.3	5.00
CP-455	45	4.50	5.1	171.35	3.60	7.0	4.70	1.3	164.92	1.3	5.00
CP-456	45	4.50	5.1	171.35	4.05	7.0	4.70	1.3	164.92	1.3	5.00
CP-457	45	4.50	5.1	171.35	4.50	7.0	4.70	1.3	164.92	1.3	5.00
CP-458	45	4.50	5.1	171.35	4.95	7.0	4.70	1.3	164.92	1.3	5.00
CP-459	45	4.50	5.1	171.35	5.40	7.0	4.70	1.3	164.92	1.3	5.00
CP-460	45	4.50	5.1	165.37	3.60	7.0	11.35	1.3	163.80	1.3	5.00

[0299] [Table 45]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle			(3) Binding material (phenol resin)			(4)Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part(s)]
CP-461	Nb-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	165.37	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.05	7.0	11.35	1.3	163.80	1.3	5.00	None
CP-462		45	4.50	5.1	165.37		4.50	7.0	11.35	1.3	163.80	1.3	5.00	
CP-463		45	4.50	5.1	165.37		4.95	7.0	11.35	1.3	163.80	1.3	5.00	
CP-464		45	4.50	5.1	165.37		5.40	7.0	11.35	1.3	163.80	1.3	5.00	
CP-465		45	4.50	5.1	151.30		3.60	7.0	27.00	1.3	161.17	1.3	5.00	
CP-466		45	4.50	5.1	151.30		4.05	7.0	27.00	1.3	161.17	1.3	5.00	
CP-467		45	4.50	5.1	151.30		4.50	7.0	27.00	1.3	161.17	1.3	5.00	
CP-468		45	4.50	5.1	151.30		4.95	7.0	27.00	1.3	161.17	1.3	5.00	
CP-469		45	4.50	5.1	151.30		5.40	7.0	27.00	1.3	161.17	1.3	5.00	
CP-470		45	4.50	5.1	140.84		3.60	7.0	38.66	1.3	159.17	1.3	5.00	
CP-471		45	4.50	5.1	140.84		4.05	7.0	38.66	1.3	159.17	1.3	5.00	
CP-472		45	4.50	5.1	140.84		4.50	7.0	38.66	1.3	159.17	1.3	5.00	
CP-473		45	4.50	5.1	140.84		4.95	7.0	38.66	1.3	159.17	1.3	5.00	
CP-474		45	4.50	5.1	140.84		5.40	7.0	38.66	1.3	159.17	1.3	5.00	
CP-475		45	4.50	5.1	134.20		3.60	7.0	46.05	1.3	157.92	1.3	5.00	
CP-476		45	4.50	5.1	134.20		4.05	7.0	46.05	1.3	157.92	1.3	5.00	
CP-477		45	4.50	5.1	134.20		4.50	7.0	46.05	1.3	157.92	1.3	5.00	
CP-478		45	4.50	5.1	134.20		4.95	7.0	46.05	1.3	157.92	1.3	5.00	
CP-479		45	4.50	5.1	134.20		5.40	7.0	46.05	1.3	157.92	1.3	5.00	
CP-480	45	4.50	5.1	197.53	4.50	7.0	5.43	1.3	120.07	1.3	5.00			
CP-481	45	4.50	5.1	190.45	3.60	7.0	13.08	1.3	119.12	1.3	5.00			
CP-482	45	4.50	5.1	190.45	4.05	7.0	13.08	1.3	119.12	1.3	5.00			
CP-483	45	4.50	5.1	190.45	4.50	7.0	13.08	1.3	119.12	1.3	5.00			
CP-484	45	4.50	5.1	190.45	4.95	7.0	13.08	1.3	119.12	1.3	5.00			
CP-485	45	4.50	5.1	190.45	5.40	7.0	13.08	1.3	119.12	1.3	5.00			
CP-486	45	4.50	5.1	173.86	3.60	7.0	31.02	1.3	116.87	1.3	5.00			

None

CP-487	45	4.50	5.1	173.86	4.05	7.0	31.02	1.3	116.87	1.3	5.00
CP-488	45	4.50	5.1	173.86	4.50	7.0	31.02	1.3	116.87	1.3	5.00
CP-489	45	4.50	5.1	173.86	4.95	7.0	31.02	1.3	116.87	1.3	5.00
CP-490	45	4.50	5.1	173.86	5.40	7.0	31.02	1.3	116.87	1.3	5.00
CP-491	45	4.50	5.1	161.54	3.60	7.0	44.35	1.3	115.18	1.3	5.00
CP-492	45	4.50	5.1	161.54	4.05	7.0	44.35	1.3	115.18	1.3	5.00
CP-493	45	4.50	5.1	161.54	4.50	7.0	44.35	1.3	115.18	1.3	5.00
CP-494	45	4.50	5.1	161.54	4.95	7.0	44.35	1.3	115.18	1.3	5.00
CP-495	45	4.50	5.1	161.54	5.40	7.0	44.35	1.3	115.18	1.3	5.00
CP-496	45	4.50	5.1	153.76	4.50	7.0	52.76	1.3	114.13	1.3	5.00
CP-497	45	4.50	5.1	208.14	3.60	7.0	5.72	1.3	101.90	1.3	5.00
CP-498	45	4.50	5.1	208.14	4.05	7.0	5.72	1.3	101.90	1.3	5.00
CP-499	45	4.50	5.1	208.14	4.50	7.0	5.72	1.3	101.90	1.3	5.00
CP-500	45	4.50	5.1	208.14	4.95	7.0	5.72	1.3	101.90	1.3	5.00

[0300] [Table 46]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part (s)]	
CP-501	Nb-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	Nb-doped tin oxide particles (average particle diameter: 20 nm)	5.40	7.0	5.72	1.3	101.90	Uncoated titanium oxide particles (average particle diameter: 210 nm)	1.3	5.00	None
CP-502		45	4.50	5.1		4.50	7.0	13.76	1.3	101.03		1.3	5.00	
CP-503		45	4.50	5.1		3.60	7.0	32.64	1.3	99.02		1.3	5.00	
CP-504		45	4.50	5.1		4.05	7.0	32.64	1.3	99.02		1.3	5.00	
CP-505		45	4.50	5.1		4.50	7.0	32.64	1.3	99.02		1.3	5.00	
CP-506		45	4.50	5.1		4.95	7.0	32.64	1.3	99.02		1.3	5.00	
CP-507		45	4.50	5.1		5.40	7.0	32.64	1.3	99.02		1.3	5.00	
CP-508		45	4.50	5.1		4.50	7.0	46.62	1.3	97.52		1.3	5.00	
CP-509		45	4.50	5.1		3.60	7.0	55.45	1.3	96.55		1.3	5.00	
CP-510		45	4.50	5.1		4.05	7.0	55.45	1.3	96.55		1.3	5.00	
CP-511		45	4.50	5.1		4.50	7.0	55.45	1.3	96.55		1.3	5.00	
CP-512		45	4.50	5.1		4.95	7.0	55.45	1.3	96.55		1.3	5.00	
CP-513		45	4.50	5.1		5.40	7.0	55.45	1.3	96.55		1.3	5.00	
CP-514		45	4.50	5.1		3.60	7.0	9.28	1.3	159.12		1.3	40.00	
CP-515		45	4.50	5.1		4.05	7.0	9.28	1.3	159.12		1.3	40.00	
CP-516		45	4.50	5.1		4.50	7.0	9.28	1.3	159.12		1.3	40.00	
CP-517		45	4.50	5.1		4.95	7.0	9.28	1.3	159.12		1.3	40.00	
CP-518		45	4.50	5.1		5.40	7.0	9.28	1.3	159.12		1.3	40.00	
CP-519		45	4.50	5.1		3.60	7.0	22.15	1.3	156.20		1.3	40.00	
CP-520		45	4.50	5.1		4.05	7.0	22.15	1.3	156.20		1.3	40.00	
CP-521		45	4.50	5.1		4.50	7.0	22.15	1.3	156.20		1.3	40.00	
CP-522		45	4.50	5.1		4.95	7.0	22.15	1.3	156.20		1.3	40.00	
CP-523		45	4.50	5.1		5.40	7.0	22.15	1.3	156.20		1.3	40.00	
CP-524		45	4.50	5.1		3.60	7.0	31.79	1.3	154.02		1.3	40.00	
CP-525		45	4.50	5.1		4.05	7.0	31.79	1.3	154.02		1.3	40.00	

CP-526	45	4.50	5.1	115.80	4.50	7.0	31.79	1.3	154.02	1.3	40.00	4.2	30.00
CP-527	45	4.50	5.1	115.80	4.95	7.0	31.79	1.3	154.02	1.3	40.00	4.2	30.00
CP-528	45	4.50	5.1	115.80	5.40	7.0	31.79	1.3	154.02	1.3	40.00	4.2	30.00
CP-529	45	4.50	5.1	170.85	3.60	7.0	11.72	1.3	95.72	1.3	40.00	4.2	30.00
CP-530	45	4.50	5.1	170.85	4.05	7.0	11.72	1.3	95.72	1.3	40.00	4.2	30.00
CP-531	45	4.50	5.1	170.85	4.50	7.0	11.72	1.3	95.72	1.3	40.00	4.2	30.00
CP-532	45	4.50	5.1	170.85	4.95	7.0	11.72	1.3	95.72	1.3	40.00	4.2	30.00
CP-533	45	4.50	5.1	170.85	5.40	7.0	11.72	1.3	95.72	1.3	40.00	4.2	30.00
CP-534	45	4.50	5.1	156.32	3.60	7.0	27.90	1.3	92.97	1.3	40.00	4.2	30.00
CP-535	45	4.50	5.1	156.32	4.05	7.0	27.90	1.3	92.97	1.3	40.00	4.2	30.00
CP-536	45	4.50	5.1	156.32	4.50	7.0	27.90	1.3	92.97	1.3	40.00	4.2	30.00
CP-537	45	4.50	5.1	156.32	4.95	7.0	27.90	1.3	92.97	1.3	40.00	4.2	30.00
CP-538	45	4.50	5.1	156.32	5.40	7.0	27.90	1.3	92.97	1.3	40.00	4.2	30.00
CP-539	45	4.50	5.1	145.50	3.60	7.0	39.95	1.3	90.92	1.3	40.00	4.2	30.00
CP-540	45	4.50	5.1	145.50	4.05	7.0	39.95	1.3	90.92	1.3	40.00	4.2	30.00

[0301] [Table 47]

Conductive -layer coating solution	(1) A first metal oxide particle					(2) A second metal oxide particle					(3) Binding material (phenol resin)			(4) Silicone resin particles		(5) Particles except (1) to (4)
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part (s)]	Kind	Doping ratio [%]	Density	Amount [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part (s)]	
CP-541	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	145.50	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	39.95	1.3	90.92	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00
CP-542		45	4.50	5.1	145.50		4.95	7.0	39.95	1.3	90.92	1.3	40.00		4.2	30.00
CP-543		45	4.50	5.1	145.50		5.40	7.0	39.95	1.3	90.92	1.3	40.00		4.2	30.00
CP-544		45	4.50	5.1	196.78		3.60	7.0	13.50	1.3	49.53	1.3	40.00		4.2	30.00
CP-545		45	4.50	5.1	196.78		4.05	7.0	13.50	1.3	49.53	1.3	40.00		4.2	30.00
CP-546		45	4.50	5.1	196.78		4.50	7.0	13.50	1.3	49.53	1.3	40.00		4.2	30.00
CP-547		45	4.50	5.1	196.78		4.95	7.0	13.50	1.3	49.53	1.3	40.00		4.2	30.00
CP-548		45	4.50	5.1	196.78		5.40	7.0	13.50	1.3	49.53	1.3	40.00		4.2	30.00
CP-549		45	4.50	5.1	179.62		3.60	7.0	32.05	1.3	47.22	1.3	40.00		4.2	30.00
CP-550		45	4.50	5.1	179.62		4.05	7.0	32.05	1.3	47.22	1.3	40.00		4.2	30.00
CP-551	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	179.62	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	32.05	1.3	47.22	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00
CP-552		45	4.50	5.1	179.62		4.95	7.0	32.05	1.3	47.22	1.3	40.00		4.2	30.00
CP-553		45	4.50	5.1	179.62		5.40	7.0	32.05	1.3	47.22	1.3	40.00		4.2	30.00
CP-554		45	4.50	5.1	166.90		3.60	7.0	45.82	1.3	45.47	1.3	40.00		4.2	30.00
CP-555		45	4.50	5.1	166.90		4.05	7.0	45.82	1.3	45.47	1.3	40.00		4.2	30.00
CP-556		45	4.50	5.1	166.90		4.50	7.0	45.82	1.3	45.47	1.3	40.00		4.2	30.00
CP-557		45	4.50	5.1	166.90		4.95	7.0	45.82	1.3	45.47	1.3	40.00		4.2	30.00
CP-558		45	4.50	5.1	166.90		5.40	7.0	45.82	1.3	45.47	1.3	40.00		4.2	30.00
CP-559		45	4.50	5.1	156.32		4.50	7.0	27.90	1.3	92.97	1.3	40.00		4.2	30.00
CP-560		45	4.50	5.1	159.70		4.50	7.0	24.15	1.3	93.58	1.3	40.00		4.2	30.00

[0302] [Table 48]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Amount Density [part(s)]	Kind	Doping ratio [%]	Density [part(s)]	Amount Density [part(s)]	Density [part(s)]	Amount solid content thereof is 60% by mass of the following)	Density [part(s)]	Amount Density [part(s)]	Kind	Amount Density [part(s)]
CP-C107	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	1.55	1.3	267.42	1.3	5.00	None	
CP-C108		45	4.50	5.1		4.50	7.0	2.37	1.3	165.70	1.3	5.00		
CP-C109		45	4.50	5.1		4.50	7.0	2.90	1.3	102.53	1.3	5.00		
CP-C110		45	4.50	5.1		4.50	7.0	35.04	1.3	267.00	1.3	5.00		
CP-C111		45	4.50	5.1		4.50	7.0	2.90	1.3	165.30	1.3	5.00		
CP-C112		45	4.50	5.1		4.50	7.0	52.76	1.3	102.22	1.3	5.00		
CP-C113		45	4.50	5.1		4.50	7.0	63.46	1.3	258.10	1.3	5.00		
CP-C114		45	4.50	5.1		4.50	7.0	136.40	1.3	156.82	1.3	5.00		
CP-C115	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1		4.50	7.0	195.35	1.3	95.70	1.3	5.00		
CP-C116		45	4.50	5.1		4.50	7.0	228.20	1.3	231.00	1.3	5.00		
CP-C117		45	4.50	5.1		4.50	7.0	2.28	1.3	132.75	1.3	5.00		
CP-C118		45	4.50	5.1		4.50	7.0	5.53	1.3	78.00	1.3	5.00		
CP-C119		45	4.50	5.1		4.50	7.0	13.25	1.3	315.95	1.3	5.00		
CP-C120		45	4.50	5.1		4.50	7.0	19.09	1.3	314.95	1.3	5.00		
CP-C121		45	4.50	5.1		4.50	7.0	22.82	1.3	312.52	1.3	5.00		
CP-C122		45	4.50	5.1		4.50	7.0	5.98	1.3	310.60	1.3	5.00		
CP-C123	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1		4.50	7.0	14.37	1.3	309.47	1.3	5.00		
CP-C124		45	4.50	5.1		4.50	7.0	34.06	1.3	85.92	1.3	5.00		
CP-C125		45	4.50	5.1		4.50	7.0	48.63	1.3	85.13	1.3	5.00		
CP-C126		45	4.50	5.1		4.50	7.0	57.82	1.3	83.32	1.3	5.00		
CP-C127		45	4.50	5.1		4.50	7.0		1.3	81.98	1.3	5.00		
CP-C128		45	4.50	5.1		4.50	7.0		1.3	81.15	1.3	5.00		

[0303] [Table 49]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part (s)]	Kind	Doping ratio [%]	Density	Amount [part (s)]	Density	Amount [part (s)]	Density	Kind	Density	Amount [part (s)]
CP-561	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	113.20	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 20 nm)	3.60	7.3	3.18	1.3	264.37	1.3			5.00
CP-562		45	4.50	5.2	113.20		4.05	7.3	3.18	1.3	264.37	1.3			5.00
CP-563		45	4.50	5.2	113.20		4.50	7.4	3.22	1.3	264.30	1.3			5.00
CP-564		45	4.50	5.2	113.20		4.95	7.4	3.22	1.3	264.30	1.3			5.00
CP-565		45	4.50	5.2	113.20		5.40	7.5	3.26	1.3	264.23	1.3			5.00
CP-566		45	4.50	5.2	109.45		4.50	7.4	7.79	1.3	262.93	1.3			5.00
CP-567		45	4.50	5.2	100.60		3.60	7.3	18.36	1.3	260.07	1.3			5.00
CP-568		45	4.50	5.2	100.60		4.05	7.3	18.36	1.3	260.07	1.3			5.00
CP-569		45	4.50	5.2	100.50		4.50	7.4	18.59	1.3	259.85	1.3			5.00
CP-570		45	4.50	5.2	100.50		4.95	7.4	18.59	1.3	259.85	1.3			5.00
CP-571		45	4.50	5.2	100.43		5.40	7.5	18.83	1.3	259.57	1.3			5.00
CP-572		45	4.50	5.2	93.80		4.50	7.4	26.70	1.3	257.50	1.3			5.00
CP-573		45	4.50	5.2	89.70		3.60	7.3	31.48	1.3	256.37	1.3			5.00
CP-574		45	4.50	5.2	89.70		4.05	7.3	31.48	1.3	256.37	1.3			5.00
CP-575		45	4.50	5.2	89.57		4.50	7.4	31.87	1.3	255.93	1.3			5.00
CP-576		45	4.50	5.2	89.57		4.95	7.4	31.87	1.3	255.93	1.3			5.00
CP-577		45	4.50	5.2	89.42		5.40	7.5	32.24	1.3	255.57	1.3			5.00
CP-578		45	4.50	5.2	136.70		4.50	7.4	3.90	1.3	224.00	1.3			5.00
CP-579		45	4.50	5.2	132.05		3.60	7.3	9.27	1.3	222.80	1.3			5.00
CP-580		45	4.50	5.2	132.05		4.05	7.3	9.27	1.3	222.80	1.3			5.00
CP-581		45	4.50	5.2	132.00		4.50	7.4	9.40	1.3	222.67	1.3			5.00
CP-582		45	4.50	5.2	132.00		4.95	7.4	9.40	1.3	222.67	1.3			5.00
CP-583		45	4.50	5.2	131.95		5.40	7.5	9.52	1.3	222.55	1.3			5.00
CP-584		45	4.50	5.2	121.10		3.60	7.3	22.10	1.3	219.67	1.3			5.00
CP-585		45	4.50	5.2	121.10		4.05	7.3	22.10	1.3	219.67	1.3			5.00
CP-586		45	4.50	5.2	120.95		4.50	7.4	22.38	1.3	219.45	1.3			5.00

None

CP-587	45	4.50	5.2	120.95	4.95	7.4	22.38	1.3	219.45	1.3	5.00
CP-588	45	4.50	5.2	120.82	5.40	7.5	22.66	1.3	219.20	1.3	5.00
CP-589	45	4.50	5.2	112.88	3.60	7.3	31.70	1.3	217.37	1.3	5.00
CP-590	45	4.50	5.2	112.88	4.05	7.3	31.70	1.3	217.37	1.3	5.00
CP-591	45	4.50	5.2	112.70	4.50	7.4	32.08	1.3	217.03	1.3	5.00
CP-592	45	4.50	5.2	112.70	4.95	7.4	32.08	1.3	217.03	1.3	5.00
CP-593	45	4.50	5.2	112.52	5.40	7.5	32.45	1.3	216.72	1.3	5.00
CP-594	45	4.50	5.2	107.45	4.50	7.4	38.22	1.3	215.55	1.3	5.00
CP-595	45	4.50	5.2	172.50	3.60	7.3	4.85	1.3	162.75	1.3	5.00
CP-596	45	4.50	5.2	172.50	4.05	7.3	4.85	1.3	162.75	1.3	5.00
CP-597	45	4.50	5.2	172.48	4.50	7.4	4.90	1.3	162.70	1.3	5.00
CP-598	45	4.50	5.2	172.48	4.95	7.4	4.90	1.3	162.70	1.3	5.00
CP-599	45	4.50	5.2	172.42	5.40	7.5	4.98	1.3	162.67	1.3	5.00
CP-600	45	4.50	5.2	166.40	3.60	7.3	11.68	1.3	161.53	1.3	5.00

[0304] [Table 50]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)			(4) Silicone resin particles		(5) Particles except (1) to (4)					
	Kind	Coating ratio [%]	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Kind	Doping ratio [%]	Density [part (s)]	Amount [part (s)]	Density [part (s)]	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density [part (s)]	Amount [part (s)]	Kind	Density	Amount [part (s)]			
	Ta-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	166.40	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.05	7.3	11.68	1.3	161.53	1.3	5.00	None					
		45	4.50	5.2	166.30		4.50	7.4	11.83	1.3	161.45	1.3	5.00						
		45	4.50	5.2	166.30		4.95	7.4	11.83	1.3	161.45	1.3	5.00						
		45	4.50	5.2	166.22		5.40	7.5	11.99	1.3	161.32	1.3	5.00						
		45	4.50	5.2	152.02		3.60	7.3	27.75	1.3	158.72	1.3	5.00						
		45	4.50	5.2	152.02		4.05	7.3	27.75	1.3	158.72	1.3	5.00						
		45	4.50	5.2	151.83		4.50	7.4	28.09	1.3	158.47	1.3	5.00						
		45	4.50	5.2	151.83		4.95	7.4	28.09	1.3	158.47	1.3	5.00						
		45	4.50	5.2	151.61		5.40	7.5	28.43	1.3	158.27	1.3	5.00						
		45	4.50	5.2	141.37		3.60	7.3	39.69	1.3	156.57	1.3	5.00						
		45	4.50	5.2	141.37		4.05	7.3	39.69	1.3	156.57	1.3	5.00						
		45	4.50	5.2	141.10		4.50	7.4	40.15	1.3	156.25	1.3	5.00						
		45	4.50	5.2	141.10		4.95	7.4	40.15	1.3	156.25	1.3	5.00						
		45	4.50	5.2	140.82		5.40	7.5	40.62	1.3	155.93	1.3	5.00						
		45	4.50	5.2	134.60		3.60	7.3	47.24	1.3	155.27	1.3	5.00						
		45	4.50	5.2	134.60		4.05	7.3	47.24	1.3	155.27	1.3	5.00						
		45	4.50	5.2	134.30		4.50	7.4	47.78	1.3	154.87	1.3	5.00						
		45	4.50	5.2	134.30		4.95	7.4	47.78	1.3	154.87	1.3	5.00						
		45	4.50	5.2	133.98		5.40	7.5	48.31	1.3	154.52	1.3	5.00						
		45	4.50	5.2	198.45		4.50	7.4	5.65	1.3	118.17	1.3	5.00						
		45	4.50	5.2	191.27		3.60	7.3	13.43	1.3	117.17	1.3	5.00						
		45	4.50	5.2	191.27		4.05	7.3	13.43	1.3	117.17	1.3	5.00						
		45	4.50	5.2	191.15		4.50	7.4	13.60	1.3	117.08	1.3	5.00						
		45	4.50	5.2	191.15		4.95	7.4	13.60	1.3	117.08	1.3	5.00						
		45	4.50	5.2	191.00		5.40	7.5	13.78	1.3	117.03	1.3	5.00						
		45	4.50	5.2	174.32		3.60	7.3	31.82	1.3	114.77	1.3	5.00						
		45	4.50	5.2	174.32		4.05	7.3	31.82	1.3	114.77	1.3	5.00						
		45	4.50	5.2	174.05		4.50	7.4	32.20	1.3	114.58	1.3	5.00						
		45	4.50	5.2	174.05		4.95	7.4	32.20	1.3	114.58	1.3	5.00						
		45	4.50	5.2	173.78		5.40	7.5	32.58	1.3	114.40	1.3	5.00						

CP-631	45	4.50	5.2	161.77	3.60	7.3	45.42	1.3	113.02	1.3	5.00
CP-632	45	4.50	5.2	161.77	4.05	7.3	45.42	1.3	113.02	1.3	5.00
CP-633	45	4.50	5.2	161.42	4.50	7.4	45.95	1.3	112.72	1.3	5.00
CP-634	45	4.50	5.2	161.42	4.95	7.4	45.95	1.3	112.72	1.3	5.00
CP-635	45	4.50	5.2	161.07	5.40	7.5	46.46	1.3	112.45	1.3	5.00
CP-636	45	4.50	5.2	153.46	4.50	7.4	54.60	1.3	111.57	1.3	5.00
CP-637	45	4.50	5.2	209.00	3.60	7.3	5.87	1.3	100.22	1.3	5.00
CP-638	45	4.50	5.2	209.00	4.05	7.3	5.87	1.3	100.22	1.3	5.00
CP-639	45	4.50	5.2	208.92	4.50	7.4	5.96	1.3	100.20	1.3	5.00
CP-640	45	4.50	5.2	208.92	4.95	7.4	5.96	1.3	100.20	1.3	5.00

[0305] [Table 51]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	(resin solid content thereof is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]
CP-641	Ta-doped tin oxide- coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	208.87	Ta-doped tin oxide particles (average particle diameter: 20 nm)	5.40	7.5	6.03	1.3	100.17	1.3	5.00	None	
CP-642		45	4.50	5.2	201.16		4.50	7.4	14.30	1.3	99.23	1.3	5.00		
CP-643		45	4.50	5.2	183.27		3.60	7.3	33.45	1.3	97.13	1.3	5.00		
CP-644		45	4.50	5.2	183.27		4.05	7.3	33.45	1.3	97.13	1.3	5.00		
CP-645		45	4.50	5.2	182.97		4.50	7.4	33.85	1.3	96.97	1.3	5.00		
CP-646		45	4.50	5.2	182.97		4.95	7.4	33.85	1.3	96.97	1.3	5.00		
CP-647		45	4.50	5.2	182.67		5.40	7.5	34.25	1.3	96.80	1.3	5.00		
CP-648		45	4.50	5.2	169.56		4.50	7.4	48.27	1.3	95.28	1.3	5.00		
CP-649		45	4.50	5.2	161.58		3.60	7.3	56.71	1.3	94.52	1.3	5.00		
CP-650		45	4.50	5.2	161.58		4.05	7.3	56.71	1.3	94.52	1.3	5.00		
CP-651		45	4.50	5.2	161.13		4.50	7.4	57.32	1.3	94.25	1.3	5.00		
CP-652		45	4.50	5.2	161.13		4.95	7.4	57.32	1.3	94.25	1.3	5.00		
CP-653		45	4.50	5.2	160.68		5.40	7.5	57.94	1.3	93.97	1.3	5.00		

[0306] [Table 52]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part (s)]	Kind	Doping ratio [%]	Density	Amount [part (s)]	Density	Amount [part (s)]	Density	Kind	Amount [part (s)]
CP-654	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	136.45	Ta-doped tin oxide particles (average particle diameter: 20 nm)	3.60	7.3	9.58	1.3	156.62	1.3	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2
CP-655		45	4.50	5.2	136.45		4.05	7.3	9.58	1.3	156.62	1.3		4.2
CP-656		45	4.50	5.2	136.40		4.50	7.4	9.70	1.3	156.50	1.3		4.2
CP-657		45	4.50	5.2	136.40		4.95	7.4	9.70	1.3	156.50	1.3		4.2
CP-658		45	4.50	5.2	136.34		5.40	7.5	9.83	1.3	156.38	1.3		4.2
CP-659		45	4.50	5.2	125.10		3.60	7.3	22.83	1.3	153.45	1.3		4.2
CP-660		45	4.50	5.2	125.10		4.05	7.3	22.83	1.3	153.45	1.3		4.2
CP-661		45	4.50	5.2	124.95		4.50	7.4	23.12	1.3	153.22	1.3		4.2
CP-662		45	4.50	5.2	124.95		4.95	7.4	23.12	1.3	153.22	1.3		4.2
CP-663		45	4.50	5.2	124.82		5.40	7.5	23.40	1.3	152.97	1.3		4.2
CP-664		45	4.50	5.2	116.60		3.60	7.3	32.73	1.3	151.12	1.3		4.2
CP-665		45	4.50	5.2	116.60		4.05	7.3	32.73	1.3	151.12	1.3		4.2
CP-666		45	4.50	5.2	116.42		4.50	7.4	33.13	1.3	150.75	1.3		4.2
CP-667		45	4.50	5.2	116.42		4.95	7.4	33.13	1.3	150.75	1.3		4.2
CP-668		45	4.50	5.2	116.25		5.40	7.5	33.53	1.3	150.37	1.3		4.2
CP-669		45	4.50	5.2	171.92		3.60	7.3	12.06	1.3	93.37	1.3		4.2
CP-670		45	4.50	5.2	171.92		4.05	7.3	12.06	1.3	93.37	1.3		4.2
CP-671		45	4.50	5.2	171.82		4.50	7.4	12.23	1.3	93.25	1.3		4.2
CP-672		45	4.50	5.2	171.82		4.95	7.4	12.23	1.3	93.25	1.3		4.2
CP-673		45	4.50	5.2	171.72		5.40	7.5	12.38	1.3	93.17	1.3		4.2
CP-674		45	4.50	5.2	157.08		3.60	7.3	28.67	1.3	90.42	1.3		4.2
CP-675		45	4.50	5.2	157.08		4.05	7.3	28.67	1.3	90.42	1.3		4.2
CP-676		45	4.50	5.2	156.85		4.50	7.4	29.02	1.3	90.22	1.3		4.2
CP-677		45	4.50	5.2	156.85		4.95	7.4	29.02	1.3	90.22	1.3		4.2
CP-678		45	4.50	5.2	156.64		5.40	7.5	29.37	1.3	89.98	1.3		4.2

CP-679	45	4.50	5.2	146.04	3.60	7.3	41.00	1.3	88.27	1.3	40.00	4.2	30.00
CP-680	45	4.50	5.2	146.04	4.05	7.3	41.00	1.3	88.27	1.3	40.00	4.2	30.00
CP-681	45	4.50	5.2	145.76	4.50	7.4	41.48	1.3	87.93	1.3	40.00	4.2	30.00
CP-682	45	4.50	5.2	145.76	4.95	7.4	41.48	1.3	87.93	1.3	40.00	4.2	30.00
CP-683	45	4.50	5.2	145.48	5.40	7.5	41.96	1.3	87.60	1.3	40.00	4.2	30.00
CP-684	45	4.50	5.2	197.62	3.60	7.3	13.86	1.3	47.53	1.3	40.00	4.2	30.00
CP-685	45	4.50	5.2	197.62	4.05	7.3	13.86	1.3	47.53	1.3	40.00	4.2	30.00
CP-686	45	4.50	5.2	197.48	4.50	7.4	14.05	1.3	47.45	1.3	40.00	4.2	30.00
CP-687	45	4.50	5.2	197.48	4.95	7.4	14.05	1.3	47.45	1.3	40.00	4.2	30.00
CP-688	45	4.50	5.2	197.36	5.40	7.5	14.22	1.3	47.37	1.3	40.00	4.2	30.00
CP-689	45	4.50	5.2	180.09	3.60	7.3	32.87	1.3	45.07	1.3	40.00	4.2	30.00
CP-690	45	4.50	5.2	180.09	4.05	7.3	32.87	1.3	45.07	1.3	40.00	4.2	30.00

[0307] [Table 53]

Conductive -layer coating solution	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)			(4) Silicone resin particles		(5) Particles except (1) to (4)		
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part (s)]	Kind	Doping ratio [%]	Density	Amount [part (s)]	Density (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part (s)]	
CP-691	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	179.82	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.4	33.26	1.3	44.87	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00
CP-692		45	4.50	5.2	179.82		4.95	7.4	33.26	1.3	44.87	1.3	40.00		4.2	30.00
CP-693		45	4.50	5.2	179.55		5.40	7.5	33.66	1.3	44.65	1.3	40.00		4.2	30.00
CP-694		45	4.50	5.2	167.15		3.60	7.3	46.92	1.3	43.22	1.3	40.00		4.2	30.00
CP-695		45	4.50	5.2	167.15		4.05	7.3	46.92	1.3	43.22	1.3	40.00		4.2	30.00
CP-696		45	4.50	5.2	166.77		4.50	7.4	47.46	1.3	42.95	1.3	40.00		4.2	30.00
CP-697		45	4.50	5.2	166.77		4.95	7.4	47.46	1.3	42.95	1.3	40.00		4.2	30.00
CP-698		45	4.50	5.2	166.40		5.40	7.5	48.00	1.3	42.67	1.3	40.00		4.2	30.00
CP-699	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	156.85	4.50	7.4	29.02	1.3	90.22	1.3	40.00	Uncoated titanium oxide particles (average particle diameter: 210 nm)	4.2	30.00	
CP-700		45	4.50	5.2	160.36	4.50	7.4	25.10	1.3	90.90	1.3	40.00		4.2	30.00	

[0308] [Table 54]

	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]
Conductive -layer coating solution														
	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	115.85	None				1.3	265.25	1.3	5.00	
		45	4.50	5.2	176.85					1.3	163.58	1.3	5.00	
		45	4.50	5.2	214.46					1.3	100.90	1.3	5.00	
		45	4.50	5.2	114.50	4.50	7.4	1.63	1.3	264.78	1.3	5.00		
		45	4.50	5.2	174.63	4.50	7.4	2.48	1.3	163.15	1.3	5.00		
		45	4.50	5.2	211.67	4.50	7.4	3.00	1.3	100.55	1.3	5.00		
		45	4.50	5.2	85.65	4.50	7.4	36.57	1.3	254.63	1.3	5.00		
	45	4.50	5.2	128.12	4.50	7.4	54.70	1.3	153.63	1.3	5.00			
	45	4.50	5.2	153.49	4.50	7.4	65.53	1.3	93.30	1.3	5.00			
	None				4.50	7.4	140.30	1.3	224.50	1.3	5.00	None		
					4.50	7.4	198.60	1.3	127.33	1.3	5.00			
					4.50	7.4	230.50	1.3	74.17	1.3	5.00			
					4.50	7.4	2.40	1.3	313.92	1.3	5.00			
					4.50	7.4	5.80	1.3	312.73	1.3	5.00			
				4.50	7.4	13.89	1.3	310.02	1.3	5.00				
				4.50	7.4	20.00	1.3	307.87	1.3	5.00				
				4.50	7.4	23.90	1.3	306.57	1.3	5.00				
				4.50	7.4	6.20	1.3	84.38	1.3	5.00				
				4.50	7.4	14.95	1.3	83.52	1.3	5.00				
				4.50	7.4	35.30	1.3	81.50	1.3	5.00				
				4.50	7.4	50.30	1.3	80.02	1.3	5.00				
				4.50	7.4	59.72	1.3	79.08	1.3	5.00				

[0309] [Table 55]

	(1) A first metal oxide particle					(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)					
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind	Density	Amount [part(s)]			
Conductive -layer coating solution	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	151.95	P-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.7	25.95	1.3	161.83	1.3	5.00						
CP-C151	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.28		4.50	6.7	25.68	1.3	160.07	1.3	5.00				None		
CP-C152																			
CP-C153	P-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	151.30	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	27.00	1.3	161.17	1.3	5.00						
CP-C154		45	4.50	5.1	150.48	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.4	28.38	1.3	160.23	1.3	5.00						

CP-C155	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	150.28	W-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.5	28.73	1.3	159.98	1.3	5.00
CP-C156	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	151.63	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.5	28.43	1.3	158.23	1.3	5.00
CP-C157	W-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	152.65	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	26.72	1.3	159.38	1.3	5.00
CP-C158		45	4.50	5.2	151.83		4.50	7.4	28.08	1.3	158.48	1.3	5.00

[0310] [Table 56]

Conductive -layer coating solution	(1) A first metal oxide particle					(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)					
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)] (resin solid content thereof is 60% by mass of the following)	Density	Amount [part (s)]	Kind	Density	Amount [part (s)]					
CP-C159	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.15	F-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	162.08	1.3	5.00	None					
	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.50		4.50	6.6	25.32	1.3	160.30	1.3	5.00						
CP-C161	F-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.0	149.93	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	27.29	1.3	162.97	1.3	5.00						
CP-C162		45	4.50	5.0	149.10	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.4	28.68	1.3	162.03	1.3	5.00						

CP-C163	Oxygen-deficient tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	-	5.1	152.00	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	26.00	1.3	161.67	1.3	5.00
CP-C164	Oxygen-deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	152.00		4.50	7.0	26.00	1.3	161.67	1.3	5.00
CP-C165	Sb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.00		4.50	7.0	26.00	1.3	161.67	1.3	5.00

[0311] [Table 57]

	(1) A first metal oxide particle				(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density is 60% by mass of the following)	Density	Amount [part(s)]	Kind	Amount [part(s)]
Conductive -layer coating solution														
CP-C166	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.20	Oxygen-deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.60	1.3	1.3	5.00		
CP-C167		45	4.50	5.1	151.10	Indium tin oxide particles (average particle diameter: 20 nm)	4.50	7.1	27.35	1.3	1.3	5.00		
CP-C168		45	4.50	5.1	152.20	Sb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	1.3	5.00		
CP-C169	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	153.30	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	25.70	1.3	1.3	5.00		

None

CP-C170	Nb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	150.60	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.4	26.25	1.3	163.58	1.3	5.00
CP-C171	Nb-doped tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	4.50	5.1	151.90	Nb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	26.00	1.3	161.83	1.3	5.00

[0312] [Table 58]

	(1) A first metal oxide particle					(2) A second metal oxide particle				(3) Binding material (phenol resin)		(4) Silicone resin particles		(5) Particles except (1) to (4)	
	Kind	Coating ratio [%]	Doping ratio [%]	Density	Amount [part(s)]	Kind	Doping ratio [%]	Density	Amount [part(s)]	Density	Amount [part(s)]	Density	Amount [part(s)]	Kind Density	Amount [part(s)]
Conductive -layer coating solution															
CP-C172	Oxygen-deficient tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	-	5.1	152.00	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.4	26.00	1.3	161.67	1.3	5.00	None	
CP-C173	Oxygen-deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	152.00		4.50	7.4	26.00	1.3	161.67	1.3	5.00		
CP-C174	Sb-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.1	152.00		4.50	7.4	26.00	1.3	161.67	1.3	5.00		

CP-C175	Ta-doped tin oxide-coated titanium oxide particles (average particle diameter: 230 nm)	45	4.50	5.2	152.20	Oxygen- deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.60	1.3	162.00	1.3	5.00
CP-C176		45	4.50	5.2	151.10	Indium tin oxide particles (average particle diameter: 20 nm)	4.50	7.1	27.35	1.3	160.92	1.3	5.00
CP-C177		45	4.50	5.2	152.20	Sb-doped tin oxide particles (average particle diameter: 20 nm)	4.50	6.6	25.60	1.3	162.00	1.3	5.00
CP-C178	Ta-doped tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	4.50	5.2	151.90	Ta-doped tin oxide particles (average particle diameter: 20 nm)	4.50	7.0	26.00	1.3	161.83	1.3	5.00
CP-C179	Oxygen- deficient tin oxide-coated barium sulfate particles (average particle diameter: 230 nm)	45	-	5.1	152.20	Oxygen- deficient tin oxide particles (average particle diameter: 20 nm)	-	6.6	25.60	1.3	162.00	1.3	5.00

[0313] (Example 1 (production example of electrophotographic photosensitive member 1))

An aluminum cylinder (JIS-A3003, aluminum alloy) having a length of 251.5 mm, a diameter of 24 mm, and a thickness of 1.0 mm produced by a production method including an extrusion process and a drawing process was used as a support (cylindrical support).

[0314] The conductive-layer coating solution CP-1 was applied onto the support under a 22°C/55%RH environment by dip coating, and then the resultant coating film was dried and thermally cured for 30 minutes at 140°C to form a conductive layer having a thickness of 20 μm .

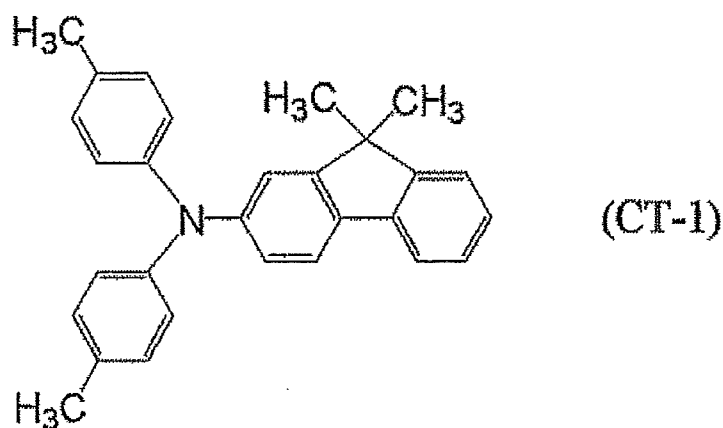
[0315] The volume resistivity of the conductive layer was measured to be $2.2 \times 10^{13} \Omega \cdot \text{cm}$.

[0316] Next, 4.5 parts of N-methoxymethylated nylon (trade name: Toresin EF-30T, manufactured by Teikoku Chemical Industry Co., Ltd.) and 1.5 parts of a copolymerized nylon resin (trade name: Amilan CM8000, manufactured by Toray Industries, Inc.) were dissolved in a mixed solvent of 65 parts of methanol and 30 parts of n-butanol to prepare an undercoat-layer coating solution. The undercoat-layer coating solution was applied onto the conductive layer by dip coating, and then the resultant coating film was dried for 6 minutes at 70°C to form an undercoat layer having a thickness of 0.85 μm .

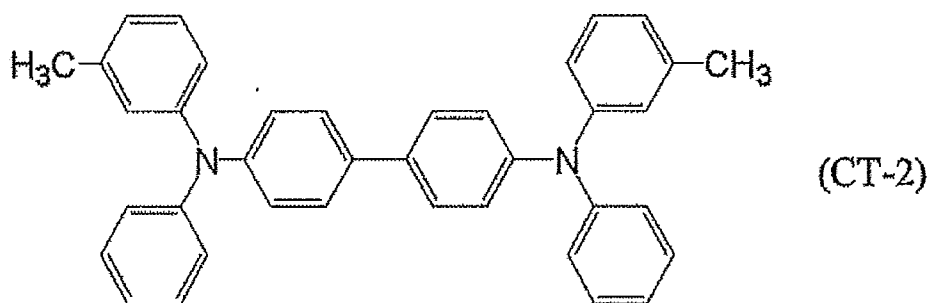
[0317] Next, 10 parts of a hydroxygallium phthalocyanine crystal (charge-generating substance) in a crystal form having strong peaks at Bragg angles ($2\theta \pm 0.2^\circ$) in $\text{CuK}\alpha$ -characteristic X-ray diffraction of 7.5° , 9.9° , 16.3° , 18.6° , 25.1° , and 28.3° , 5 parts of a polyvinyl butyral (trade name: S-LEC BX-1, manufactured by SEKISUI CHEMICAL, CO., LTD.), and 250 parts of cyclohexanone were loaded into a sand mill using glass beads each having a diameter of 1 mm, and were then subjected to a dispersion treatment under the condition of a

dispersion treatment time of 3 hours. After the dispersion treatment, 250 parts of ethyl acetate were added to the treated product to prepare a charge-generating-layer coating solution. The charge-generating-layer coating solution was applied onto the undercoat layer by dip coating, and then the resultant coating film was dried for 10 minutes at 100°C to form a charge-generating layer having a thickness of 0.12 μm.

[0318] Next, 56 parts of an amine compound (charge-transporting substance) represented by the following formula (CT-1):

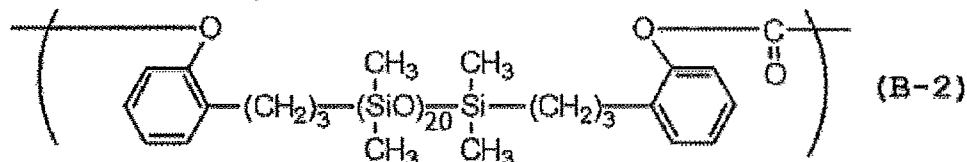
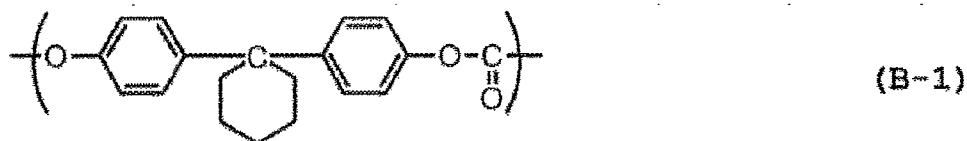


24 parts of an amine compound (charge-transporting substance) represented by the following formula (CT-2):

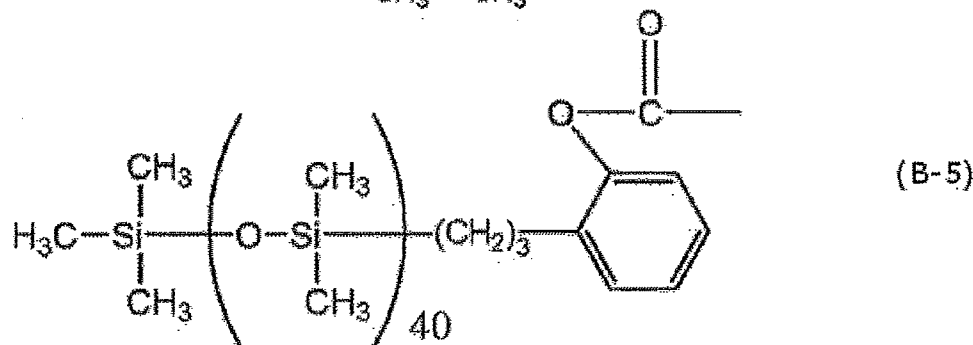
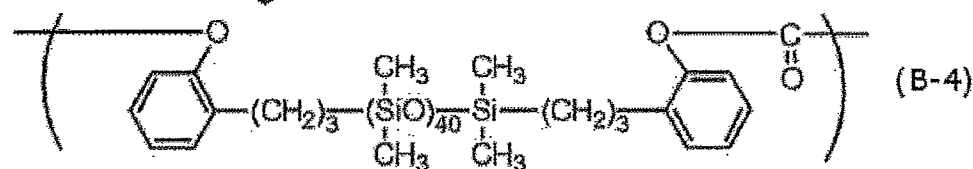
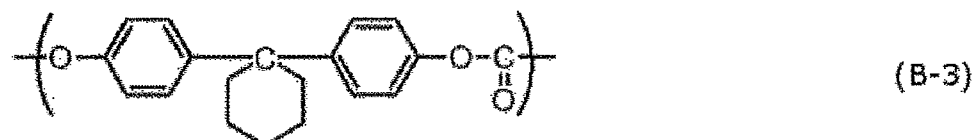


90 parts of a polycarbonate (trade name: Z200, manufactured by Mitsubishi Engineering-Plastics Corporation), 10 parts of a siloxane-modified polycarbonate having a repeating structural unit

represented by the following formula (B-1) and a repeating structural unit represented by the following formula (B-2) ((B-1):(B-2)=98:2 (molar ratio)):



and 0.9 part of a siloxane-modified polycarbonate having a repeating structural unit represented by the following formula (B-3) and a repeating structural unit represented by the following formula (B-4), and having a terminal structure represented by the following formula (B-5) ((B-3):(B-4)=95:5 (molar ratio)):



were dissolved in a mixed solvent of 300 parts of o-xylene, 250 parts of dimethoxymethane, and 27 parts of methyl benzoate to prepare a charge-transporting-layer coating solution. The charge-transporting-layer

coating solution was applied onto the charge-generating layer by dip coating, and then the resultant coating film was dried for 30 minutes at 120°C to form a charge-transporting layer having a thickness of 18.5 μm . Thus, an electrophotographic photosensitive member 1 including the charge-transporting layer as a surface layer was produced.

[0319] With regard to the electrophotographic photosensitive member 1, the abundance ratio of phosphorus to tin oxide in the P-doped tin oxide-coated titanium oxide particles and the abundance ratio of phosphorus to tin oxide in the P-doped tin oxide particles were each determined from an atomic ratio by employing the foregoing method.

[0320] Next, the volume of the P-doped tin oxide-coated titanium oxide particles and the volume of the P-doped tin oxide particles were measured by identifying the P-doped tin oxide-coated titanium oxide particles and the P-doped tin oxide particles based on their difference in contrast of the slice and view of the FIB-SEM by employing the foregoing method. The same holds true for the following examples.

[0321] (Examples 2 to 700 and Comparative Examples 1 to 179 (production examples of electrophotographic photosensitive members 2 to 700 and C1 to C179))
Electrophotographic photosensitive members 2 to 700 and C1 to C179 were produced by the same operations as those of Example 1 (production example of the electrophotographic photosensitive member 1) except that the conductive-layer coating solution was changed as shown in Tables 22 to 43 and Tables 59 to 73.

[0322] (Evaluation)

An evaluation for a crack was performed by observing the surface of a conductive layer at the stage of the formation of the conductive layer on a support with an optical microscope and by observing an image output

from an electrophotographic apparatus (laser beam printer) mounted with a produced electrophotographic photosensitive member.

[0323] The image observation was performed as described below.

[0324] The produced electrophotographic photosensitive member was mounted on a laser beam printer manufactured by Hewlett-Packard Company (trade name: LaserJet P2055dn) as an evaluation apparatus. The resultant was placed under a normal-temperature and normal-humidity (23°C/50%RH) environment, and then a solid black image, a solid white image, and a half-tone image of a one-dot keima pattern were output, followed by the observation of the output images. The half-tone image of a one-dot keima pattern is a half-tone image of a pattern illustrated in FIG. 5.

[0325] The degrees of the occurrence of the crack were classified into ranks based on the observation of the images and the following microscopic observation of the conductive layer as described below.

[0326] The case where the observation of the surface of the conductive layer with the optical microscope could not confirm the occurrence of any crack was defined as a rank 3. In addition, the case where the observation of the surface of the conductive layer with the optical microscope was able to confirm the occurrence of a crack but an image defect due to the crack was not observed on any one of the solid black image, the solid white image, and the half-tone image of a one-dot keima pattern was defined as a rank 2. In addition, the case where the observation of the surface of the conductive layer with the optical microscope was able to confirm the occurrence of a crack, and an image defect probably due to the crack was observed on any one of the solid black image, the solid white image, and the half-tone image of a one-dot keima pattern was defined as a rank 1. The half-tone image of a one-dot keima pattern is a

half-tone image of a pattern illustrated in FIG. 5.

- [0327] An evaluation for a residual potential and an evaluation for a pattern memory were also performed with a laser beam printer manufactured by Hewlett-Packard Company (trade name: LaserJet P2055dn) as an evaluation apparatus.
- [0328] The evaluation for a pattern memory was performed as described below.
- [0329] A produced electrophotographic photosensitive member was mounted on the laser beam printer manufactured by Hewlett-Packard Company. The resultant was placed under a low-temperature and low-humidity (15°C/7%RH) environment, and then a durability test involving continuously outputting 15,000 images of a 3-dot and 100-space vertical line pattern in a repeated manner was performed. The degrees of the occurrence of a pattern memory were classified into six ranks as shown in Table 74 according to the manner in which vertical streaks resulting from the hysteresis of the vertical lines were observed on each of four kinds of half-tone images and a solid black image shown in Table 74 output after the test. The number of the rank becomes larger as the extent to which the pattern memory is suppressed improves. It should be noted that the four kinds of half-tone images are a half-tone image of a one-dot keima pattern, a half-tone image with one-dot and one-space lateral lines, a half-tone image with two-dot and three-space lateral lines, and a half-tone image with one-dot and two-space lateral lines.
- [0330] The evaluation for a residual potential was performed as described below.
- [0331] Before and after the durability test, residual potentials after continuous output of three solid white images and five solid black images were measured. An increase in residual potential of 10 V or less was defined as a rank 4. In addition, an increase of more

than 10 V and 20 V or less was defined as a rank 3. In addition, an increase of more than 20 V and 30 V or less was defined as a rank 2. In addition, an increase of more than 30 V was defined as a rank 1.

[0332] Tables 22 to 43 and Tables 59 to 73 show the results.

[0333] [Table 22]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T) / (V_1/V_T) \} \times 100$	$\{(V_1/V_T) + (V_2/V_T) \} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 1	CP-1	1	2	15	0.8	2.2×10^{13}	4	3	3
Example 2	CP-2	2	2	15	0.9	2.2×10^{13}	5	3	3
Example 3	CP-3	3	2	15	1.0	2.2×10^{13}	5	3	3
Example 4	CP-4	4	2	15	1.1	2.2×10^{13}	5	3	3
Example 5	CP-5	5	2	15	1.2	2.2×10^{13}	4	3	3
Example 6	CP-6	6	5	15	1.0	2.1×10^{13}	6	3	3
Example 7	CP-7	7	13	15	0.8	2.0×10^{13}	5	3	3
Example 8	CP-8	8	13	15	0.9	2.0×10^{13}	6	3	3
Example 9	CP-9	9	13	15	1.0	2.0×10^{13}	6	3	3
Example 10	CP-10	10	13	15	1.1	2.0×10^{13}	6	3	3
Example 11	CP-11	11	13	15	1.2	2.0×10^{13}	5	3	3
Example 12	CP-12	12	20	15	1.0	1.9×10^{13}	6	3	3
Example 13	CP-13	13	25	15	0.8	1.8×10^{13}	3	3	3
Example 14	CP-14	14	25	15	0.9	1.8×10^{13}	4	3	3
Example 15	CP-15	15	25	15	1.0	1.8×10^{13}	4	3	3
Example 16	CP-16	16	25	15	1.1	1.8×10^{13}	4	3	3
Example 17	CP-17	17	25	15	1.2	1.8×10^{13}	3	3	3
Example 18	CP-18	18	2	20	1.0	6.6×10^{12}	5	4	3
Example 19	CP-19	19	5	20	0.8	6.3×10^{12}	5	4	3
Example 20	CP-20	20	5	20	0.9	6.3×10^{12}	6	4	3
Example 21	CP-21	21	5	20	1.0	6.3×10^{12}	6	4	3
Example 22	CP-22	22	5	20	1.1	6.3×10^{12}	6	4	3
Example 23	CP-23	23	5	20	1.2	6.3×10^{12}	5	4	3
Example 24	CP-24	24	13	20	0.8	5.8×10^{12}	5	4	3
Example 25	CP-25	25	13	20	0.9	5.8×10^{12}	6	4	3
Example 26	CP-26	26	13	20	1.0	5.8×10^{12}	6	4	3
Example 27	CP-27	27	13	20	1.1	5.8×10^{12}	6	4	3
Example 28	CP-28	28	13	20	1.2	5.8×10^{12}	5	4	3
Example 29	CP-29	29	20	20	0.8	5.4×10^{12}	5	4	3

Example 30	CP-30	30	20	20	0.9	5.5×10^{12}	6	4	3
Example 31	CP-31	31	20	20	1.0	5.5×10^{12}	6	4	3
Example 32	CP-32	32	20	20	1.1	5.5×10^{12}	6	4	3
Example 33	CP-33	33	20	20	1.2	5.5×10^{12}	5	4	3
Example 34	CP-34	34	25	20	1.0	5.2×10^{12}	4	4	3
Example 35	CP-35	35	2	30	0.8	3.6×10^{11}	4	4	3
Example 36	CP-36	36	2	30	0.9	3.6×10^{11}	5	4	3
Example 37	CP-37	37	2	30	1.0	3.6×10^{11}	5	4	3
Example 38	CP-38	38	2	30	1.1	3.6×10^{11}	5	4	3
Example 39	CP-39	39	2	30	1.2	3.6×10^{11}	4	4	3
Example 40	CP-40	40	5	30	0.8	3.4×10^{11}	5	4	3

[0334] [Table 23]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 41	CP-41	41	5	30	0.9	3.4×10^{11}	6	4	3
Example 42	CP-42	42	5	30	1.0	3.4×10^{11}	6	4	3
Example 43	CP-43	43	5	30	1.1	3.4×10^{11}	6	4	3
Example 44	CP-44	44	5	30	1.2	3.4×10^{11}	5	4	3
Example 45	CP-45	45	13	30	0.8	2.9×10^{11}	5	4	3
Example 46	CP-46	46	13	30	0.9	3.0×10^{11}	6	4	3
Example 47	CP-47	47	13	30	1.0	3.0×10^{11}	6	4	3
Example 48	CP-48	48	13	30	1.1	3.0×10^{11}	6	4	3
Example 49	CP-49	49	13	30	1.2	3.0×10^{11}	5	4	3
Example 50	CP-50	50	20	30	0.8	2.6×10^{11}	5	4	3
Example 51	CP-51	51	20	30	0.9	2.6×10^{11}	6	4	3
Example 52	CP-52	52	20	30	1.0	2.6×10^{11}	6	4	3
Example 53	CP-53	53	20	30	1.1	2.6×10^{11}	6	4	3
Example 54	CP-54	54	20	30	1.2	2.6×10^{11}	5	4	3
Example 55	CP-55	55	25	30	0.8	2.4×10^{11}	3	4	3
Example 56	CP-56	56	25	30	0.9	2.5×10^{11}	4	4	3
Example 57	CP-57	57	25	30	1.0	2.5×10^{11}	4	4	3
Example 58	CP-58	58	25	30	1.1	2.5×10^{11}	4	4	3
Example 59	CP-59	59	25	30	1.2	2.5×10^{11}	3	4	3
Example 60	CP-60	60	2	40	1.0	7.7×10^9	5	4	3
Example 61	CP-61	61	5	40	0.8	6.9×10^9	5	4	3
Example 62	CP-62	62	5	40	0.9	7.0×10^9	6	4	3
Example 63	CP-63	63	5	40	1.0	7.0×10^9	6	4	3
Example 64	CP-64	64	5	40	1.1	7.0×10^9	6	4	3
Example 65	CP-65	65	5	40	1.2	7.0×10^9	5	4	3
Example 66	CP-66	66	13	40	0.8	5.4×10^9	5	4	3
Example 67	CP-67	67	13	40	0.9	5.5×10^9	6	4	3
Example 68	CP-68	68	13	40	1.0	5.5×10^9	6	4	3
Example 69	CP-69	69	13	40	1.1	5.5×10^9	6	4	3

Example 70	CP-70	70		13	40	1.2	5.5×10^9	5	4	3
Example 71	CP-71	71		20	40	0.8	4.5×10^9	5	4	3
Example 72	CP-72	72		20	40	0.9	4.6×10^9	6	4	3
Example 73	CP-73	73		20	40	1.0	4.6×10^9	6	4	3
Example 74	CP-74	74		20	40	1.1	4.6×10^9	6	4	3
Example 75	CP-75	75		20	40	1.2	4.6×10^9	5	4	3
Example 76	CP-76	76		25	40	1.0	4.1×10^9	4	4	3
Example 77	CP-77	77		2	45	0.8	6.4×10^8	4	4	2
Example 78	CP-78	78		2	45	0.9	6.6×10^8	5	4	2
Example 79	CP-79	79		2	45	1.0	6.6×10^8	5	4	2
Example 80	CP-80	80		2	45	1.1	6.6×10^8	5	4	2

[0335] [Table 24]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 81	CP-81	81	2	45	1.2	6.6×10^8	4	4	2
Example 82	CP-82	82	5	45	1.0	5.8×10^8	6	4	2
Example 83	CP-83	83	13	45	0.8	4.2×10^8	5	4	2
Example 84	CP-84	84	13	45	0.9	4.4×10^8	6	4	2
Example 85	CP-85	85	13	45	1.0	4.4×10^8	6	4	2
Example 86	CP-86	86	13	45	1.1	4.4×10^8	6	4	2
Example 87	CP-87	87	13	45	1.2	4.4×10^8	5	4	2
Example 88	CP-88	88	20	45	1.0	3.5×10^8	6	4	2
Example 89	CP-89	89	25	45	0.8	3.0×10^8	3	4	2
Example 90	CP-90	90	25	45	0.9	3.1×10^8	4	4	2
Example 91	CP-91	91	25	45	1.0	3.1×10^8	4	4	2
Example 92	CP-92	92	25	45	1.1	3.1×10^8	4	4	2
Example 93	CP-93	93	25	45	1.2	3.1×10^8	3	4	2
Example 94	CP-94	94	5	20	0.8	4.8×10^{12}	5	4	3
Example 95	CP-95	95	5	20	0.9	4.8×10^{12}	6	4	3
Example 96	CP-96	96	5	20	1.0	4.8×10^{12}	6	4	3
Example 97	CP-97	97	5	20	1.1	4.8×10^{12}	6	4	3
Example 98	CP-98	98	5	20	1.2	4.8×10^{12}	5	4	3
Example 99	CP-99	99	13	20	0.8	4.3×10^{12}	5	4	3
Example 100	CP-100	100	13	20	0.9	4.4×10^{12}	6	4	3
Example 101	CP-101	101	13	20	1.0	4.4×10^{12}	6	4	3
Example 102	CP-102	102	13	20	1.1	4.4×10^{12}	6	4	3
Example 103	CP-103	103	13	20	1.2	4.4×10^{12}	5	4	3
Example 104	CP-104	104	20	20	0.8	4.0×10^{12}	5	4	3
Example 105	CP-105	105	20	20	0.9	4.1×10^{12}	6	4	3
Example 106	CP-106	106	20	20	1.0	4.1×10^{12}	6	4	3
Example 107	CP-107	107	20	20	1.1	4.1×10^{12}	6	4	3
Example 108	CP-108	108	20	20	1.2	4.1×10^{12}	5	4	3
Example 109	CP-109	109	5	30	0.8	1.7×10^{11}	5	4	3
Example 110	CP-110	110	5	30	0.9	1.8×10^{11}	6	4	3
Example 111	CP-111	111	5	30	1.0	1.8×10^{11}	6	4	3
Example 112	CP-112	112	5	30	1.1	1.8×10^{11}	6	4	3
Example 113	CP-113	113	5	30	1.2	1.8×10^{11}	5	4	3

Example 114	CP-114	114	13	30	0.8	1.4×10^{11}	5	4	3
Example 115	CP-115	115	13	30	0.9	1.5×10^{11}	6	4	3
Example 116	CP-116	116	13	30	1.0	1.5×10^{11}	6	4	3
Example 117	CP-117	117	13	30	1.1	1.5×10^{11}	6	4	3
Example 118	CP-118	118	13	30	1.2	1.5×10^{11}	5	4	3
Example 119	CP-119	119	20	30	0.8	1.3×10^{11}	5	4	3
Example 120	CP-120	120	20	30	0.9	1.3×10^{11}	6	4	3

[0336] [Table 25]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Pattern memory	Residual potential	Crack
Example 121	CP-121	121	20	30	1.0	1.3×10^{11}	6	4	3
Example 122	CP-122	122	20	30	1.1	1.3×10^{11}	6	4	3
Example 123	CP-123	123	20	30	1.2	1.3×10^{11}	5	4	3
Example 124	CP-124	124	5	40	0.8	1.6×10^9	5	4	3
Example 125	CP-125	125	5	40	0.9	1.6×10^9	6	4	3
Example 126	CP-126	126	5	40	1.0	1.6×10^9	6	4	3
Example 127	CP-127	127	5	40	1.1	1.6×10^9	6	4	3
Example 128	CP-128	128	5	40	1.2	1.6×10^9	5	4	3
Example 129	CP-129	129	13	40	0.8	1.2×10^9	5	4	3
Example 130	CP-130	130	13	40	0.9	1.2×10^9	6	4	3
Example 131	CP-131	131	13	40	1.0	1.2×10^9	6	4	3
Example 132	CP-132	132	13	40	1.1	1.2×10^9	6	4	3
Example 133	CP-133	133	13	40	1.2	1.2×10^9	5	4	3
Example 134	CP-134	134	20	40	0.8	9.5×10^8	5	4	3
Example 135	CP-135	135	20	40	0.9	9.9×10^8	6	4	3
Example 136	CP-136	136	20	40	1.0	9.9×10^8	6	4	3
Example 137	CP-137	137	20	40	1.1	9.9×10^8	6	4	3
Example 138	CP-138	138	20	40	1.2	9.9×10^8	5	4	3
Example 139	CP-139	139	13	30	1.0	2.5×10^{11}	6	4	3
Example 140	CP-140	140	13	30	1.0	5.5×10^{11}	6	4	3

[0337] [Table 26]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)+(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation
						Pattern memory potential	Residual Crack
Comparative Example 1	CP-C1	C1	-	-	-	2.2×10^{13}	1 3
Comparative Example 2	CP-C2	C2	-	-	-	3.8×10^{11}	1 4
Comparative Example 3	CP-C3	C3	-	-	-	7.1×10^8	1 4
Comparative Example 4	CP-C4	C4	1	15	1.0	2.2×10^{13}	2 3
Comparative Example 5	CP-C5	C5	1	30	1.0	3.7×10^{11}	2 4
Comparative Example 6	CP-C6	C6	1	45	1.0	6.8×10^8	2 4
Comparative Example 7	CP-C7	C7	30	15	1.0	1.8×10^{13}	2 3
Comparative Example 8	CP-C8	C8	30	30	1.0	2.3×10^{11}	2 4
Comparative Example 9	CP-C9	C9	30	45	1.0	2.7×10^8	2 4
Comparative Example 10	CP-C10	C10	-	-	-	9.0×10^{12}	1 3
Comparative Example 11	CP-C11	C11	-	-	-	4.3×10^{10}	1 4
Comparative Example 12	CP-C12	C12	-	-	-	1.1×10^7	1 4
Comparative Example 13	CP-C13	C13	2	10	1.0	6.3×10^{13}	5 1
Comparative Example 14	CP-C14	C14	5	10	1.0	6.2×10^{13}	6 1
Comparative Example 15	CP-C15	C15	13	10	1.0	5.9×10^{13}	6 1
Comparative Example 16	CP-C16	C16	20	10	1.0	5.8×10^{13}	6 1
Comparative Example 17	CP-C17	C17	25	10	1.0	5.7×10^{13}	4 1
Comparative Example 18	CP-C18	C18	2	50	1.0	3.4×10^7	5 4
Comparative Example 19	CP-C19	C19	5	50	1.0	3.0×10^7	6 4
Comparative Example 20	CP-C20	C20	13	50	1.0	2.1×10^7	6 4
Comparative Example 21	CP-C21	C21	20	50	1.0	1.6×10^7	6 4
Comparative Example 22	CP-C22	C22	25	50	1.0	1.4×10^7	4 4

[0338] [Table 27]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 23	CP-C23	C23	-	-	-	2.9×10^{11}	1	4	3
Comparative Example 24	CP-C24	C24	-	-	-	2.9×10^{11}	1	4	3
Comparative Example 25	CP-C25	C25	-	-	-	2.9×10^{11}	1	4	3
Comparative Example 26	CP-C26	C26	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 27	CP-C27	C27	-	-	-	2.8×10^{11}	1	4	3
Comparative Example 28	CP-C28	C28	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 29	CP-C29	C29	-	-	-	2.6×10^{11}	1	4	3

[0339] [Table 28]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 30	CP-C30	C30	-	-	-	3.3×10^{11}	1	4	3
Comparative Example 31	CP-C31	C31	-	-	-	2.6×10^{11}	1	4	3
Comparative Example 32	CP-C32	C32	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 33	CP-C33	C33	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 34	CP-C34	C34	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 35	CP-C35	C35	-	-	-	3.0×10^{11}	1	4	3

[0340] [Table 29]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 141	CP-141	141	2	15	0.8	2.0×10^{13}	4	3	3
Example 142	CP-142	142	2	15	0.9	2.0×10^{13}	5	3	3
Example 143	CP-143	143	2	15	1.0	2.0×10^{13}	5	3	3
Example 144	CP-144	144	2	15	1.1	2.0×10^{13}	5	3	3
Example 145	CP-145	145	2	15	1.2	2.0×10^{13}	4	3	3
Example 146	CP-146	146	5	15	1.0	2.0×10^{13}	6	3	3
Example 147	CP-147	147	13	15	0.8	1.8×10^{13}	5	3	3
Example 148	CP-148	148	13	15	0.9	1.8×10^{13}	6	3	3
Example 149	CP-149	149	13	15	1.0	1.8×10^{13}	6	3	3
Example 150	CP-150	150	13	15	1.1	1.8×10^{13}	6	3	3
Example 151	CP-151	151	13	15	1.2	1.8×10^{13}	5	3	3
Example 152	CP-152	152	20	15	1.0	1.7×10^{13}	6	3	3
Example 153	CP-153	153	25	15	0.8	1.6×10^{13}	3	3	3
Example 154	CP-154	154	25	15	0.9	1.6×10^{13}	4	3	3
Example 155	CP-155	155	25	15	1.0	1.6×10^{13}	4	3	3
Example 156	CP-156	156	25	15	1.1	1.6×10^{13}	4	3	3
Example 157	CP-157	157	25	15	1.2	1.6×10^{13}	3	3	3
Example 158	CP-158	158	2	20	1.0	6.0×10^{12}	5	4	3
Example 159	CP-159	159	5	20	0.8	5.8×10^{12}	5	4	3
Example 160	CP-160	160	5	20	0.9	5.7×10^{12}	6	4	3
Example 161	CP-161	161	5	20	1.0	5.7×10^{12}	6	4	3
Example 162	CP-162	162	5	20	1.1	5.7×10^{12}	6	4	3
Example 163	CP-163	163	5	20	1.2	5.7×10^{12}	5	4	3
Example 164	CP-164	164	13	20	0.8	5.1×10^{12}	5	4	3
Example 165	CP-165	165	13	20	0.9	5.1×10^{12}	6	4	3
Example 166	CP-166	166	13	20	1.0	5.1×10^{12}	6	4	3
Example 167	CP-167	167	13	20	1.1	5.0×10^{12}	6	4	3
Example 168	CP-168	168	13	20	1.2	5.0×10^{12}	5	4	3
Example 169	CP-169	169	20	20	0.8	4.7×10^{12}	5	4	3

Example 170	CP-170	170	20	20	0.9	4.6×10^{12}	6	4	3
Example 171	CP-171	171	20	20	1.0	4.6×10^{12}	6	4	3
Example 172	CP-172	172	20	20	1.1	4.5×10^{12}	6	4	3
Example 173	CP-173	173	20	20	1.2	4.5×10^{12}	5	4	3
Example 174	CP-174	174	25	20	1.0	4.3×10^{12}	4	4	3
Example 175	CP-175	175	2	30	0.8	3.1×10^{11}	4	4	3
Example 176	CP-176	176	2	30	0.9	3.1×10^{11}	5	4	3
Example 177	CP-177	177	2	30	1.0	3.1×10^{11}	5	4	3
Example 178	CP-178	178	2	30	1.1	3.1×10^{11}	5	4	3
Example 179	CP-179	179	2	30	1.2	3.1×10^{11}	4	4	3
Example 180	CP-180	180	5	30	0.8	2.9×10^{11}	5	4	3

[0341] [Table 30]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Example 181	CP-181	181	5	30	0.9	2.9×10^{11}	6	4
Example 182	CP-182	182	5	30	1.0	2.9×10^{11}	6	4
Example 183	CP-183	183	5	30	1.1	2.9×10^{11}	6	4
Example 184	CP-184	184	5	30	1.2	2.9×10^{11}	5	4
Example 185	CP-185	185	13	30	0.8	2.4×10^{11}	5	4
Example 186	CP-186	186	13	30	0.9	2.3×10^{11}	6	4
Example 187	CP-187	187	13	30	1.0	2.3×10^{11}	6	4
Example 188	CP-188	188	13	30	1.1	2.3×10^{11}	6	4
Example 189	CP-189	189	13	30	1.2	2.3×10^{11}	5	4
Example 190	CP-190	190	20	30	0.8	2.0×10^{11}	5	4
Example 191	CP-191	191	20	30	0.9	2.0×10^{11}	6	4
Example 192	CP-192	192	20	30	1.0	2.0×10^{11}	6	4
Example 193	CP-193	193	20	30	1.1	1.9×10^{11}	6	4
Example 194	CP-194	194	20	30	1.2	1.9×10^{11}	5	4
Example 195	CP-195	195	25	30	0.8	1.8×10^{11}	3	4
Example 196	CP-196	196	25	30	0.9	1.8×10^{11}	4	4
Example 197	CP-197	197	25	30	1.0	1.8×10^{11}	4	4
Example 198	CP-198	198	25	30	1.1	1.7×10^{11}	4	4
Example 199	CP-199	199	25	30	1.2	1.7×10^{11}	3	4
Example 200	CP-200	200	2	40	1.0	6.0×10^9	5	4
Example 201	CP-201	201	5	40	0.8	5.3×10^9	5	4
Example 202	CP-202	202	5	40	0.9	5.3×10^9	6	4
Example 203	CP-203	203	5	40	1.0	5.3×10^9	6	4
Example 204	CP-204	204	5	40	1.1	5.2×10^9	6	4
Example 205	CP-205	205	5	40	1.2	5.2×10^9	5	4
Example 206	CP-206	206	13	40	0.8	3.9×10^9	5	4
Example 207	CP-207	207	13	40	0.9	3.8×10^9	6	4
Example 208	CP-208	208	13	40	1.0	3.8×10^9	6	4
Example 209	CP-209	209	13	40	1.1	3.7×10^9	6	4

Example 210	CP-210	210	13	40	1.2	3.7×10^9	5	4	3
Example 211	CP-211	211	20	40	0.8	3.1×10^9	5	4	3
Example 212	CP-212	212	20	40	0.9	3.0×10^9	6	4	3
Example 213	CP-213	213	20	40	1.0	3.0×10^9	6	4	3
Example 214	CP-214	214	20	40	1.1	2.9×10^9	6	4	3
Example 215	CP-215	215	20	40	1.2	2.9×10^9	5	4	3
Example 216	CP-216	216	25	40	1.0	2.5×10^9	4	4	3
Example 217	CP-217	217	2	45	0.8	4.9×10^8	4	4	2
Example 218	CP-218	218	2	45	0.9	4.9×10^8	5	4	2
Example 219	CP-219	219	2	45	1.0	4.9×10^8	5	4	2
Example 220	CP-220	220	2	45	1.1	4.9×10^8	5	4	2

[0342] [Table 31]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 221	CP-221	221	2	45	1.2	4.9×10^8	4	4	2
Example 222	CP-222	222	5	45	1.0	4.2×10^8	6	4	2
Example 223	CP-223	223	13	45	0.8	2.9×10^8	5	4	2
Example 224	CP-224	224	13	45	0.9	2.8×10^8	6	4	2
Example 225	CP-225	225	13	45	1.0	2.8×10^8	6	4	2
Example 226	CP-226	226	13	45	1.1	2.7×10^8	6	4	2
Example 227	CP-227	227	13	45	1.2	2.7×10^8	5	4	2
Example 228	CP-228	228	20	45	1.0	2.0×10^8	6	4	2
Example 229	CP-229	229	25	45	0.8	1.8×10^8	3	4	2
Example 230	CP-230	230	25	45	0.9	1.7×10^8	4	4	2
Example 231	CP-231	231	25	45	1.0	1.7×10^8	4	4	2
Example 232	CP-232	232	25	45	1.1	1.6×10^8	4	4	2
Example 233	CP-233	233	25	45	1.2	1.6×10^8	3	4	2

[0343] [Table 32]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [Ω·cm]	Result of evaluation	
							Pattern memory	Residual potential
Example 234	CP-234	234	5	20	0.8	4.3×10^{12}	5	4
Example 235	CP-235	235	5	20	0.9	4.3×10^{12}	6	4
Example 236	CP-236	236	5	20	1.0	4.3×10^{12}	6	4
Example 237	CP-237	237	5	20	1.1	4.3×10^{12}	6	4
Example 238	CP-238	238	5	20	1.2	4.3×10^{12}	5	4
Example 239	CP-239	239	13	20	0.8	3.8×10^{12}	5	4
Example 240	CP-240	240	13	20	0.9	3.7×10^{12}	6	4
Example 241	CP-241	241	13	20	1.0	3.7×10^{12}	6	4
Example 242	CP-242	242	13	20	1.1	3.7×10^{12}	6	4
Example 243	CP-243	243	13	20	1.2	3.7×10^{12}	5	4
Example 244	CP-244	244	20	20	0.8	3.4×10^{12}	5	4
Example 245	CP-245	245	20	20	0.9	3.4×10^{12}	6	4
Example 246	CP-246	246	20	20	1.0	3.4×10^{12}	6	4
Example 247	CP-247	247	20	20	1.1	3.3×10^{12}	6	4
Example 248	CP-248	248	20	20	1.2	3.3×10^{12}	5	4
Example 249	CP-249	249	5	30	0.8	1.4×10^{11}	5	4
Example 250	CP-250	250	5	30	0.9	1.4×10^{11}	6	4
Example 251	CP-251	251	5	30	1.0	1.4×10^{11}	6	4
Example 252	CP-252	252	5	30	1.1	1.4×10^{11}	6	4
Example 253	CP-253	253	5	30	1.2	1.4×10^{11}	5	4
Example 254	CP-254	254	13	30	0.8	1.1×10^{11}	5	4
Example 255	CP-255	255	13	30	0.9	1.1×10^{11}	6	4
Example 256	CP-256	256	13	30	1.0	1.1×10^{11}	6	4
Example 257	CP-257	257	13	30	1.1	1.1×10^{11}	6	4
Example 258	CP-258	258	13	30	1.2	1.1×10^{11}	5	4
Example 259	CP-259	259	20	30	0.8	9.5×10^{10}	5	4
Example 260	CP-260	260	20	30	0.9	9.2×10^{10}	6	4
Example 261	CP-261	261	20	30	1.0	9.2×10^{10}	6	4
Example 262	CP-262	262	20	30	1.1	9.0×10^{10}	6	4

Example 263	CP-263	263	20	30	1.2	9.0×10^{10}	5	4	3
Example 264	CP-264	264	5	40	0.8	1.2×10^9	5	4	3
Example 265	CP-265	265	5	40	0.9	1.2×10^9	6	4	3
Example 266	CP-266	266	5	40	1.0	1.2×10^9	6	4	3
Example 267	CP-267	267	5	40	1.1	1.1×10^9	6	4	3
Example 268	CP-268	268	5	40	1.2	1.1×10^9	5	4	3
Example 269	CP-269	269	13	40	0.8	7.9×10^8	5	4	3
Example 270	CP-270	270	13	40	0.9	7.6×10^8	6	4	3

[0344] [Table 33]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 271	CP-271	271	13	40	1.0	7.6×10^8	6	4	3
Example 272	CP-272	272	13	40	1.1	7.3×10^8	6	4	3
Example 273	CP-273	273	13	40	1.2	7.3×10^8	5	4	3
Example 274	CP-274	274	20	40	0.8	5.9×10^8	5	4	3
Example 275	CP-275	275	20	40	0.9	5.6×10^8	6	4	3
Example 276	CP-276	276	20	40	1.0	5.6×10^8	6	4	3
Example 277	CP-277	277	20	40	1.1	5.3×10^8	6	4	3
Example 278	CP-278	278	20	40	1.2	5.3×10^8	5	4	3
Example 279	CP-279	279	13	30	1.0	2.1×10^{11}	6	4	3
Example 280	CP-280	280	13	30	1.0	5.1×10^{11}	6	4	3

[0345] [Table 34]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Comparative Example 42	CP-C42	C42	-	-	-	2.1×10^{13}	1	3
Comparative Example 43	CP-C43	C43	-	-	-	3.3×10^{11}	1	4
Comparative Example 44	CP-C44	C44	-	-	-	5.5×10^8	1	4
Comparative Example 45	CP-C45	C45	1	15	1.0	2.1×10^{13}	2	3
Comparative Example 46	CP-C46	C46	1	30	1.0	3.2×10^{11}	2	4
Comparative Example 47	CP-C47	C47	1	45	1.0	5.2×10^8	2	4
Comparative Example 48	CP-C48	C48	30	15	1.0	1.6×10^{13}	2	3
Comparative Example 49	CP-C49	C49	30	30	1.0	1.6×10^{11}	2	4
Comparative Example 50	CP-C50	C50	30	45	1.0	1.4×10^8	2	4
Comparative Example 51	CP-C51	C51	-	-	-	5.8×10^{12}	1	3
Comparative Example 52	CP-C52	C52	-	-	-	1.5×10^{10}	1	4
Comparative Example 53	CP-C53	C53	-	-	-	1.5×10^6	1	4
Comparative Example 54	CP-C54	C54	2	10	1.0	6.0×10^{13}	5	1
Comparative Example 55	CP-C55	C55	5	10	1.0	5.9×10^{13}	6	1
Comparative Example 56	CP-C56	C56	13	10	1.0	5.6×10^{13}	6	1
Comparative Example 57	CP-C57	C57	20	10	1.0	5.4×10^{13}	6	1
Comparative Example 58	CP-C58	C58	25	10	1.0	5.2×10^{13}	4	1
Comparative Example 59	CP-C59	C59	2	50	1.0	2.4×10^7	5	4
Comparative Example 60	CP-C60	C60	5	50	1.0	2.0×10^7	6	4
Comparative Example 61	CP-C61	C61	13	50	1.0	1.2×10^7	6	4
Comparative Example 62	CP-C62	C62	20	50	1.0	8.3×10^6	6	4
Comparative Example 63	CP-C63	C63	25	50	1.0	6.5×10^6	4	4

[0346] [Table 35]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)+(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 64	CP-C64	C64	-	-	-	2.6×10^{11}	1	4	3
Comparative Example 65	CP-C65	C65	-	-	-	2.6×10^{11}	1	4	3
Comparative Example 66	CP-C66	C66	-	-	-	2.3×10^{11}	1	4	3
Comparative Example 67	CP-C67	C67	-	-	-	2.7×10^{11}	1	4	3
Comparative Example 68	CP-C68	C68	-	-	-	2.5×10^{11}	1	4	3
Comparative Example 69	CP-C69	C69	-	-	-	2.7×10^{11}	1	4	3
Comparative Example 70	CP-C70	C70	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 71	CP-C71	C71	-	-	-	2.3×10^{11}	1	4	3

[0347] [Table 36]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Example 281	CP-281	281	2	15	0.8	2.3×10^{13}	4	3
Example 282	CP-282	282	2	15	0.9	2.3×10^{13}	5	3
Example 283	CP-283	283	2	15	1.0	2.3×10^{13}	5	3
Example 284	CP-284	284	2	15	1.1	2.3×10^{13}	5	3
Example 285	CP-285	285	2	15	1.2	2.3×10^{13}	4	3
Example 286	CP-286	286	5	15	1.0	2.2×10^{13}	6	3
Example 287	CP-287	287	13	15	0.8	2.1×10^{13}	5	3
Example 288	CP-288	288	13	15	0.9	2.1×10^{13}	6	3
Example 289	CP-289	289	13	15	1.0	2.1×10^{13}	6	3
Example 290	CP-290	290	13	15	1.1	2.1×10^{13}	6	3
Example 291	CP-291	291	13	15	1.2	2.1×10^{13}	5	3
Example 292	CP-292	292	20	15	1.0	2.0×10^{13}	6	3
Example 293	CP-293	293	25	15	0.8	1.9×10^{13}	3	3
Example 294	CP-294	294	25	15	0.9	1.9×10^{13}	4	3
Example 295	CP-295	295	25	15	1.0	2.0×10^{13}	4	3
Example 296	CP-296	296	25	15	1.1	2.0×10^{13}	4	3
Example 297	CP-297	297	25	15	1.2	2.0×10^{13}	3	3
Example 298	CP-298	298	2	20	1.0	7.1×10^{12}	5	4
Example 299	CP-299	299	5	20	0.8	6.9×10^{12}	5	4
Example 300	CP-300	300	5	20	0.9	6.9×10^{12}	6	4
Example 301	CP-301	301	5	20	1.0	6.9×10^{12}	6	4
Example 302	CP-302	302	5	20	1.1	6.9×10^{12}	6	4
Example 303	CP-303	303	5	20	1.2	6.9×10^{12}	5	4
Example 304	CP-304	304	13	20	0.8	6.3×10^{12}	5	4
Example 305	CP-305	305	13	20	0.9	6.3×10^{12}	6	4
Example 306	CP-306	306	13	20	1.0	6.3×10^{12}	6	4
Example 307	CP-307	307	13	20	1.1	6.3×10^{12}	6	4
Example 308	CP-308	308	13	20	1.2	6.3×10^{12}	5	4
Example 309	CP-309	309	20	20	0.8	5.8×10^{12}	5	4

Example 310	CP-310	310	20	20	0.9	5.8×10^{12}	6	4	3
Example 311	CP-311	311	20	20	1.0	5.9×10^{12}	6	4	3
Example 312	CP-312	312	20	20	1.1	5.9×10^{12}	6	4	3
Example 313	CP-313	313	20	20	1.2	5.9×10^{12}	5	4	3
Example 314	CP-314	314	25	20	1.0	5.7×10^{12}	4	4	3
Example 315	CP-315	315	2	30	0.8	4.1×10^{11}	4	4	3
Example 316	CP-316	316	2	30	0.9	4.1×10^{11}	5	4	3
Example 317	CP-317	317	2	30	1.0	4.2×10^{11}	5	4	3
Example 318	CP-318	318	2	30	1.1	4.2×10^{11}	5	4	3
Example 319	CP-319	319	2	30	1.2	4.2×10^{11}	4	4	3
Example 320	CP-320	320	5	30	0.8	3.9×10^{11}	5	4	3

[0348] [Table 37]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 321	CP-321	321	5	30	0.9	3.9×10^{11}	6	4	3
Example 322	CP-322	322	5	30	1.0	3.9×10^{11}	6	4	3
Example 323	CP-323	323	5	30	1.1	3.9×10^{11}	6	4	3
Example 324	CP-324	324	5	30	1.2	3.9×10^{11}	5	4	3
Example 325	CP-325	325	13	30	0.8	3.3×10^{11}	5	4	3
Example 326	CP-326	326	13	30	0.9	3.3×10^{11}	6	4	3
Example 327	CP-327	327	13	30	1.0	3.4×10^{11}	6	4	3
Example 328	CP-328	328	13	30	1.1	3.4×10^{11}	6	4	3
Example 329	CP-329	329	13	30	1.2	3.4×10^{11}	5	4	3
Example 330	CP-330	330	20	30	0.8	3.0×10^{11}	5	4	3
Example 331	CP-331	331	20	30	0.9	3.0×10^{11}	6	4	3
Example 332	CP-332	332	20	30	1.0	3.0×10^{11}	6	4	3
Example 333	CP-333	333	20	30	1.1	3.0×10^{11}	6	4	3
Example 334	CP-334	334	20	30	1.2	3.0×10^{11}	5	4	3
Example 335	CP-335	335	25	30	0.8	2.7×10^{11}	3	4	3
Example 336	CP-336	336	25	30	0.9	2.7×10^{11}	4	4	3
Example 337	CP-337	337	25	30	1.0	2.8×10^{11}	4	4	3
Example 338	CP-338	338	25	30	1.1	2.8×10^{11}	4	4	3
Example 339	CP-339	339	25	30	1.2	2.8×10^{11}	3	4	3
Example 340	CP-340	340	2	40	1.0	9.5×10^9	5	4	3
Example 341	CP-341	341	5	40	0.8	8.4×10^9	5	4	3
Example 342	CP-342	342	5	40	0.9	8.4×10^9	6	4	3
Example 343	CP-343	343	5	40	1.0	8.6×10^9	6	4	3
Example 344	CP-344	344	5	40	1.1	8.6×10^9	6	4	3
Example 345	CP-345	345	5	40	1.2	8.6×10^9	5	4	3
Example 346	CP-346	346	13	40	0.8	6.7×10^9	5	4	3
Example 347	CP-347	347	13	40	0.9	6.7×10^9	6	4	3
Example 348	CP-348	348	13	40	1.0	6.8×10^9	6	4	3
Example 349	CP-349	349	13	40	1.1	6.8×10^9	6	4	3

Example 350	CP-350	350	13	40	1.2	6.8×10^9	5	4	3
Example 351	CP-351	351	20	40	0.8	5.6×10^9	5	4	3
Example 352	CP-352	352	20	40	0.9	5.6×10^9	6	4	3
Example 353	CP-353	353	20	40	1.0	5.7×10^9	6	4	3
Example 354	CP-354	354	20	40	1.1	5.7×10^9	6	4	3
Example 355	CP-355	355	20	40	1.2	5.7×10^9	5	4	3
Example 356	CP-356	356	25	40	1.0	5.1×10^9	4	4	3
Example 357	CP-357	357	2	45	0.8	8.4×10^8	4	4	2
Example 358	CP-358	358	2	45	0.9	8.4×10^8	5	4	2
Example 359	CP-359	359	2	45	1.0	8.5×10^8	5	4	2
Example 360	CP-360	360	2	45	1.1	8.5×10^8	5	4	2

[0349] [Table 38]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_n)/(V_1/V_n)\} \times 100$	$\{(V_1/V_n)/(V_2/V_n)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 361	CP-361	361	2	45	1.2	8.5×10^8	4	4	2
Example 362	CP-362	362	5	45	1.0	7.6×10^8	6	4	2
Example 363	CP-363	363	13	45	0.8	5.6×10^8	5	4	2
Example 364	CP-364	364	13	45	0.9	5.6×10^8	6	4	2
Example 365	CP-365	365	13	45	1.0	5.7×10^8	6	4	2
Example 366	CP-366	366	13	45	1.1	5.7×10^8	6	4	2
Example 367	CP-367	367	13	45	1.2	5.7×10^8	5	4	2
Example 368	CP-368	368	20	45	1.0	4.7×10^8	6	4	2
Example 369	CP-369	369	25	45	0.8	3.8×10^8	3	4	2
Example 370	CP-370	370	25	45	0.9	3.8×10^8	4	4	2
Example 371	CP-371	371	25	45	1.0	4.1×10^8	4	4	2
Example 372	CP-372	372	25	45	1.1	4.1×10^8	4	4	2
Example 373	CP-373	373	25	45	1.2	4.1×10^8	3	4	2

[0350] [Table 39]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_1) / (V_1/V_2)\} \times 100$	$\{(V_1/V_2) + (V_2/V_1)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Example 374	CP-374	374	5	20	0.8	5.2×10^{12}	5	4
Example 375	CP-375	375	5	20	0.9	5.2×10^{12}	6	4
Example 376	CP-376	376	5	20	1.0	5.2×10^{12}	6	4
Example 377	CP-377	377	5	20	1.1	5.2×10^{12}	6	4
Example 378	CP-378	378	5	20	1.2	5.2×10^{12}	5	4
Example 379	CP-379	379	13	20	0.8	4.7×10^{12}	5	4
Example 380	CP-380	380	13	20	0.9	4.7×10^{12}	6	4
Example 381	CP-381	381	13	20	1.0	4.8×10^{12}	6	4
Example 382	CP-382	382	13	20	1.1	4.8×10^{12}	6	4
Example 383	CP-383	383	13	20	1.2	4.8×10^{12}	5	4
Example 384	CP-384	384	20	20	0.8	4.4×10^{12}	5	4
Example 385	CP-385	385	20	20	0.9	4.4×10^{12}	6	4
Example 386	CP-386	386	20	20	1.0	4.4×10^{12}	6	4
Example 387	CP-387	387	20	20	1.1	4.4×10^{12}	6	4
Example 388	CP-388	388	20	20	1.2	4.4×10^{12}	5	4
Example 389	CP-389	389	5	30	0.8	2.0×10^{11}	5	4
Example 390	CP-390	390	5	30	0.9	2.0×10^{11}	6	4
Example 391	CP-391	391	5	30	1.0	2.1×10^{11}	6	4
Example 392	CP-392	392	5	30	1.1	2.1×10^{11}	6	4
Example 393	CP-393	393	5	30	1.2	2.1×10^{11}	5	4
Example 394	CP-394	394	13	30	0.8	1.7×10^{11}	5	4
Example 395	CP-395	395	13	30	0.9	1.7×10^{11}	6	4
Example 396	CP-396	396	13	30	1.0	1.7×10^{11}	6	4
Example 397	CP-397	397	13	30	1.1	1.7×10^{11}	6	4
Example 398	CP-398	398	13	30	1.2	1.7×10^{11}	5	4
Example 399	CP-399	399	20	30	0.8	1.5×10^{11}	5	4
Example 400	CP-400	400	20	30	0.9	1.5×10^{11}	6	4
Example 401	CP-401	401	20	30	1.0	1.5×10^{11}	6	4
Example 402	CP-402	402	20	30	1.1	1.5×10^{11}	6	4
Example 403	CP-403	403	20	30	1.2	1.5×10^{11}	5	4
Example 404	CP-404	404	5	40	0.8	2.1×10^9	5	4

[0351] [Table 40]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 405	CP-405	405	5	40	0.9	2.1×10^9	6	4	3
Example 406	CP-406	406	5	40	1.0	2.1×10^9	6	4	3
Example 407	CP-407	407	5	40	1.1	2.1×10^9	6	4	3
Example 408	CP-408	408	5	40	1.2	2.1×10^9	5	4	3
Example 409	CP-409	409	13	40	0.8	1.6×10^9	5	4	3
Example 410	CP-410	410	13	40	0.9	1.6×10^9	6	4	3
Example 411	CP-411	411	13	40	1.0	1.6×10^9	6	4	3
Example 412	CP-412	412	13	40	1.1	1.6×10^9	6	4	3
Example 413	CP-413	413	13	40	1.2	1.6×10^9	5	4	3
Example 414	CP-414	414	20	40	0.8	1.2×10^9	5	4	3
Example 415	CP-415	415	20	40	0.9	1.2×10^9	6	4	3
Example 416	CP-416	416	20	40	1.0	1.3×10^9	6	4	3
Example 417	CP-417	417	20	40	1.1	1.3×10^9	6	4	3
Example 418	CP-418	418	20	40	1.2	1.3×10^9	5	4	3
Example 419	CP-419	419	13	30	1.0	2.7×10^{11}	6	4	3
Example 420	CP-420	420	13	30	1.0	5.8×10^{11}	6	4	3

[0352] [Table 41]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	{(V ₂ /V _T)/(V ₁ /V _T)}×100	{(V ₁ /V _T)+(V ₂ /V _T)}×100	R ₂ /R ₁	Volume resistivity of conductive layer [Ω·cm]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 76	CP-C76	C76	-	-	-	2.3×10 ¹³	1	3	3
Comparative Example 77	CP-C77	C77	-	-	-	4.4×10 ¹¹	1	4	3
Comparative Example 78	CP-C78	C78	-	-	-	9.2×10 ⁸	1	4	2
Comparative Example 79	CP-C79	C79	1	15	1.0	2.3×10 ¹³	2	3	3
Comparative Example 80	CP-C80	C80	1	30	1.0	4.3×10 ¹¹	2	4	3
Comparative Example 81	CP-C81	C81	1	45	1.0	8.8×10 ⁸	2	4	2
Comparative Example 82	CP-C82	C82	30	15	1.0	1.9×10 ¹³	2	3	3
Comparative Example 83	CP-C83	C83	30	30	1.0	2.6×10 ¹¹	2	4	3
Comparative Example 84	CP-C84	C84	30	45	1.0	3.5×10 ⁸	2	4	2
Comparative Example 85	CP-C85	C85	-	-	-	9.6×10 ¹²	1	3	3
Comparative Example 86	CP-C86	C86	-	-	-	5.0×10 ¹⁰	1	4	3
Comparative Example 87	CP-C87	C87	-	-	-	1.5×10 ⁷	1	4	2
Comparative Example 88	CP-C88	C88	2	10	1.0	6.5×10 ¹³	5	1	3
Comparative Example 89	CP-C89	C89	5	10	1.0	6.4×10 ¹³	6	1	3
Comparative Example 90	CP-C90	C90	13	10	1.0	6.1×10 ¹³	6	1	3
Comparative Example 91	CP-C91	C91	20	10	1.0	6.0×10 ¹³	6	1	3
Comparative Example 92	CP-C92	C92	25	10	1.0	5.8×10 ¹³	4	1	3
Comparative Example 93	CP-C93	C93	2	50	1.0	4.8×10 ⁷	5	4	1
Comparative Example 94	CP-C94	C94	5	50	1.0	4.1×10 ⁷	6	4	1
Comparative Example 95	CP-C95	C95	13	50	1.0	2.9×10 ⁷	6	4	1
Comparative Example 96	CP-C96	C96	20	50	1.0	2.2×10 ⁷	6	4	1
Comparative Example 97	CP-C97	C97	25	50	1.0	1.9×10 ⁷	4	4	1

[0353] [Table 42]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)+(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 98	CP-C98	C98	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 99	CP-C99	C99	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 100	CP-C100	C100	-	-	-	2.7×10^{11}	1	4	3
Comparative Example 101	CP-C101	C101	-	-	-	3.4×10^{11}	1	4	3
Comparative Example 102	CP-C102	C102	-	-	-	3.1×10^{11}	1	4	3
Comparative Example 103	CP-C103	C103	-	-	-	3.4×10^{11}	1	4	3
Comparative Example 104	CP-C104	C104	-	-	-	2.7×10^{11}	1	4	3
Comparative Example 105	CP-C105	C105	-	-	-	3.4×10^{11}	1	4	3

[0354] [Table 43]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 36	CP-C36	C36	-	-	-	8.0×10^6	1	4	3
Comparative Example 37	CP-C37	C37	-	-	-	1.0×10^7	1	4	3
Comparative Example 38	CP-C38	C38	-	-	-	4.4×10^{10}	1	4	3
Comparative Example 39	CP-C39	C39	-	-	-	2.0×10^{13}	1	4	3
Comparative Example 40	CP-C40	C40	-	-	-	2.1×10^9	1	4	3
Comparative Example 41	CP-C41	C41	-	-	-	3.1×10^9	1	4	3
Comparative Example 72	CP-C72	C72	-	-	-	3.5×10^{10}	1	4	3
Comparative Example 73	CP-C73	C73	-	-	-	2.0×10^{13}	1	4	3
Comparative Example 74	CP-C74	C74	-	-	-	4.0×10^9	1	4	3
Comparative Example 75	CP-C75	C75	-	-	-	5.8×10^9	1	4	3
Comparative Example 106	CP-C106	C106	-	-	-	3.5×10^{10}	1	4	3

[0355] [Table 59]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Example 421	CP-421	421	2	15	0.8	2.2×10^{13}	4	3
Example 422	CP-422	422	2	15	0.9	2.2×10^{13}	5	3
Example 423	CP-423	423	2	15	1.0	2.2×10^{13}	5	3
Example 424	CP-424	424	2	15	1.1	2.2×10^{13}	5	3
Example 425	CP-425	425	2	15	1.2	2.2×10^{13}	4	3
Example 426	CP-426	426	5	15	1.0	2.1×10^{13}	6	3
Example 427	CP-427	427	13	15	0.8	2.0×10^{13}	5	3
Example 428	CP-428	428	13	15	0.9	2.0×10^{13}	6	3
Example 429	CP-429	429	13	15	1.0	2.0×10^{13}	6	3
Example 430	CP-430	430	13	15	1.1	2.0×10^{13}	6	3
Example 431	CP-431	431	13	15	1.2	2.0×10^{13}	5	3
Example 432	CP-432	432	20	15	1.0	1.9×10^{13}	6	3
Example 433	CP-433	433	25	15	0.8	1.8×10^{13}	3	3
Example 434	CP-434	434	25	15	0.9	1.8×10^{13}	4	3
Example 435	CP-435	435	25	15	1.0	1.8×10^{13}	4	3
Example 436	CP-436	436	25	15	1.1	1.8×10^{13}	4	3
Example 437	CP-437	437	25	15	1.2	1.8×10^{13}	3	3
Example 438	CP-438	438	2	20	1.0	6.6×10^{12}	5	4
Example 439	CP-439	439	5	20	0.8	6.3×10^{12}	5	4
Example 440	CP-440	440	5	20	0.9	6.3×10^{12}	6	4
Example 441	CP-441	441	5	20	1.0	6.3×10^{12}	6	4
Example 442	CP-442	442	5	20	1.1	6.3×10^{12}	6	4
Example 443	CP-443	443	5	20	1.2	6.3×10^{12}	5	4
Example 444	CP-444	444	13	20	0.8	5.7×10^{12}	5	4
Example 445	CP-445	445	13	20	0.9	5.7×10^{12}	6	4
Example 446	CP-446	446	13	20	1.0	5.7×10^{12}	6	4
Example 447	CP-447	447	13	20	1.1	5.7×10^{12}	6	4
Example 448	CP-448	448	13	20	1.2	5.7×10^{12}	5	4
Example 449	CP-449	449	20	20	0.8	5.3×10^{12}	5	4

Example 450	CP-450	450		20	20	0.9	5.3×10^{12}	6	4	3
Example 451	CP-451	451		20	20	1.0	5.3×10^{12}	6	4	3
Example 452	CP-452	452		20	20	1.1	5.3×10^{12}	6	4	3
Example 453	CP-453	453		20	20	1.2	5.3×10^{12}	5	4	3
Example 454	CP-454	454		25	20	1.0	5.0×10^{12}	4	4	3
Example 455	CP-455	455		2	30	0.8	3.6×10^{11}	4	4	3
Example 456	CP-456	456		2	30	0.9	3.6×10^{11}	5	4	3
Example 457	CP-457	457		2	30	1.0	3.6×10^{11}	5	4	3
Example 458	CP-458	458		2	30	1.1	3.6×10^{11}	5	4	3
Example 459	CP-459	459		2	30	1.2	3.6×10^{11}	4	4	3
Example 460	CP-460	460		5	30	0.8	3.4×10^{11}	5	4	3

[0356] [Table 60]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_1)/(V_1/V_2) \times 100\}$	$\{(V_1/V_2)/(V_2/V_1) \times 100\}$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential Crack
Example 461	CP-461	461	5	30	0.9	3.4×10^{11}	6	4 3
Example 462	CP-462	462	5	30	1.0	3.4×10^{11}	6	4 3
Example 463	CP-463	463	5	30	1.1	3.4×10^{11}	6	4 3
Example 464	CP-464	464	5	30	1.2	3.4×10^{11}	5	4 3
Example 465	CP-465	465	13	30	0.8	2.8×10^{11}	5	4 3
Example 466	CP-466	466	13	30	0.9	2.8×10^{11}	6	4 3
Example 467	CP-467	467	13	30	1.0	2.8×10^{11}	6	4 3
Example 468	CP-468	468	13	30	1.1	2.8×10^{11}	6	4 3
Example 469	CP-469	469	13	30	1.2	2.8×10^{11}	5	4 3
Example 470	CP-470	470	20	30	0.8	2.5×10^{11}	5	4 3
Example 471	CP-471	471	20	30	0.9	2.5×10^{11}	6	4 3
Example 472	CP-472	472	20	30	1.0	2.5×10^{11}	6	4 3
Example 473	CP-473	473	20	30	1.1	2.5×10^{11}	6	4 3
Example 474	CP-474	474	20	30	1.2	2.5×10^{11}	5	4 3
Example 475	CP-475	475	25	30	0.8	2.3×10^{11}	3	4 3
Example 476	CP-476	476	25	30	0.9	2.3×10^{11}	4	4 3
Example 477	CP-477	477	25	30	1.0	2.3×10^{11}	4	4 3
Example 478	CP-478	478	25	30	1.1	2.3×10^{11}	4	4 3
Example 479	CP-479	479	25	30	1.2	2.3×10^{11}	3	4 3
Example 480	CP-480	480	2	40	1.0	7.6×10^9	5	4 3
Example 481	CP-481	481	5	40	0.8	6.8×10^9	5	4 3
Example 482	CP-482	482	5	40	0.9	6.8×10^9	6	4 3
Example 483	CP-483	483	5	40	1.0	6.8×10^9	6	4 3
Example 484	CP-484	484	5	40	1.1	6.8×10^9	6	4 3
Example 485	CP-485	485	5	40	1.2	6.8×10^9	5	4 3
Example 486	CP-486	486	13	40	0.8	5.2×10^9	5	4 3
Example 487	CP-487	487	13	40	0.9	5.2×10^9	6	4 3
Example 488	CP-488	488	13	40	1.0	5.2×10^9	6	4 3
Example 489	CP-489	489	13	40	1.1	5.2×10^9	6	4 3

Example 490	CP-490	490	13	40	1.2	5.2×10^9	5	4	3
Example 491	CP-491	491	20	40	0.8	4.2×10^9	5	4	3
Example 492	CP-492	492	20	40	0.9	4.2×10^9	6	4	3
Example 493	CP-493	493	20	40	1.0	4.2×10^9	6	4	3
Example 494	CP-494	494	20	40	1.1	4.2×10^9	6	4	3
Example 495	CP-495	495	20	40	1.2	4.2×10^9	5	4	3
Example 496	CP-496	496	25	40	1.0	3.7×10^9	4	4	3
Example 497	CP-497	497	2	45	0.8	6.5×10^8	4	4	2
Example 498	CP-498	498	2	45	0.9	6.5×10^8	5	4	2
Example 499	CP-499	499	2	45	1.0	6.5×10^8	5	4	2
Example 500	CP-500	500	2	45	1.1	6.5×10^8	5	4	2

[0357] [Table 61]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_2)/\{(V_1/V_2)/V_2\}\} \times 100$	$\{(V_1/V_2)/\{(V_2/V_2)/V_2\}\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 501	CP-501	501	2	45	1.2	6.5×10^8	4	4	2
Example 502	CP-502	502	5	45	1.0	5.7×10^8	6	4	2
Example 503	CP-503	503	13	45	0.8	4.1×10^8	5	4	2
Example 504	CP-504	504	13	45	0.9	4.1×10^8	6	4	2
Example 505	CP-505	505	13	45	1.0	4.1×10^8	6	4	2
Example 506	CP-506	506	13	45	1.1	4.1×10^8	6	4	2
Example 507	CP-507	507	13	45	1.2	4.1×10^8	5	4	2
Example 508	CP-508	508	20	45	1.0	3.2×10^8	6	4	2
Example 509	CP-509	509	25	45	0.8	2.7×10^8	3	4	2
Example 510	CP-510	510	25	45	0.9	2.7×10^8	4	4	2
Example 511	CP-511	511	25	45	1.0	2.7×10^8	4	4	2
Example 512	CP-512	512	25	45	1.1	2.7×10^8	4	4	2
Example 513	CP-513	513	25	45	1.2	2.7×10^8	3	4	2
Example 514	CP-514	514	5	20	0.8	4.8×10^{12}	5	4	3
Example 515	CP-515	515	5	20	0.9	4.8×10^{12}	6	4	3
Example 516	CP-516	516	5	20	1.0	4.8×10^{12}	6	4	3
Example 517	CP-517	517	5	20	1.1	4.8×10^{12}	6	4	3
Example 518	CP-518	518	5	20	1.2	4.8×10^{12}	5	4	3
Example 519	CP-519	519	13	20	0.8	4.3×10^{12}	5	4	3
Example 520	CP-520	520	13	20	0.9	4.3×10^{12}	6	4	3
Example 521	CP-521	521	13	20	1.0	4.3×10^{12}	6	4	3
Example 522	CP-522	522	13	20	1.1	4.3×10^{12}	6	4	3
Example 523	CP-523	523	13	20	1.2	4.3×10^{12}	5	4	3
Example 524	CP-524	524	20	20	0.8	3.9×10^{12}	5	4	3
Example 525	CP-525	525	20	20	0.9	3.9×10^{12}	6	4	3
Example 526	CP-526	526	20	20	1.0	3.9×10^{12}	6	4	3
Example 527	CP-527	527	20	20	1.1	3.9×10^{12}	6	4	3
Example 528	CP-528	528	20	20	1.2	3.9×10^{12}	5	4	3
Example 529	CP-529	529	5	30	0.8	1.7×10^{11}	5	4	3
Example 530	CP-530	530	5	30	0.9	1.7×10^{11}	6	4	3
Example 531	CP-531	531	5	30	1.0	1.7×10^{11}	6	4	3
Example 532	CP-532	532	5	30	1.1	1.7×10^{11}	6	4	3
Example 533	CP-533	533	5	30	1.2	1.7×10^{11}	5	4	3

Example 534	CP-534	534	13	30	0.8	1.4×10^{11}	5	4	3
Example 535	CP-535	535	13	30	0.9	1.4×10^{11}	6	4	3
Example 536	CP-536	536	13	30	1.0	1.4×10^{11}	6	4	3
Example 537	CP-537	537	13	30	1.1	1.4×10^{11}	6	4	3
Example 538	CP-538	538	13	30	1.2	1.4×10^{11}	5	4	3
Example 539	CP-539	539	20	30	0.8	1.2×10^{11}	5	4	3
Example 540	CP-540	540	20	30	0.9	1.2×10^{11}	6	4	3

[0358] [Table 62]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 541	CP-541	541	20	30	1.0	1.2×10^{11}	6	4	3
Example 542	CP-542	542	20	30	1.1	1.2×10^{11}	6	4	3
Example 543	CP-543	543	20	30	1.2	1.2×10^{11}	5	4	3
Example 544	CP-544	544	5	40	0.8	1.6×10^9	5	4	3
Example 545	CP-545	545	5	40	0.9	1.6×10^9	6	4	3
Example 546	CP-546	546	5	40	1.0	1.6×10^9	6	4	3
Example 547	CP-547	547	5	40	1.1	1.6×10^9	6	4	3
Example 548	CP-548	548	5	40	1.2	1.6×10^9	5	4	3
Example 549	CP-549	549	13	40	0.8	1.1×10^9	5	4	3
Example 550	CP-550	550	13	40	0.9	1.1×10^9	6	4	3
Example 551	CP-551	551	13	40	1.0	1.1×10^9	6	4	3
Example 552	CP-552	552	13	40	1.1	1.1×10^9	6	4	3
Example 553	CP-553	553	13	40	1.2	1.1×10^9	5	4	3
Example 554	CP-554	554	20	40	0.8	8.7×10^8	5	4	3
Example 555	CP-555	555	20	40	0.9	8.7×10^8	6	4	3
Example 556	CP-556	556	20	40	1.0	8.7×10^8	6	4	3
Example 557	CP-557	557	20	40	1.1	8.7×10^8	6	4	3
Example 558	CP-558	558	20	40	1.2	8.7×10^8	5	4	3
Example 559	CP-559	559	13	30	1.0	1.4×10^{11}	6	4	3
Example 560	CP-560	560	11	30	1.0	4.8×10^{11}	6	4	3

[0359] [Table 63]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential Crack
Comparative Example 107	CP-C107	C107	-	-	-	2.2×10^{13}	1	3
Comparative Example 108	CP-C108	C108	-	-	-	3.8×10^{11}	1	4
Comparative Example 109	CP-C109	C109	-	-	-	7.2×10^8	1	4
Comparative Example 110	CP-C110	C110	1	15	1.0	2.2×10^{13}	2	3
Comparative Example 111	CP-C111	C111	1	30	1.0	3.7×10^{11}	2	4
Comparative Example 112	CP-C112	C112	1	45	1.0	6.8×10^8	2	4
Comparative Example 113	CP-C113	C113	30	15	1.0	1.7×10^{13}	2	3
Comparative Example 114	CP-C114	C114	30	30	1.0	2.1×10^{11}	2	4
Comparative Example 115	CP-C115	C115	30	45	1.0	2.3×10^8	2	4
Comparative Example 116	CP-C116	C116	-	-	-	7.7×10^{12}	1	3
Comparative Example 117	CP-C117	C117	-	-	-	2.9×10^{10}	1	4
Comparative Example 118	CP-C118	C118	-	-	-	5.3×10^6	1	4
Comparative Example 119	CP-C119	C119	2	10	1.0	6.3×10^{13}	5	1
Comparative Example 120	CP-C120	C120	5	10	1.0	6.1×10^{13}	6	1
Comparative Example 121	CP-C121	C121	13	10	1.0	5.9×10^{13}	6	1
Comparative Example 122	CP-C122	C122	20	10	1.0	5.7×10^{13}	6	1
Comparative Example 123	CP-C123	C123	25	10	1.0	5.5×10^{13}	4	1
Comparative Example 124	CP-C124	C124	2	50	1.0	3.4×10^7	5	4
Comparative Example 125	CP-C125	C125	5	50	1.0	2.9×10^7	6	4
Comparative Example 126	CP-C126	C126	13	50	1.0	1.9×10^7	6	4
Comparative Example 127	CP-C127	C127	20	50	1.0	1.4×10^7	6	4
Comparative Example 128	CP-C128	C128	25	50	1.0	1.2×10^7	4	4

[Table 64]

[0360]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Example 561	CP-561	561	2	15	0.8	2.0×10^{13}	4	3
Example 562	CP-562	562	2	15	0.9	2.0×10^{13}	5	3
Example 563	CP-563	563	2	15	1.0	2.0×10^{13}	5	3
Example 564	CP-564	564	2	15	1.1	2.0×10^{13}	5	3
Example 565	CP-565	565	2	15	1.2	2.0×10^{13}	4	3
Example 566	CP-566	566	5	15	1.0	2.0×10^{13}	6	3
Example 567	CP-567	567	13	15	0.8	1.8×10^{13}	5	3
Example 568	CP-568	568	13	15	0.9	1.8×10^{13}	6	3
Example 569	CP-569	569	13	15	1.0	1.8×10^{13}	6	3
Example 570	CP-570	570	13	15	1.1	1.8×10^{13}	6	3
Example 571	CP-571	571	13	15	1.2	1.8×10^{13}	5	3
Example 572	CP-572	572	20	15	1.0	1.7×10^{13}	6	3
Example 573	CP-573	573	25	15	0.8	1.7×10^{13}	3	3
Example 574	CP-574	574	25	15	0.9	1.7×10^{13}	4	3
Example 575	CP-575	575	25	15	1.0	1.6×10^{13}	4	3
Example 576	CP-576	576	25	15	1.1	1.6×10^{13}	4	3
Example 577	CP-577	577	25	15	1.2	1.6×10^{13}	3	3
Example 578	CP-578	578	2	20	1.0	6.0×10^{12}	5	4
Example 579	CP-579	579	5	20	0.8	5.8×10^{12}	5	4
Example 580	CP-580	580	5	20	0.9	5.8×10^{12}	6	4
Example 581	CP-581	581	5	20	1.0	5.8×10^{12}	6	4
Example 582	CP-582	582	5	20	1.1	5.8×10^{12}	6	4
Example 583	CP-583	583	5	20	1.2	5.7×10^{12}	5	4
Example 584	CP-584	584	13	20	0.8	5.2×10^{12}	5	4
Example 585	CP-585	585	13	20	0.9	5.2×10^{12}	6	4
Example 586	CP-586	586	13	20	1.0	5.1×10^{12}	6	4
Example 587	CP-587	587	13	20	1.1	5.1×10^{12}	6	4
Example 588	CP-588	588	13	20	1.2	5.1×10^{12}	5	4
Example 589	CP-589	589	20	20	0.8	4.7×10^{12}	5	4

Example 590	CP-590	590	20	20	0.9	4.7×10^{12}	6	4	3
Example 591	CP-591	591	20	20	1.0	4.7×10^{12}	6	4	3
Example 592	CP-592	592	20	20	1.1	4.7×10^{12}	6	4	3
Example 593	CP-593	593	20	20	1.2	4.6×10^{12}	5	4	3
Example 594	CP-594	594	25	20	1.0	4.4×10^{12}	4	4	3
Example 595	CP-595	595	2	30	0.8	3.1×10^{11}	4	4	3
Example 596	CP-596	596	2	30	0.9	3.1×10^{11}	5	4	3
Example 597	CP-597	597	2	30	1.0	3.1×10^{11}	5	4	3
Example 598	CP-598	598	2	30	1.1	3.1×10^{11}	5	4	3
Example 599	CP-599	599	2	30	1.2	3.1×10^{11}	4	4	3
Example 600	CP-600	600	5	30	0.8	2.9×10^{11}	5	4	3

[0361] [Table 65]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 601	CP-601	601	5	30	0.9	2.9×10^{11}	6	4	3
Example 602	CP-602	602	5	30	1.0	2.9×10^{11}	6	4	3
Example 603	CP-603	603	5	30	1.1	2.9×10^{11}	6	4	3
Example 604	CP-604	604	5	30	1.2	2.9×10^{11}	5	4	3
Example 605	CP-605	605	13	30	0.8	2.4×10^{11}	5	4	3
Example 606	CP-606	606	13	30	0.9	2.4×10^{11}	6	4	3
Example 607	CP-607	607	13	30	1.0	2.4×10^{11}	6	4	3
Example 608	CP-608	608	13	30	1.1	2.4×10^{11}	6	4	3
Example 609	CP-609	609	13	30	1.2	2.3×10^{11}	5	4	3
Example 610	CP-610	610	20	30	0.8	2.1×10^{11}	5	4	3
Example 611	CP-611	611	20	30	0.9	2.1×10^{11}	6	4	3
Example 612	CP-612	612	20	30	1.0	2.0×10^{11}	6	4	3
Example 613	CP-613	613	20	30	1.1	2.0×10^{11}	6	4	3
Example 614	CP-614	614	20	30	1.2	2.0×10^{11}	5	4	3
Example 615	CP-615	615	25	30	0.8	1.9×10^{11}	3	4	3
Example 616	CP-616	616	25	30	0.9	1.9×10^{11}	4	4	3
Example 617	CP-617	617	25	30	1.0	1.8×10^{11}	4	4	3
Example 618	CP-618	618	25	30	1.1	1.8×10^{11}	4	4	3
Example 619	CP-619	619	25	30	1.2	1.8×10^{11}	3	4	3
Example 620	CP-620	620	2	40	1.0	6.1×10^9	5	4	3
Example 621	CP-621	621	5	40	0.8	5.4×10^9	5	4	3
Example 622	CP-622	622	5	40	0.9	5.4×10^9	6	4	3
Example 623	CP-623	623	5	40	1.0	5.3×10^9	6	4	3
Example 624	CP-624	624	5	40	1.1	5.3×10^9	6	4	3
Example 625	CP-625	625	5	40	1.2	5.3×10^9	5	4	3
Example 626	CP-626	626	13	40	0.8	4.0×10^9	5	4	3
Example 627	CP-627	627	13	40	0.9	4.0×10^9	6	4	3
Example 628	CP-628	628	13	40	1.0	3.9×10^9	6	4	3
Example 629	CP-629	629	13	40	1.1	3.9×10^9	6	4	3

Example 630	CP-630	630	13	40	1.2	3.8×10^9	5	4	3
Example 631	CP-631	631	20	40	0.8	3.2×10^9	5	4	3
Example 632	CP-632	632	20	40	0.9	3.2×10^9	6	4	3
Example 633	CP-633	633	20	40	1.0	3.1×10^9	6	4	3
Example 634	CP-634	634	20	40	1.1	3.1×10^9	6	4	3
Example 635	CP-635	635	20	40	1.2	3.0×10^9	5	4	3
Example 636	CP-636	636	25	40	1.0	2.6×10^9	4	4	3
Example 637	CP-637	637	2	45	0.8	5.0×10^8	4	4	2
Example 638	CP-638	638	2	45	0.9	5.0×10^8	5	4	2
Example 639	CP-639	639	2	45	1.0	5.0×10^8	5	4	2
Example 640	CP-640	640	2	45	1.1	5.0×10^8	5	4	2

[0362] [Table 66]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_n)/(V_1/V_n)\} \times 100$	$\{(V_1/V_n)/(V_2/V_n)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 641	CP-641	641	2	45	1.2	4.9×10^8	4	4	2
Example 642	CP-642	642	5	45	1.0	4.2×10^8	6	4	2
Example 643	CP-643	643	13	45	0.8	3.0×10^8	5	4	2
Example 644	CP-644	644	13	45	0.9	3.0×10^8	6	4	2
Example 645	CP-645	645	13	45	1.0	2.9×10^8	6	4	2
Example 646	CP-646	646	13	45	1.1	2.9×10^8	6	4	2
Example 647	CP-647	647	13	45	1.2	2.8×10^8	5	4	2
Example 648	CP-648	648	20	45	1.0	2.1×10^8	6	4	2
Example 649	CP-649	649	25	45	0.8	1.9×10^8	3	4	2
Example 650	CP-650	650	25	45	0.9	1.9×10^8	4	4	2
Example 651	CP-651	651	25	45	1.0	1.8×10^8	4	4	2
Example 652	CP-652	652	25	45	1.1	1.8×10^8	4	4	2
Example 653	CP-653	653	25	45	1.2	1.7×10^8	3	4	2

[0363] [Table 67]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)/(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 654	CP-654	654	5	20	0.8	4.3×10^{12}	5	4	3
Example 655	CP-655	655	5	20	0.9	4.3×10^{12}	6	4	3
Example 656	CP-656	656	5	20	1.0	4.3×10^{12}	6	4	3
Example 657	CP-657	657	5	20	1.1	4.3×10^{12}	6	4	3
Example 658	CP-658	658	5	20	1.2	4.3×10^{12}	5	4	3
Example 659	CP-659	659	13	20	0.8	3.8×10^{12}	5	4	3
Example 660	CP-660	660	13	20	0.9	3.8×10^{12}	6	4	3
Example 661	CP-661	661	13	20	1.0	3.8×10^{12}	6	4	3
Example 662	CP-662	662	13	20	1.1	3.8×10^{12}	6	4	3
Example 663	CP-663	663	13	20	1.2	3.7×10^{12}	5	4	3
Example 664	CP-664	664	20	20	0.8	3.5×10^{12}	5	4	3
Example 665	CP-665	665	20	20	0.9	3.5×10^{12}	6	4	3
Example 666	CP-666	666	20	20	1.0	3.4×10^{12}	6	4	3
Example 667	CP-667	667	20	20	1.1	3.4×10^{12}	6	4	3
Example 668	CP-668	668	20	20	1.2	3.4×10^{12}	5	4	3
Example 669	CP-669	669	5	30	0.8	1.5×10^{11}	5	4	3
Example 670	CP-670	670	5	30	0.9	1.5×10^{11}	6	4	3
Example 671	CP-671	671	5	30	1.0	1.4×10^{11}	6	4	3
Example 672	CP-672	672	5	30	1.1	1.4×10^{11}	6	4	3
Example 673	CP-673	673	5	30	1.2	1.4×10^{11}	5	4	3
Example 674	CP-674	674	13	30	0.8	1.2×10^{11}	5	4	3
Example 675	CP-675	675	13	30	0.9	1.2×10^{11}	6	4	3
Example 676	CP-676	676	13	30	1.0	1.1×10^{11}	6	4	3
Example 677	CP-677	677	13	30	1.1	1.1×10^{11}	6	4	3
Example 678	CP-678	678	13	30	1.2	1.1×10^{11}	5	4	3
Example 679	CP-679	679	20	30	0.8	9.8×10^{10}	5	4	3
Example 680	CP-680	680	20	30	0.9	9.8×10^{10}	6	4	3
Example 681	CP-681	681	20	30	1.0	9.5×10^{10}	6	4	3
Example 682	CP-682	682	20	30	1.1	9.5×10^{10}	6	4	3

Example 683	CP-683	683	20	30	1.2	9.3×10^{10}	5	4	3
Example 684	CP-684	684	5	40	0.8	1.2×10^9	5	4	3
Example 685	CP-685	685	5	40	0.9	1.2×10^9	6	4	3
Example 686	CP-686	686	5	40	1.0	1.2×10^9	6	4	3
Example 687	CP-687	687	5	40	1.1	1.2×10^9	6	4	3
Example 688	CP-688	688	5	40	1.2	1.2×10^9	5	4	3
Example 689	CP-689	689	13	40	0.8	8.2×10^8	5	4	3
Example 690	CP-690	690	13	40	0.9	8.2×10^8	6	4	3

[0364] [Table 68]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_0)/(V_1/V_0)\} \times 100$	$\{(V_1/V_0)/(V_2/V_0)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Example 691	CP-691	691	13	40	1.0	8.0×10^8	6	4	3
Example 692	CP-692	692	13	40	1.1	8.0×10^8	6	4	3
Example 693	CP-693	693	13	40	1.2	7.7×10^8	5	4	3
Example 694	CP-694	694	20	40	0.8	6.2×10^8	5	4	3
Example 695	CP-695	695	20	40	0.9	6.2×10^8	6	4	3
Example 696	CP-696	696	20	40	1.0	5.9×10^8	6	4	3
Example 697	CP-697	697	20	40	1.1	5.9×10^8	6	4	3
Example 698	CP-698	698	20	40	1.2	5.6×10^8	5	4	3
Example 699	CP-699	699	13	30	1.0	1.1×10^{11}	6	4	3
Example 700	CP-700	700	13	30	1.0	4.7×10^{11}	6	4	3

[0365] [Table 69]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)+(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation	
							Pattern memory	Residual potential
Comparative Example 129	CP-C129	C129	-	-	-	2.1×10^{13}	1	3
Comparative Example 130	CP-C130	C130	-	-	-	3.3×10^{11}	1	4
Comparative Example 131	CP-C131	C131	-	-	-	5.5×10^8	1	4
Comparative Example 132	CP-C132	C132	1	15	1.0	2.1×10^{13}	2	3
Comparative Example 133	CP-C133	C133	1	31	1.0	3.2×10^{11}	2	4
Comparative Example 134	CP-C134	C134	1	47	1.0	5.2×10^8	2	4
Comparative Example 135	CP-C135	C135	30	15	1.0	1.6×10^{13}	2	3
Comparative Example 136	CP-C136	C136	30	31	1.0	1.7×10^{11}	2	4
Comparative Example 137	CP-C137	C137	30	47	1.0	1.5×10^8	2	4
Comparative Example 138	CP-C138	C138	-	-	-	6.1×10^{12}	1	3
Comparative Example 139	CP-C139	C139	-	-	-	1.7×10^{10}	1	4
Comparative Example 140	CP-C140	C140	-	-	-	1.9×10^6	1	4
Comparative Example 141	CP-C141	C141	2	10	1.0	6.0×10^{13}	5	1
Comparative Example 142	CP-C142	C142	5	10	1.0	5.9×10^{13}	6	1
Comparative Example 143	CP-C143	C143	13	10	1.0	5.6×10^{13}	6	1
Comparative Example 144	CP-C144	C144	20	10	1.0	5.4×10^{13}	6	1
Comparative Example 145	CP-C145	C145	25	10	1.0	5.2×10^{13}	4	1
Comparative Example 146	CP-C146	C146	2	52	1.0	2.4×10^7	5	4
Comparative Example 147	CP-C147	C147	5	52	1.0	2.0×10^7	6	4
Comparative Example 148	CP-C148	C148	13	52	1.0	1.3×10^7	6	4
Comparative Example 149	CP-C149	C149	20	52	1.0	8.8×10^6	6	4
Comparative Example 150	CP-C150	C150	25	52	1.0	7.0×10^6	4	4

[0366] [Table 70]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 151	CP-C151	C151	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 152	CP-C152	C152	-	-	-	2.6×10^{11}	1	4	3
Comparative Example 153	CP-C153	C153	-	-	-	2.8×10^{11}	1	4	3
Comparative Example 154	CP-C154	C154	-	-	-	2.7×10^{11}	1	4	3
Comparative Example 155	CP-C155	C155	-	-	-	2.6×10^{11}	1	4	3
Comparative Example 156	CP-C156	C156	-	-	-	2.3×10^{11}	1	4	3
Comparative Example 157	CP-C157	C157	-	-	-	2.5×10^{11}	1	4	3
Comparative Example 158	CP-C158	C158	-	-	-	2.4×10^{11}	1	4	3

[0367] [Table 71]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T) + (V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation		
							Pattern memory	Residual potential	Crack
Comparative Example 159	CP-C159	C159	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 160	CP-C160	C160	-	-	-	2.7×10^{11}	1	4	3
Comparative Example 161	CP-C161	C161	-	-	-	3.2×10^{11}	1	4	3
Comparative Example 162	CP-C162	C162	-	-	-	3.0×10^{11}	1	4	3
Comparative Example 163	CP-C163	C163	-	-	-	2.9×10^{11}	1	4	3
Comparative Example 164	CP-C164	C164	-	-	-	2.9×10^{11}	1	4	3
Comparative Example 165	CP-C165	C165	-	-	-	2.9×10^{11}	1	4	3

[0368] [Table 72]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)+(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation Pattern memory potential	Crack
Comparative Example 166	CP-C166	C166	-	-	-	3.0×10^{11}	1	3
Comparative Example 167	CP-C167	C167	-	-	-	2.8×10^{11}	1	3
Comparative Example 168	CP-C168	C168	-	-	-	3.0×10^{11}	1	3
Comparative Example 169	CP-C169	C169	-	-	-	2.6×10^{11}	1	3
Comparative Example 170	CP-C170	C170	-	-	-	3.3×10^{11}	1	3
Comparative Example 171	CP-C171	C171	-	-	-	3.0×10^{11}	1	3

[0369] [Table 73]

	Conductive-layer coating solution	Production example of electrophotographic photosensitive member	$\{(V_2/V_T)/(V_1/V_T)\} \times 100$	$\{(V_1/V_T)+(V_2/V_T)\} \times 100$	R_2/R_1	Volume resistivity of conductive layer [$\Omega \cdot \text{cm}$]	Result of evaluation Pattern memory potential	Crack
Comparative Example 172	CP-C172	C172	-	-	-	2.9×10^{11}	1	3
Comparative Example 173	CP-C173	C173	-	-	-	2.9×10^{11}	1	3
Comparative Example 174	CP-C174	C174	-	-	-	2.9×10^{11}	1	3
Comparative Example 175	CP-C175	C175	-	-	-	3.0×10^{11}	1	3
Comparative Example 176	CP-C176	C176	-	-	-	2.8×10^{11}	1	3
Comparative Example 177	CP-C177	C177	-	-	-	3.0×10^{11}	1	3
Comparative Example 178	CP-C178	C178	-	-	-	3.0×10^{11}	1	3
Comparative Example 179	CP-C179	C179	-	-	-	1.9×10^{12}	1	3

[0370] [Table 74]

		Rank of pattern memory					
		6	5	4	3	2	1
Half-tone image	Solid black image	Unobservable	Observable	Observable	Observable	Observable	Observable
	One-dot keima pattern	Unobservable	Unobservable	Observable	Observable	Observable	Observable
	One-dot and one-space lateral line	Unobservable	Unobservable	Unobservable	Observable	Observable	Observable
	Two-dot and three-space lateral line	Unobservable	Unobservable	Unobservable	Unobservable	Observable	Observable
	One-dot and two-space lateral line	Unobservable	Unobservable	Unobservable	Unobservable	Unobservable	Observable

[0371] While the present invention has been described with reference to exemplary embodiments, it is to be understood that the invention is not limited to the disclosed exemplary embodiments. The scope of the following claims is to be accorded the broadest interpretation so as to encompass all such modifications and equivalent structures and functions.

[0372] This application claims the benefit of Japanese Patent Applications No. 2012-189532, filed on August 30, 2012, No. 2013-077617, filed on April 3, 2013, and No. 2013-177141, filed on August 28, 2013, which are hereby incorporated by reference herein in its entirety.

Reference Signs List

[0373] 1 electrophotographic photosensitive member
2 axis
3 charging device (primary charging device)
4 exposure light (image exposure light)
5 developing device
6 transferring device (such as transfer roller)
7 cleaning device (such as cleaning blade)
8 fixing device
9 process cartridge
10 guiding device
11 pre-exposure light
P transfer material (such as paper)

CLAIMS

- [Claim 1] An electrophotographic photosensitive member, comprising:
a support;
a conductive layer formed on the support; and
a photosensitive layer formed on the conductive layer,
wherein:
the conductive layer comprises:
a titanium oxide particle coated with tin oxide doped with phosphorus,
a tin oxide particle doped with phosphorus, and
a binding material; and
when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with phosphorus in the conductive layer is represented by V_{1P} , and a total volume of the tin oxide particle doped with phosphorus in the conductive layer is represented by V_{2P} , the V_T , the V_{1P} , and the V_{2P} satisfy the following expressions (1) and (2).
$$2 \leq \{ (V_{2P}/V_T) / (V_{1P}/V_T) \} \times 100 \leq 25 \quad \cdots (1)$$
$$15 \leq \{ (V_{1P}/V_T) + (V_{2P}/V_T) \} \times 100 \leq 45 \quad \cdots (2)$$
- [Claim 2] The electrophotographic photosensitive member according to claim 1, wherein the V_T , the V_{1P} , and the V_{2P} satisfy the following expression (3).
$$5 \leq \{ (V_{2P}/V_T) / (V_{1P}/V_T) \} \times 100 \leq 20 \quad \cdots (3)$$
- [Claim 3] The electrophotographic photosensitive member according to claim 1 or 2, wherein the V_T , the V_{1P} , and the V_{2P} satisfy the following expression (4).
$$20 \leq \{ (V_{1P}/V_T) + (V_{2P}/V_T) \} \times 100 \leq 40 \quad \cdots (4)$$
- [Claim 4] The electrophotographic photosensitive member according to any one of claims 1 to 3, wherein when an abundance ratio of phosphorus to tin oxide in the titanium oxide particle coated with tin

oxide doped with phosphorus is represented by R_{1P} [atom%] and an abundance ratio of phosphorus to tin oxide in the tin oxide particle doped with phosphorus is represented by R_{2P} [atom%], the R_{1P} and the R_{2P} satisfy the following expression (5).

$$0.9 \leq R_{2P}/R_{1P} \leq 1.1 \quad \dots (5)$$

- [Claim 5] An electrophotographic photosensitive member, comprising:
- a support;
 - a conductive layer formed on the support; and
 - a photosensitive layer formed on the conductive layer,
- wherein:
- the conductive layer comprises:
- a titanium oxide particle coated with tin oxide doped with tungsten,
 - a tin oxide particle doped with tungsten, and
 - a binding material; and
- when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with tungsten in the conductive layer is represented by V_{1W} , and a total volume of the tin oxide particle doped with tungsten in the conductive layer is represented by V_{2W} , the V_T , the V_{1W} , and the V_{2W} satisfy the following expressions (6) and (7).

$$2 \leq \{ (V_{2W}/V_T) / (V_{1W}/V_T) \} \times 100 \leq 25 \quad \dots (6)$$

$$15 \leq \{ (V_{1W}/V_T) + (V_{2W}/V_T) \} \times 100 \leq 45 \quad \dots (7)$$

- [Claim 6] The electrophotographic photosensitive member according to claim 5, wherein the V_T , the V_{1W} , and the V_{2W} satisfy the following expression (8).

$$5 \leq \{ (V_{2W}/V_T) / (V_{1W}/V_T) \} \times 100 \leq 20 \quad \dots (8)$$

- [Claim 7] The electrophotographic photosensitive member according to claim 5 or 6, wherein the V_T , the V_{1W} , and the V_{2W} satisfy the following expression (9).

$$20 \leq \{ (V_{1W}/V_T) + (V_{2W}/V_T) \} \times 100 \leq 40 \quad \dots (9)$$

[Claim 8] The electrophotographic photosensitive member according to any one of claims 5 to 7, wherein when an abundance ratio of tungsten to tin oxide in the titanium oxide particle coated with tin oxide doped with tungsten is represented by R_{1W} [atom%] and an abundance ratio of tungsten to tin oxide in the tin oxide particle doped with tungsten is represented by R_{2W} [atom%], the R_{1W} and the R_{2W} satisfy the following expression (10).

$$0.9 \leq R_{2W}/R_{1W} \leq 1.1 \quad \cdots (10)$$

[Claim 9] An electrophotographic photosensitive member, comprising:
 a support;
 a conductive layer formed on the support; and
 a photosensitive layer formed on the conductive layer,
 wherein:

the conductive layer comprises:

a titanium oxide particle coated with tin oxide doped with fluorine,
 a tin oxide particle doped with fluorine, and
 a binding material; and

when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with fluorine in the conductive layer is represented by V_{1F} , and a total volume of the tin oxide particle doped with fluorine in the conductive layer is represented by V_{2F} , the V_T , the V_{1F} , and the V_{2F} satisfy the following expressions (11) and (12).

$$2 \leq \{ (V_{2F}/V_T) / (V_{1F}/V_T) \} \times 100 \leq 25 \quad \cdots (11)$$

$$15 \leq \{ (V_{1F}/V_T) + (V_{2F}/V_T) \} \times 100 \leq 45 \quad \cdots (12)$$

[Claim 10] The electrophotographic photosensitive member according to claim 9, wherein the V_T , the V_{1F} , and the V_{2F} satisfy the following expression (13).

$$5 \leq \{ (V_{2F}/V_T) / (V_{1F}/V_T) \} \times 100 \leq 20 \quad \cdots (13)$$

[Claim 11] The electrophotographic photosensitive member according to claim 9 or 10, wherein the V_T , the V_{1F} , and the V_{2F} satisfy the following expression (14).

$$20 \leq \{ (V_{1F}/V_T) + (V_{2F}/V_T) \} \times 100 \leq 40 \quad \dots \quad (14)$$

[claim 12] The electrophotographic photosensitive member according to any one of claims 9 to 11, wherein when an abundance ratio of fluorine to tin oxide in the titanium oxide particle coated with tin oxide doped with fluorine is represented by R_{1F} [atom%] and an abundance ratio of fluorine to tin oxide in the tin oxide particle doped with fluorine is represented by R_{2F} [atom%], the R_{1F} and the R_{2F} satisfy the following expression (15).

$$0.9 \leq R_{2F}/R_{1F} \leq 1.1 \quad \dots \quad (15)$$

[Claim 13] An electrophotographic photosensitive member, comprising:

a support;

a conductive layer formed on the support; and

a photosensitive layer formed on the conductive layer,

wherein:

the conductive layer comprises:

a titanium oxide particle coated with tin oxide doped with niobium,

a tin oxide particle doped with niobium, and

a binding material; and

when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with niobium in the conductive layer is represented by V_{1Nb} , and a total volume of the tin oxide particle doped with niobium in the conductive layer is represented by V_{2Nb} , the V_T , the V_{1Nb} , and the V_{2Nb} satisfy the following expressions (16) and (17).

$$2 \leq \{ (V_{2Nb}/V_T) / (V_{1Nb}/V_T) \} \times 100 \leq 25 \quad \dots \quad (16)$$

$$15 \leq \{ (V_{1Nb}/V_T) + (V_{2Nb}/V_T) \} \times 100 \leq 45 \quad \dots \quad (17)$$

[Claim 14] The electrophotographic photosensitive member according to claim 13, wherein the V_T , the V_{1Nb} , and the V_{2Nb} satisfy the following expression (18).

$$5 \leq \{ (V_{2Nb}/V_T) / (V_{1Nb}/V_T) \} \times 100 \leq 20 \cdots (18)$$

[Claim 15] The electrophotographic photosensitive member according to claim 13 or 14, wherein the V_T , the V_{1Nb} , and the V_{2Nb} satisfy the following expression (19).

$$20 \leq \{ (V_{1Nb}/V_T) + (V_{2Nb}/V_T) \} \times 100 \leq 40 \cdots (19)$$

[Claim 16] The electrophotographic photosensitive member according to any one of claims 13 to 15, wherein when an abundance ratio of niobium to tin oxide in the titanium oxide particle coated with tin oxide doped with niobium is represented by R_{1Nb} [atom%] and an abundance ratio of niobium to tin oxide in the tin oxide particle doped with niobium is represented by R_{2Nb} [atom%], the R_{1Nb} and the R_{2Nb} satisfy the following expression (20).

$$0.9 \leq R_{2Nb}/R_{1Nb} \leq 1.1 \cdots (20)$$

[Claim 17] An electrophotographic photosensitive member, comprising:
 a support;
 a conductive layer formed on the support; and
 a photosensitive layer formed on the conductive layer,

wherein:

the conductive layer comprises:

a titanium oxide particle coated with tin oxide doped with tantalum,
 a tin oxide particle doped with tantalum, and
 a binding material; and

when a total volume of the conductive layer is represented by V_T , a total volume of the titanium oxide particle coated with tin oxide doped with tantalum in the conductive layer is represented by V_{1Ta} , and a total volume of the tin oxide particle

doped with tantalum in the conductive layer is represented by V_{2Ta} , the V_T , the V_{1Ta} , and the V_{2Ta} satisfy the following expressions (21) and (22).

$$2 \leq \{ (V_{2Ta}/V_T) / (V_{1Ta}/V_T) \} \times 100 \leq 25 \quad \dots \quad (21)$$

$$15 \leq \{ (V_{1Ta}/V_T) + (V_{2Ta}/V_T) \} \times 100 \leq 45 \quad \dots \quad (22)$$

[Claim 18] The electrophotographic photosensitive member according to claim 17, wherein the V_T , the V_{1Ta} , and the V_{2Ta} satisfy the following expression (23).

$$5 \leq \{ (V_{2Ta}/V_T) / (V_{1Ta}/V_T) \} \times 100 \leq 20 \quad \dots \quad (23)$$

[Claim 19] The electrophotographic photosensitive member according to claim 17 or 18, wherein the V_T , the V_{1Ta} , and the V_{2Ta} satisfy the following expression (24).

$$20 \leq \{ (V_{1Ta}/V_T) + (V_{2Ta}/V_T) \} \times 100 \leq 40 \quad \dots \quad (24)$$

[Claim 20] The electrophotographic photosensitive member according to any one of claims 17 to 19, wherein when an abundance ratio of tantalum to tin oxide in the titanium oxide particle coated with tin oxide doped with tantalum is represented by R_{1Ta} [atom%] and an abundance ratio of tantalum to tin oxide in the tin oxide particle doped with tantalum is represented by R_{2Ta} [atom%], the R_{1Ta} and the R_{2Ta} satisfy the following expression (25).

$$0.9 \leq R_{2Ta}/R_{1Ta} \leq 1.1 \quad \dots \quad (25)$$

[Claim 21] A process cartridge detachably mountable to a main body of an electrophotographic apparatus, wherein the process cartridge integrally supports: the electrophotographic photosensitive member according to any one of claims 1 to 20; and at least one device selected from the group consisting of a charging device, a developing device, a transferring device, and a cleaning device.

[Claim 22] An electrophotographic apparatus, comprising: the electrophotographic photosensitive member according to any one of claims 1 to 20;

a charging device;
an exposing device;
a developing device; and
a transferring device.

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FIG. 1

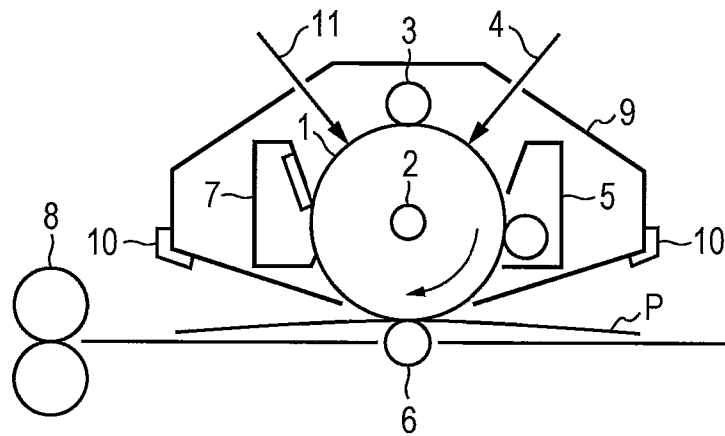
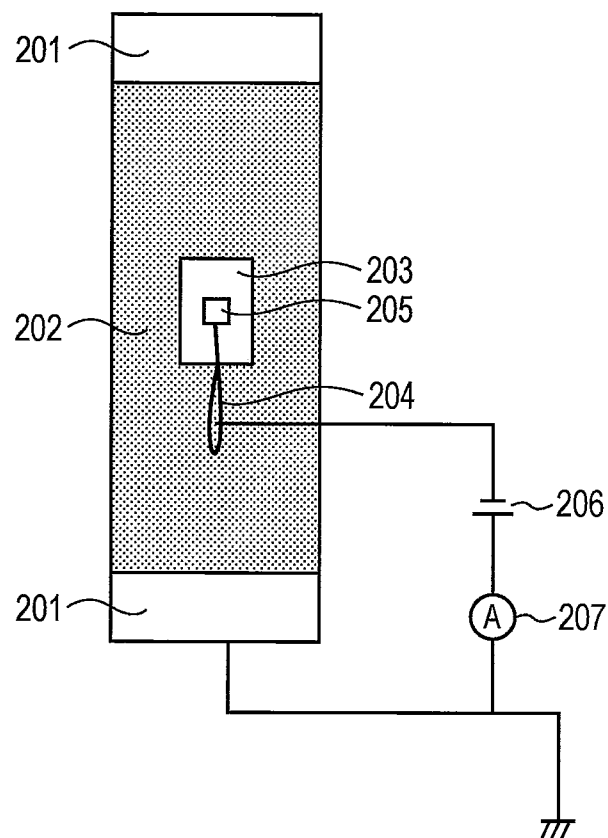


FIG. 2



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FIG. 3

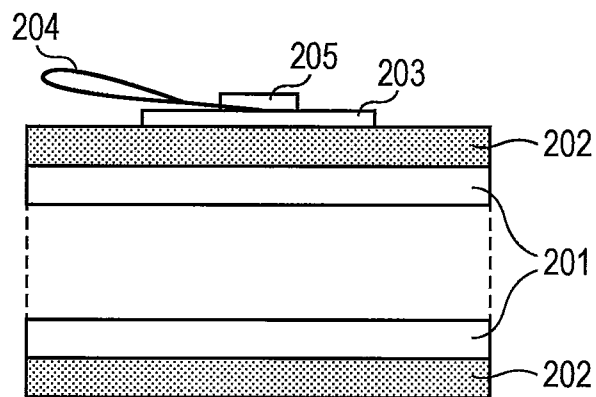
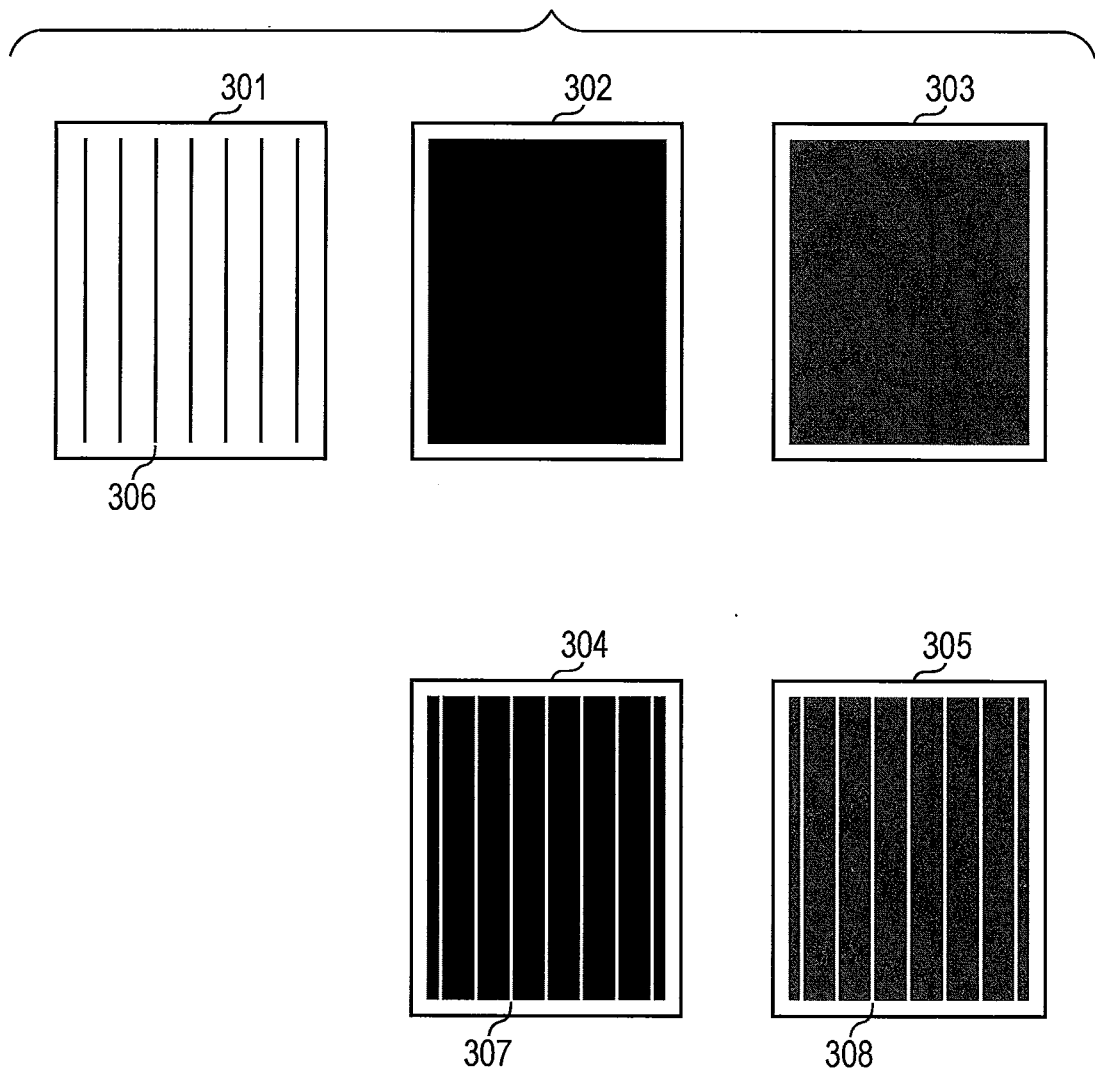
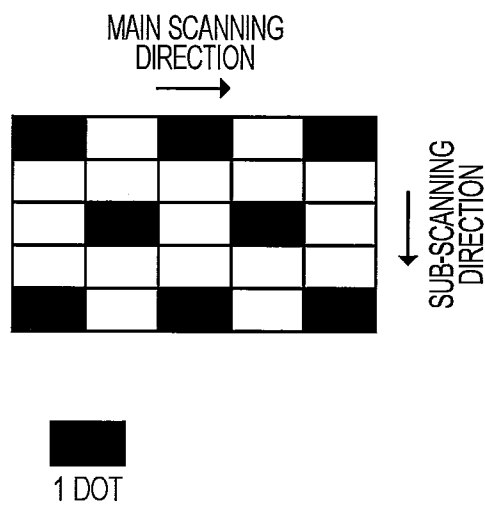


FIG. 4



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FIG. 5

INTERNATIONAL SEARCH REPORT

International application No.

PCT/JP2013/073860

A. CLASSIFICATION OF SUBJECT MATTER		
Int.Cl. G03G5/14 (2006.01) i		
According to International Patent Classification (IPC) or to both national classification and IPC		
B. FIELDS SEARCHED		
Minimum documentation searched (classification system followed by classification symbols)		
Int.Cl. G03G5/14		
Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched		
Published examined utility model applications of Japan 1922-1996 Published unexamined utility model applications of Japan 1971-2013 Registered utility model specifications of Japan 1996-2013 Published registered utility model applications of Japan 1994-2013		
Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)		
C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	JP 2012-18371 A (CANON KABUSHIKI KAISHA) 2012.01.26, & US 2012/0114375 A1 & EP 2443518 A & WO 2011/027911 A1 & CN 102483592 A & KR 10-2012-0045061 A	1-22
A	JP 9-50142 A (Minolta Co., Ltd.) 1997.02.18, & US 2002/0048711 A1	1-22
A	JP 2000-231178 A (Eastman Kodak Company) 2000.08.22, & US 6168911 B1 & EP 1011019 A1	1-22
☐ Further documents are listed in the continuation of Box C. ☐ See patent family annex.		
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Date of the actual completion of the international search		Date of mailing of the international search report
03.10.2013		15.10.2013
Name and mailing address of the ISA/JP		Authorized officer
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